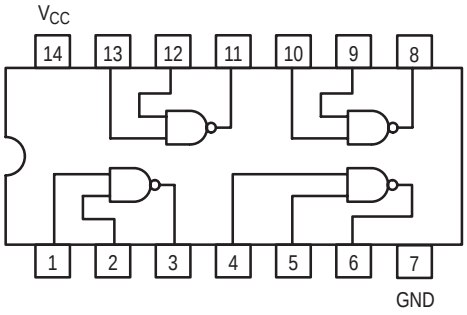
SN74LS00

Quad 2-Input NAND Gate

- ESD > 3500 Volts



GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Typ	Max	Unit
V_{CC}	Supply Voltage	4.75	5.0	5.25	V
T_A	Operating Ambient Temperature Range	0	25	70	°C
I_{OH}	Output Current – High			–0.4	mA
I_{OL}	Output Current – Low			8.0	mA

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LOW
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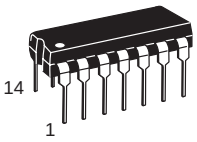
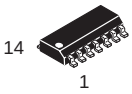


PLASTIC
N SUFFIX
CASE 646



SOIC
D SUFFIX
CASE 751A

ORDERING INFORMATION

Device	Package	Shipping
SN74LS00N	14 Pin DIP	2000 Units/Box
SN74LS00D	14 Pin	2500/Tape & Reel

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DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Symbol	Parameter	Limits			Unit	Test Conditions	
		Min	Typ	Max			
V_{IH}	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V_{IL}	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs	
V_{IK}	Input Clamp Diode Voltage		–0.65	–1.5	V	V_{CC} = MIN, I_{IN} = –18 mA	
V_{OH}	Output HIGH Voltage	2.7	3.5		V	V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH} or V_{IL} per Truth Table	
V_{OL}	Output LOW Voltage		0.25	0.4	V	I_{OL} = 4.0 mA	V_{CC} = V_{CC} MIN, V_{IN} = V_{IL} or V_{IH} per Truth Table
			0.35	0.5	V	I_{OL} = 8.0 mA	
I_{IH}	Input HIGH Current			20	μA	V_{CC} = MAX, V_{IN} = 2.7 V	
				0.1	mA	V_{CC} = MAX, V_{IN} = 7.0 V	
I_{IL}	Input LOW Current			–0.4	mA	V_{CC} = MAX, V_{IN} = 0.4 V	
I_{OS}	Short Circuit Current (Note 1)	–20		–100	mA	V_{CC} = MAX	
I_{CC}	Power Supply Current Total, Output HIGH			1.6	mA	V_{CC} = MAX	
	Total, Output LOW			4.4			

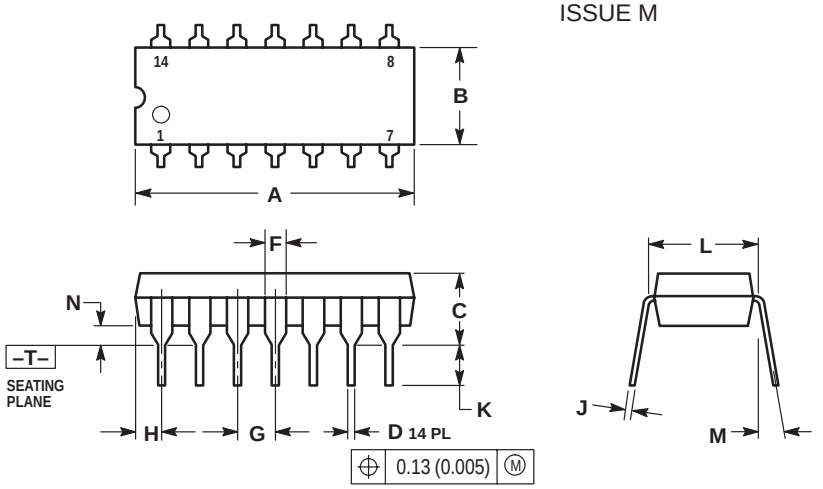
Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS (T_A = 25°C)

Symbol	Parameter	Limits			Unit	Test Conditions
		Min	Typ	Max		
t_{PLH}	Turn–Off Delay, Input to Output		9.0	15	ns	V_{CC} = 5.0 V C_L = 15 pF
t_{PHL}	Turn–On Delay, Input to Output		10	15	ns	

PACKAGE DIMENSIONS

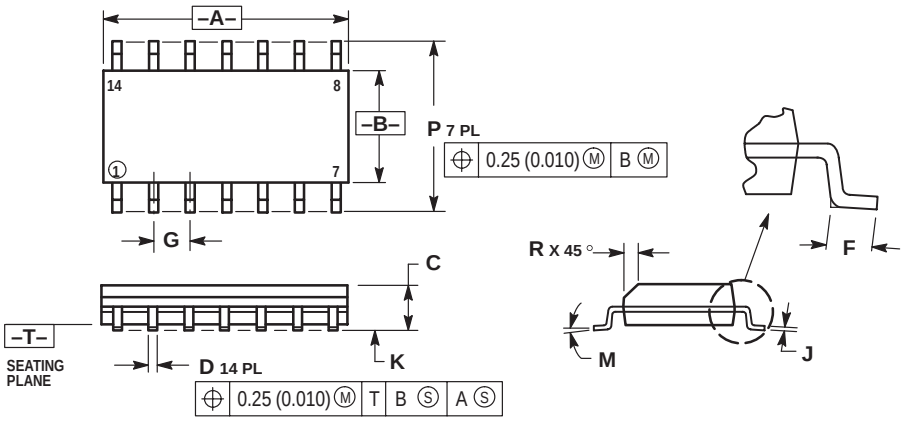
N SUFFIX
PLASTIC PACKAGE
CASE 646–06
ISSUE M



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.715	0.770	18.16	18.80
B	0.240	0.260	6.10	6.60
C	0.145	0.185	3.69	4.69
D	0.015	0.021	0.38	0.53
F	0.040	0.070	1.02	1.78
G	0.100 BSC		2.54 BSC	
H	0.052	0.095	1.32	2.41
J	0.008	0.015	0.20	0.38
K	0.115	0.135	2.92	3.43
L	0.290	0.310	7.37	7.87
M	—	10°	—	10°
N	0.015	0.039	0.38	1.01

D SUFFIX
PLASTIC SOIC PACKAGE
CASE 751A–03
ISSUE F



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7 °	0 °	7 °
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

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SN5402, SN54LS02, SN54S02, SN7402, SN74LS02, SN74S02
QUADRUPLE 2-INPUT POSITIVE-NOR GATES

DECEMBER 1983—REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

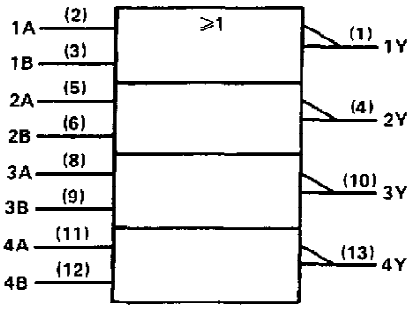
These devices contain four independent 2-input NOR gates.

The SN5402, SN54LS02, and SN54S02 are characterized for operation over the full military temperature range of −55°C to 125°C. The SN7402, SN74LS02, and SN74S02 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

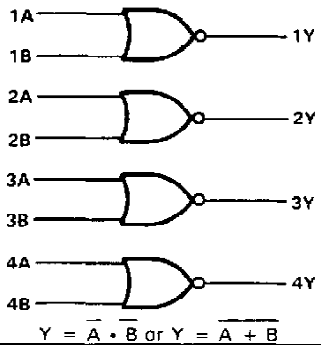
INPUTS		OUTPUT
A	B	Y
H	X	L
X	H	L
L	L	H

logic symbol†



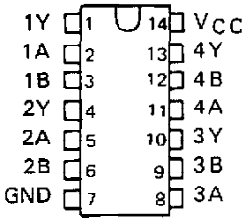
†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, and N packages.

logic diagram (positive logic)

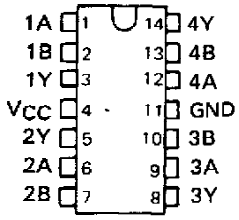


$Y = \overline{A} \cdot \overline{B}$ or $Y = \overline{A + B}$

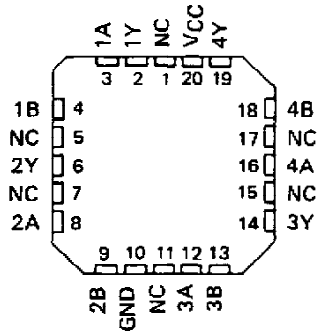
SN5402 . . . J PACKAGE
SN54LS02, SN54S02 . . . J OR W PACKAGE
SN7402 . . . N PACKAGE
SN74LS02, SN74S02 . . . D OR N PACKAGE
(TOP VIEW)



SN5402 . . . W PACKAGE
(TOP VIEW)



SN54LS02, SN54S02 . . . FK PACKAGE
(TOP VIEW)

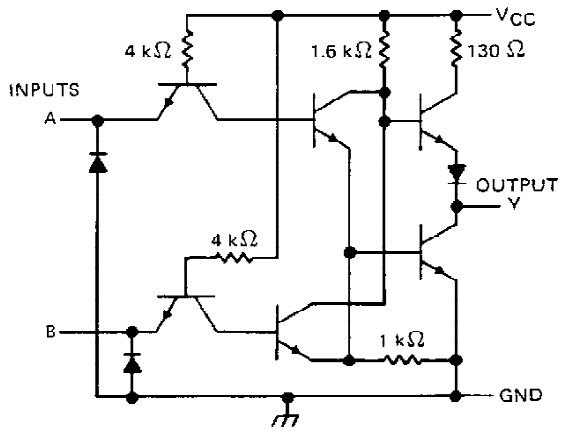


NC – No internal connection

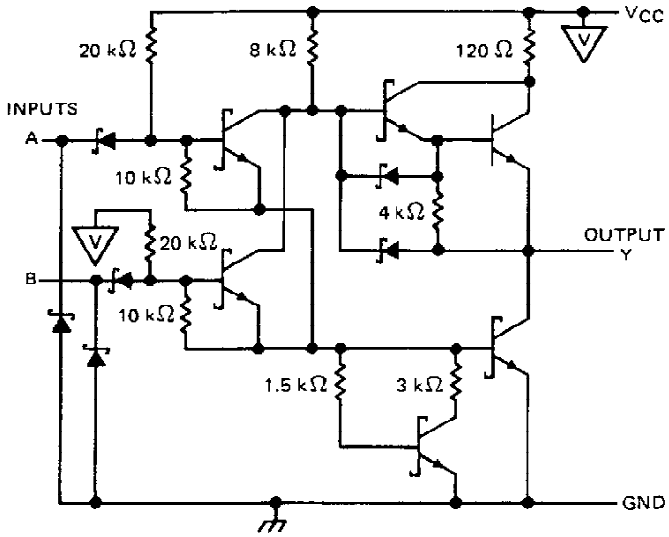
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

schematics (each gate)

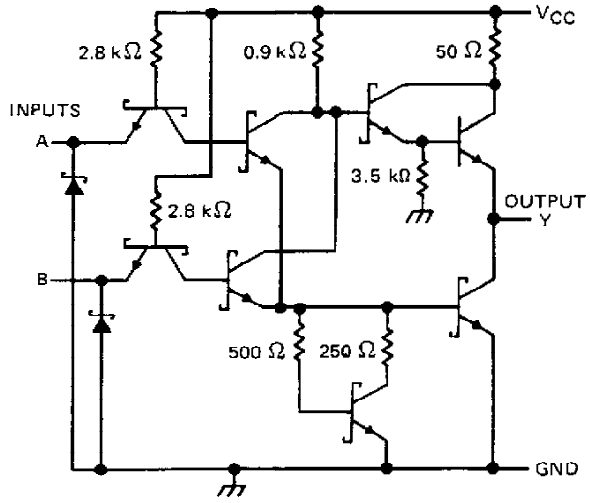
'02



'LS02



'S02



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage: '02, 'S02	5.5 V
'LS02	7 V
Off-state output voltage	7 V
Operating free-air temperature range: SN54'	−55°C to 125°C
SN74'	0°C to 70°C
Storage temperature range	−65°C to 150°C

NOTE 1. Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5402			SN7402			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			16			16	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	SN5402			SN7402			UNIT
		MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}	V_{CC} = MIN, V_{IL} = 0.8 V, I_{OH} = −0.4 mA	2.4	3.4		2.4	3.4		V
V_{OL}	V_{CC} = MIN, V_{IH} = 2 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
I_{IL}	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
I_{OS}§	V_{CC} = MAX	−20		−55	−18		−55	mA
I_{CCH}	V_{CC} = MAX, V_I = 0 V		8	16		8	16	mA
I_{CCL}	V_{CC} = MAX, See Note 2		14	27		14	27	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 400 Ω, C_L = 15 pF		12	22	ns
t_{PHL}					8	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

		SN54LS02			SN74LS02			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			SN54LS02			SN74LS02			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}	V_{CC} = MIN,	V_{IL} = MAX,	I_{OH} = −0.4 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN,	V_{IH} = 2 V,	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
	V_{CC} = MIN,	V_{IH} = 2 V,	I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
I_{IH}	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
I_{IL}	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
I_{OS}§	V_{CC} = MAX			−20		−100	−20		−100	mA
I_{CCH}	V_{CC} = MAX,	V_I = 0 V			1.6	3.2		1.6	3.2	mA
I_{CCL}	V_{CC} = MAX,	See Note 2			2.8	5.4		2.8	5.4	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.
NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 2 kΩ,	C_L = 15 pF		10	15	ns
t_{PHL}						10	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

		SN54S02			SN74S02			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			−1			−1	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			SN54S02			SN74S02			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN,	I_I = −18 mA				−1.2			−1.2	V
V_{OH}	V_{CC} = MIN,	V_{IL} = 0.8 V,	I_{OH} = −1 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN,	V_{IH} = 2 V,	I_{OL} = 20 mA			0.5			0.5	V
I_I	V_{CC} = MAX,	V_I = 5.5 V				1			1	mA
I_{IH}	V_{CC} = MAX,	V_I = 2.7 V				50			50	μA
I_{IL}	V_{CC} = MAX,	V_I = 0.5 V				−2			−2	mA
I_{OS}§	V_{CC} = MAX			−40		−100	−40		−100	mA
I_{CCH}	V_{CC} = MAX,	V_I = 0 V			17	29		17	29	mA
I_{CCL}	V_{CC} = MAX,	See Note 2			26	45		26	45	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.
NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	A or B	Y	R_L = 280 Ω,	C_L = 15 pF		3.5	5.5	ns
t_{PHL}						3.5	5.5	ns
t_{PLH}			R_L = 280 Ω,	C_L = 50 pF		5		ns
t_{PHL}						5		ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
JM38510/00401BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/00401BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/00401BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07301BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07301BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07301BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07301BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301SCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301SCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301SDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30301SDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SN5402J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN5402J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54LS02J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54LS02J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54S02J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54S02J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN7402N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN7402N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN7402N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7402N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7402NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN7402NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS02D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
SN74LS02DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74LS02J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74LS02N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS02N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS02N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS02N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS02NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS02NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS02NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS02NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S02D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S02D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S02DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S02DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S02DR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74S02DR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74S02N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S02N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S02N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74S02N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74S02NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S02NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SNJ5402J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ5402J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ5402W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ5402W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS02FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SNJ54LS02FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS02J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS02J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS02W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS02W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S02FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S02FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S02J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S02J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S02W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S02W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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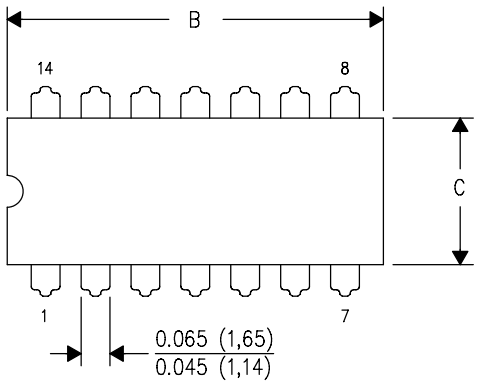
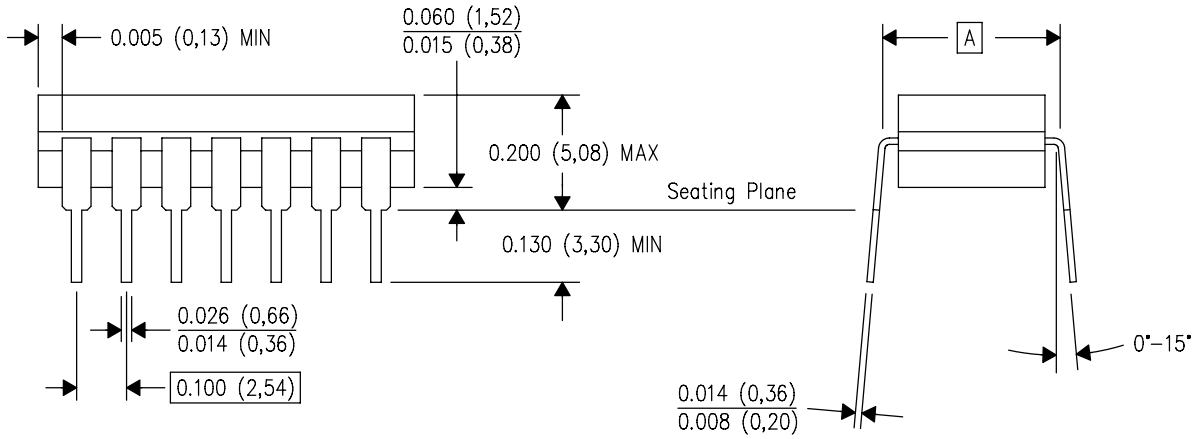
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



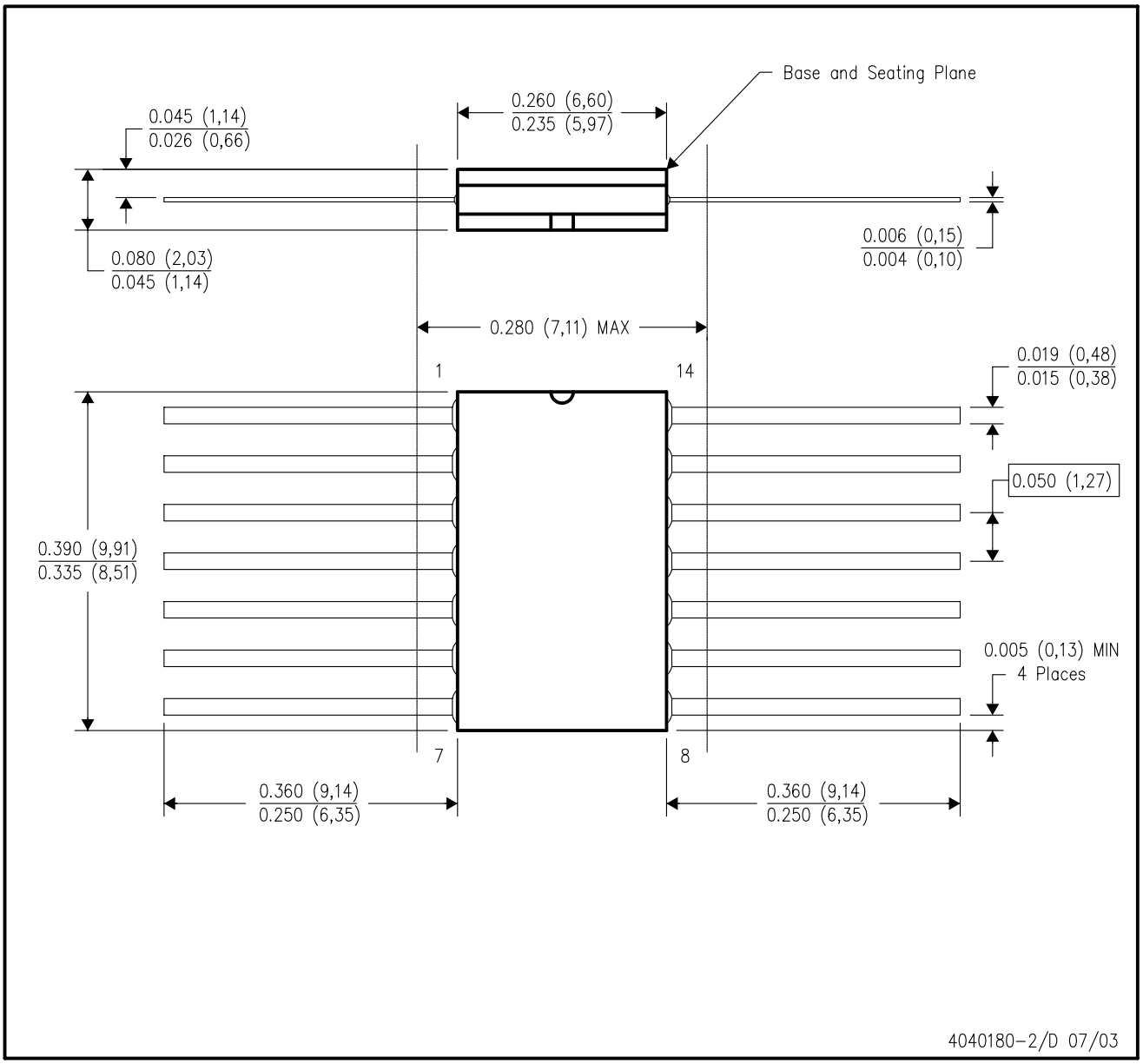
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

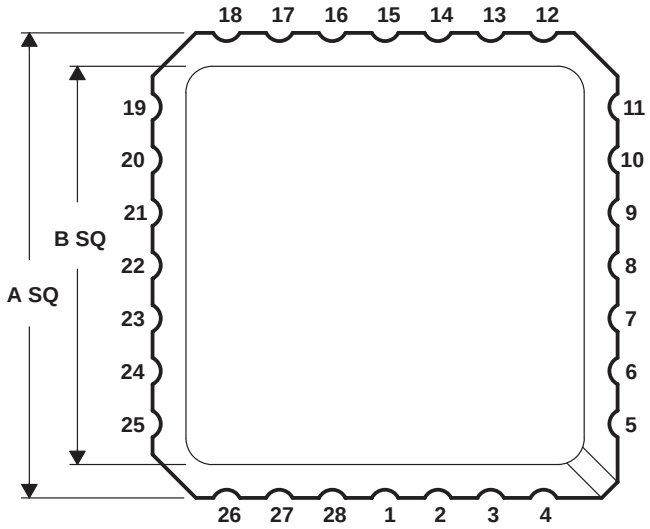
W (R–GDFP–F14) CERAMIC DUAL FLATPACK



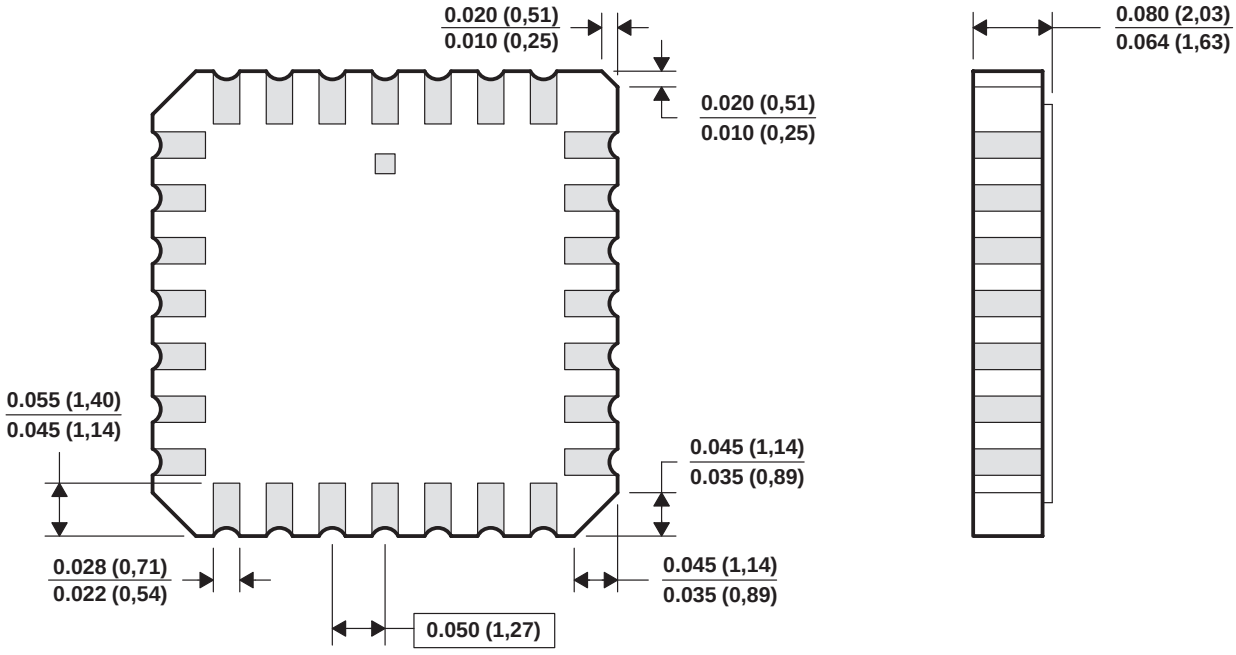
NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F14 and JEDEC MO–092AB

FK (S-CQCC-N)** **LEADLESS CERAMIC CHIP CARRIER**

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.739 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



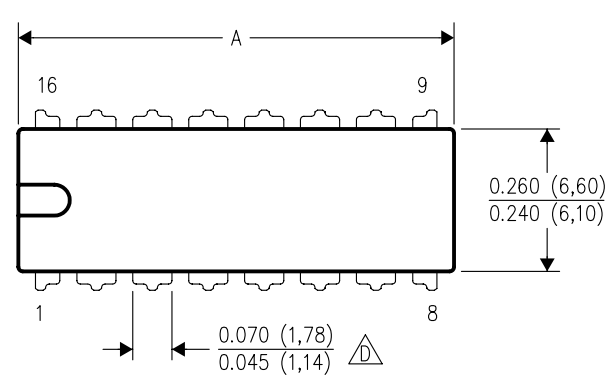
4040140/D 10/96

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

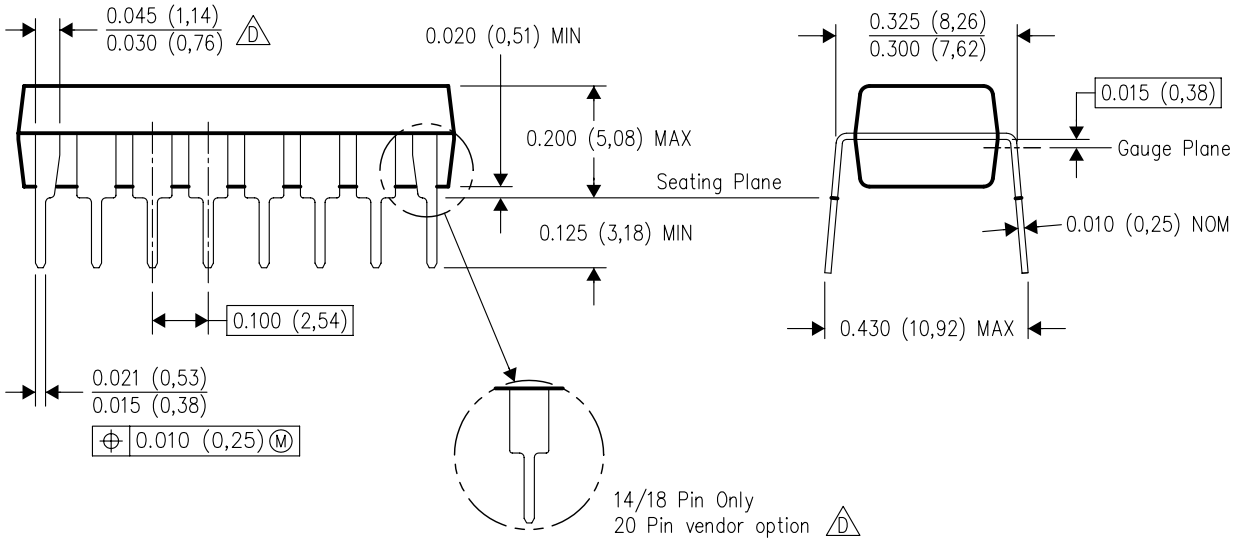
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



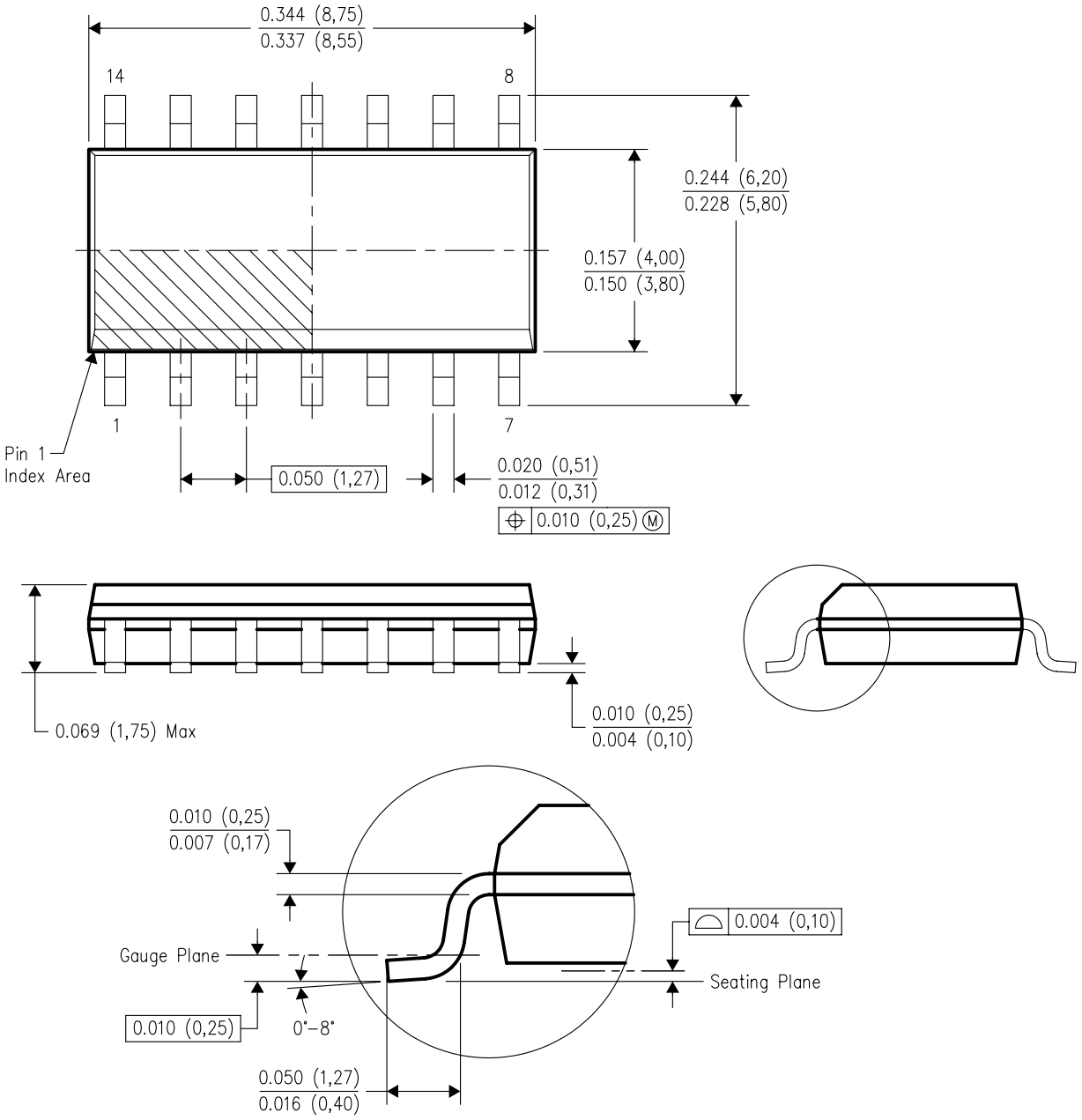
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R–PDSO–G14) PLASTIC SMALL–OUTLINE PACKAGE

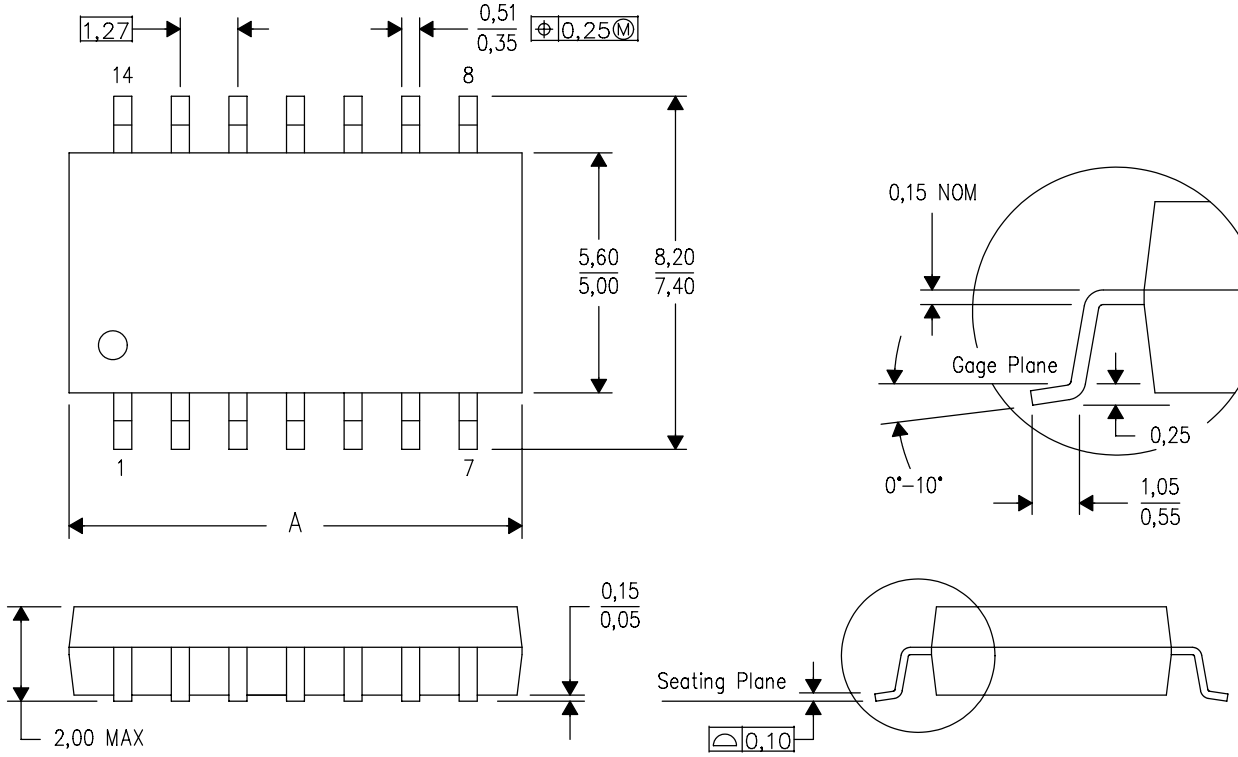


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–012 variation AB.

MECHANICAL DATA

NS (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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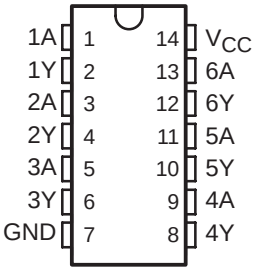
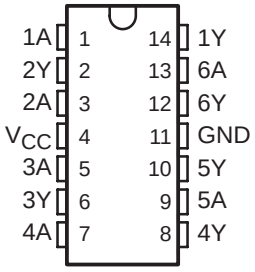
description/ordering information

These devices contain six independent inverters.

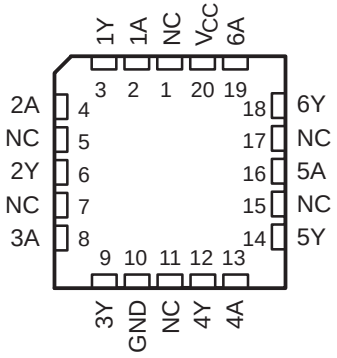
SN5404 . . . J PACKAGE
SN54LS04, SN54S04 . . . J OR W PACKAGE
SN7404, SN74S04 . . . D, N, OR NS PACKAGE
SN74LS04 . . . D, DB, N, OR NS PACKAGE
(TOP VIEW)



SN5404 . . . W PACKAGE
(TOP VIEW)



SN54LS04, SN54S04 . . . FK PACKAGE
(TOP VIEW)



NC − No internal connection

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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

ORDERING INFORMATION

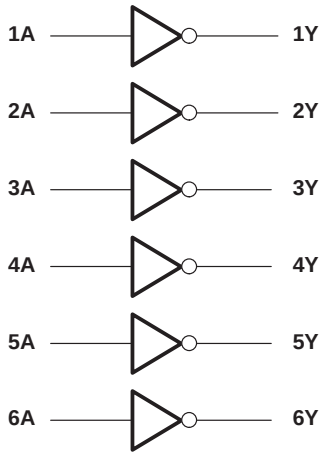
T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP − N	Tube	SN7404N	SN7404N
		Tube	SN74LS04N	SN74LS04N
		Tube	SN74S04N	SN74S04N
	SOIC − D	Tube	SN7404D	7404
		Tape and reel	SN7404DR	
		Tube	SN74LS04D	LS04
		Tape and reel	SN74LS04DR	
		Tube	SN74S04D	S04
		Tape and reel	SN74S04DR	
	SOP − NS	Tape and reel	SN7404NSR	SN7404
		Tape and reel	SN74LS04NSR	74LS04
		Tape and reel	SN74S04NSR	74S04
	SSOP − DB	Tape and reel	SN74LS04DBR	LS04
−55°C to 125°C	CDIP − J	Tube	SN5404J	SN5404J
		Tube	SNJ5404J	SNJ5404J
		Tube	SN54LS04J	SN54LS04J
		Tube	SN54S04J	SN54S04J
		Tube	SNJ54LS04J	SNJ54LS04J
		Tube	SNJ54S04J	SNJ54S04J
	CFP − W	Tube	SNJ5404W	SNJ5404W
		Tube	SNJ54LS04W	SNJ54LS04W
		Tube	SNJ54S04W	SNJ54S04W
	LCCC − FK	Tube	SNJ54LS04FK	SNJ54LS04FK
		Tube	SNJ54S04FK	SNJ54S04FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE
(each inverter)

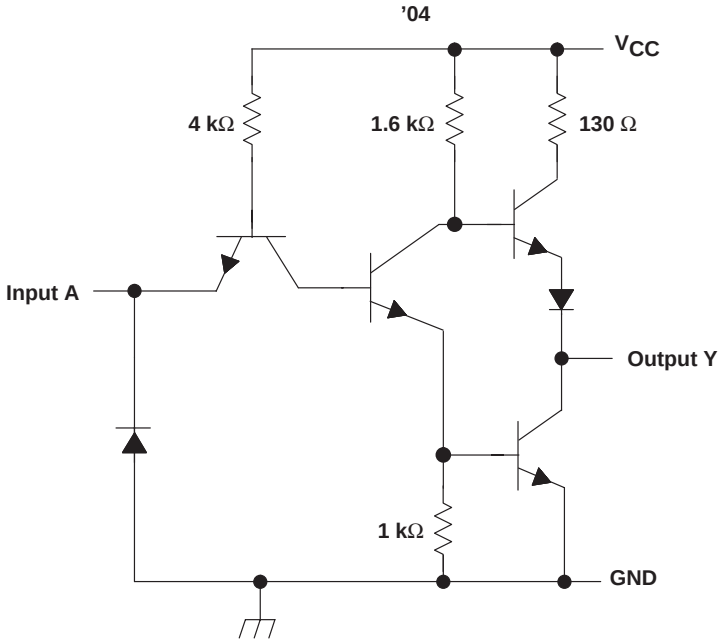
INPUT A	OUTPUT Y
H	L
L	H

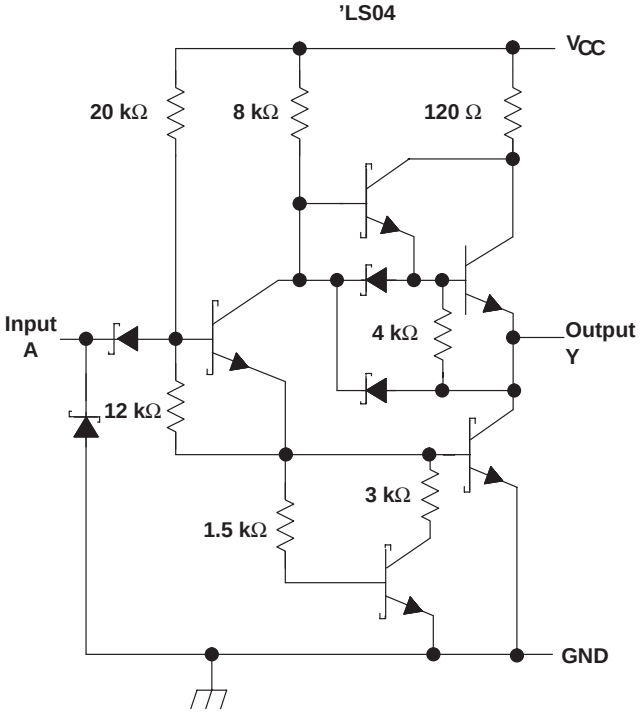
logic diagram (positive logic)

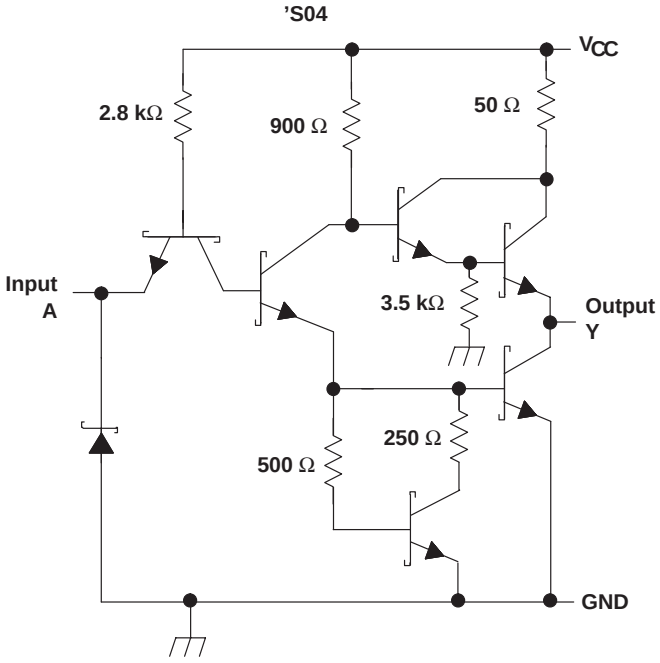


$Y = \overline{A}$

schematics (each gate)







Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage, V_I: '04, 'S04 . . . . . 5.5 V
'LS04 . . . . . 7 V
Package thermal impedance, θ_{JA} (see Note 2): D package . . . . . 86°C/W
DB package . . . . . 96°C/W
N package . . . . . 80°C/W
NS package . . . . . 76°C/W
Storage temperature range, T_{stg} . . . . . −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. This are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to network ground terminal.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		SN5404			SN7404			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			16			16	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS‡			SN5404			SN7404			UNIT
				MIN	TYP§	MAX	MIN	TYP§	MAX	
V_{IK}	V_{CC} = MIN,	I_I = −12 mA				−1.5			−1.5	V
V_{OH}	V_{CC} = MIN,	V_{IL} = 0.8 V,	I_{OH} = −0.4 mA	2.4	3.4		2.4	3.4		V
V_{OL}	V_{CC} = MIN,	V_{IH} = 2 V,	I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	V_{CC} = MAX,	V_I = 5.5 V				1			1	mA
I_{IH}	V_{CC} = MAX,	V_I = 2.4 V				40			40	µA
I_{IL}	V_{CC} = MAX,	V_I = 0.4 V				−1.6			−1.6	mA
I_{OS}¶	V_{CC} = MAX			−20		−55	−18		−55	mA
I_{CCH}	V_{CC} = MAX,	V_I = 0 V			6	12		6	12	mA
I_{CCL}	V_{CC} = MAX,	V_I = 4.5 V			18	33		18	33	mA

‡ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
§ All typical values are at V_{CC} = 5 V, T_A = 25°C.
¶ Not more than one output should be shorted at a time.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN5404 SN7404			UNIT
				MIN	TYP	MAX	
t_{PLH}	A	Y	R_L = 400 Ω, C_L = 15 pF		12	22	ns
t_{PHL}					8	15	

recommended operating conditions (see Note 3)

		SN54LS04			SN74LS04			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†			SN54LS04			SN74LS04			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}	V_{CC} = MIN,	V_{IL} = MAX,	I_{OH} = −0.4 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN,	V_{IH} = 2 V	I_{OL} = 4 mA		0.25	0.4			0.4	V
			I_{OL} = 8 mA					0.25	0.5	
I_I	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
I_{IH}	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
I_{IL}	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
I_{OS}§	V_{CC} = MAX			−20		−100	−20		−100	mA
I_{CCH}	V_{CC} = MAX,	V_I = 0 V			1.2	2.4		1.2	2.4	mA
I_{CCL}	V_{CC} = MAX,	V_I = 4.5 V			3.6	6.6		3.6	6.6	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	SN54LS04 SN74LS04			UNIT
				MIN	TYP	MAX	
t_{PLH}	A	Y	R_L = 2 kΩ, C_L = 15 pF		9	15	ns
t_{PHL}					10	15	

recommended operating conditions (see Note 3)

		SN54S04			SN74S04			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			−1			−1	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

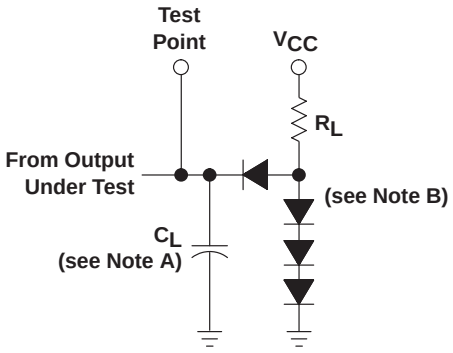
PARAMETER	TEST CONDITIONS†			SN54S04			SN74S04			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = MIN,	I_I = −18 mA				−1.2			−1.2	V
V_{OH}	V_{CC} = MIN,	V_{IL} = 0.8 V,	I_{OH} = −1 mA	2.5	3.4		2.7	3.4		V
V_{OL}	V_{CC} = MIN,	V_{IH} = 2 V,	I_{OL} = 20 mA			0.5			0.5	V
I_I	V_{CC} = MAX,	V_I = 5.5 V				1			1	mA
I_{IH}	V_{CC} = MAX,	V_I = 2.7 V				50			50	µA
I_{IL}	V_{CC} = MAX,	V_I = 0.5 V				−2			−2	mA
I_{OS}§	V_{CC} = MAX			−40		−100	−40		−100	mA
I_{CCH}	V_{CC} = MAX,	V_I = 0 V			15	24		15	24	mA
I_{CCL}	V_{CC} = MAX,	V_I = 4.5 V			30	54		30	54	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

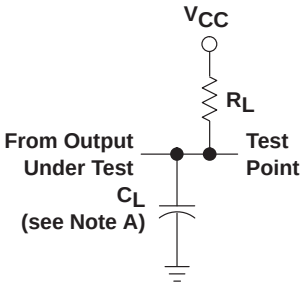
switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		SN54S04 SN74S04			UNIT
					MIN	TYP	MAX	
t_{PLH}	A	Y	R_L = 280 Ω,	C_L = 15 pF		3	4.5	ns
t_{PHL}						3	5	
t_{PLH}	A	Y	R_L = 280 Ω,	C_L = 50 pF		4.5		ns
t_{PHL}						5		

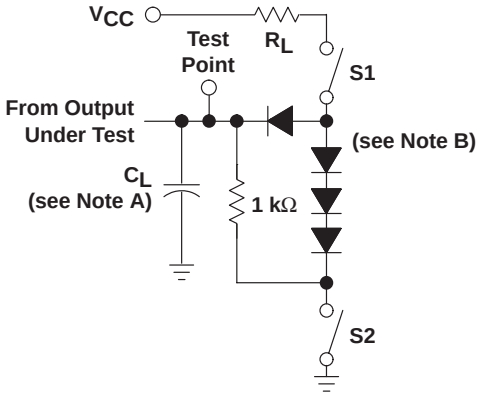
PARAMETER MEASUREMENT INFORMATION
SERIES 54/74 AND 54S/74S DEVICES



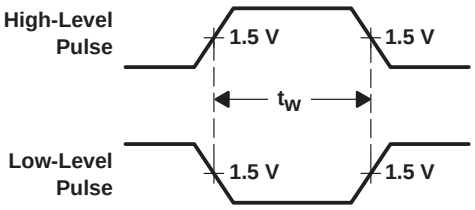
**LOAD CIRCUIT
FOR 2-STATE TOTEM-POLE OUTPUTS**



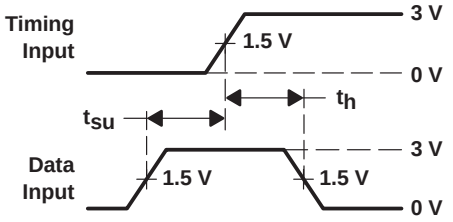
**LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS**



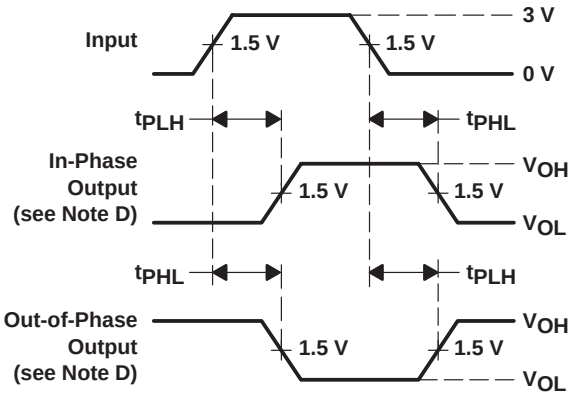
**LOAD CIRCUIT
FOR 3-STATE OUTPUTS**



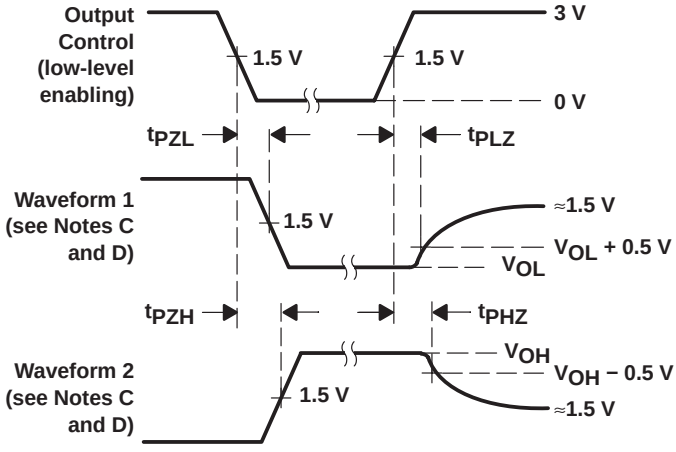
**VOLTAGE WAVEFORMS
PULSE DURATIONS**



**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES**

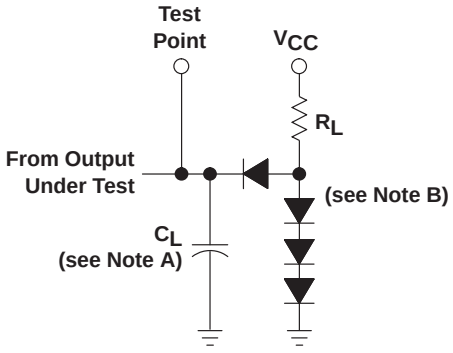


**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS**

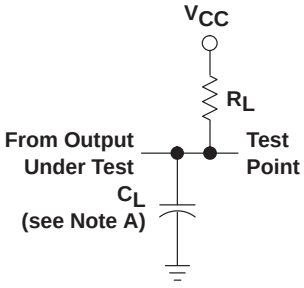
NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
D. S1 and S2 are closed for t_{PLH}, t_{PHL}, t_{PHZ}, and t_{PLZ}; S1 is open and S2 is closed for t_{PZH}; S1 is closed and S2 is open for t_{PZL}.
E. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O \approx 50\ \Omega$; t_r and $t_f \leq 7$ ns for Series 54/74 devices and t_r and $t_f \leq 2.5$ ns for Series 54S/74S devices.
F. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

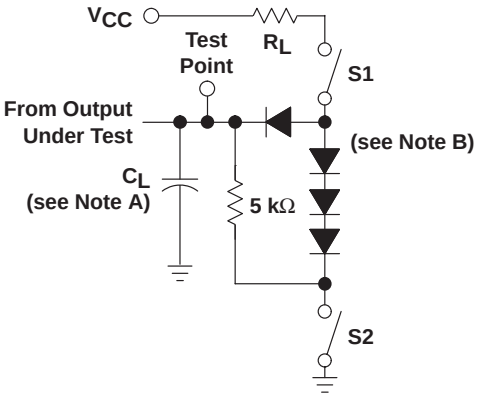
PARAMETER MEASUREMENT INFORMATION
SERIES 54LS/74LS DEVICES



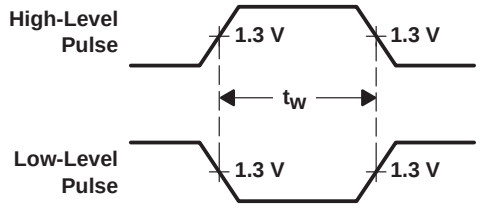
LOAD CIRCUIT
FOR 2-STATE TOTEM-POLE OUTPUTS



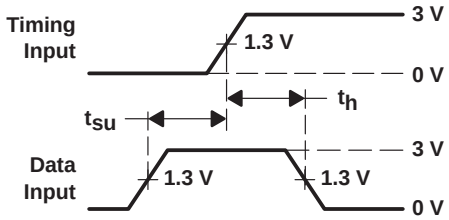
LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS



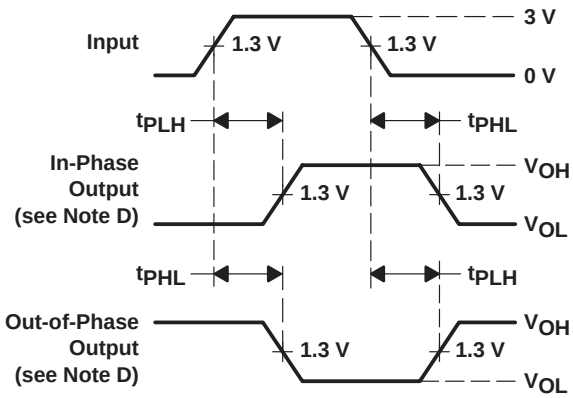
LOAD CIRCUIT
FOR 3-STATE OUTPUTS



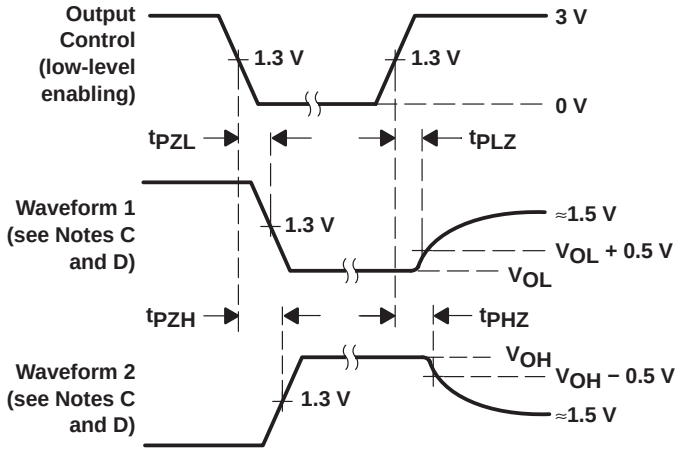
VOLTAGE WAVEFORMS
PULSE DURATIONS



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
D. S1 and S2 are closed for t_{PLH}, t_{PHL}, t_{PHZ}, and t_{PLZ}; S1 is open and S2 is closed for t_{PZH}; S1 is closed and S2 is open for t_{PZL}.
E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
F. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O \approx 50\ \Omega$, $t_r \le 1.5$ ns, $t_f \le 2.6$ ns.
G. The outputs are measured one at a time, with one input transition per measurement.

Figure 2. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/00105BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 00105BCA	Samples
JM38510/00105BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 00105BDA	Samples
JM38510/07003BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 07003BCA	Samples
JM38510/07003BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 07003BDA	Samples
JM38510/30003B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30003B2A	Samples
JM38510/30003BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30003BCA	Samples
JM38510/30003BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30003BDA	Samples
JM38510/30003SCA	ACTIVE	CDIP	J	14	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30003SCA	Samples
M38510/00105BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 00105BCA	Samples
M38510/00105BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 00105BDA	Samples
M38510/07003BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 07003BCA	Samples
M38510/07003BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 07003BDA	Samples
M38510/30003B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/ 30003B2A	Samples
M38510/30003BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30003BCA	Samples
M38510/30003BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30003BDA	Samples
M38510/30003SCA	ACTIVE	CDIP	J	14	25	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 30003SCA	Samples
SN5404J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN5404J	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN54LS04J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS04J	Samples
SN54S04J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54S04J	Samples
SN7404D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7404	Samples
SN7404DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7404	Samples
SN7404DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7404	Samples
SN7404DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	7404	Samples
SN7404N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN7404N	Samples
SN7404N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70		
SN7404NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN7404N	Samples
SN74LS04D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS04	Samples
SN74LS04DBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		LS04	Samples
SN74LS04DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS04	Samples
SN74LS04DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS04	Samples
SN74LS04DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS04	Samples
SN74LS04DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS04	Samples
SN74LS04J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	0 to 70		
SN74LS04N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS04N	Samples
SN74LS04N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70		
SN74LS04NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS04N	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS04NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS04	Samples
SN74LS04NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS04	Samples
SN74S04D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	S04	Samples
SN74S04DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	S04	Samples
SN74S04DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	S04	Samples
SN74S04N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74S04N	Samples
SN74S04N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70		
SN74S04NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74S04N	Samples
SN74S04NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74S04	Samples
SNJ5404J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ5404J	Samples
SNJ5404W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ5404W	Samples
SNJ54LS04FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS 04FK	Samples
SNJ54LS04J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS04J	Samples
SNJ54LS04W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS04W	Samples
SNJ54S04FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54S 04FK	Samples
SNJ54S04J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54S04J	Samples
SNJ54S04W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54S04W	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN5404, SN54LS04, SN54LS04-SP, SN54S04, SN7404, SN74LS04, SN74S04 :

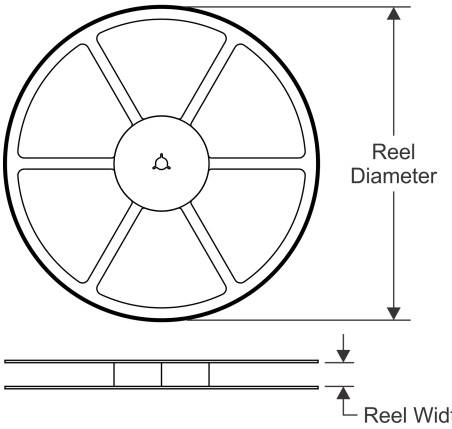
- Catalog: SN7404, SN74LS04, SN54LS04, SN74S04
- Military: SN5404, SN54LS04, SN54S04
- Space: SN54LS04-SP

NOTE: Qualified Version Definitions:

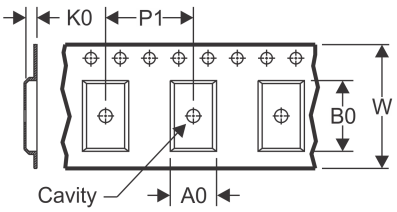
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

TAPE AND REEL INFORMATION

REEL DIMENSIONS

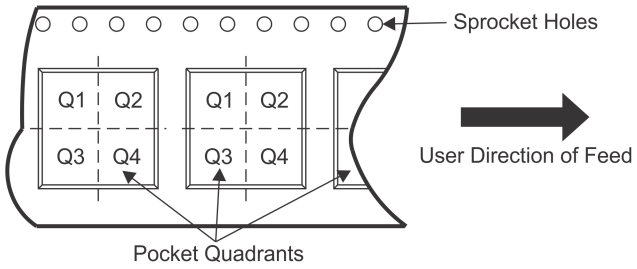


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

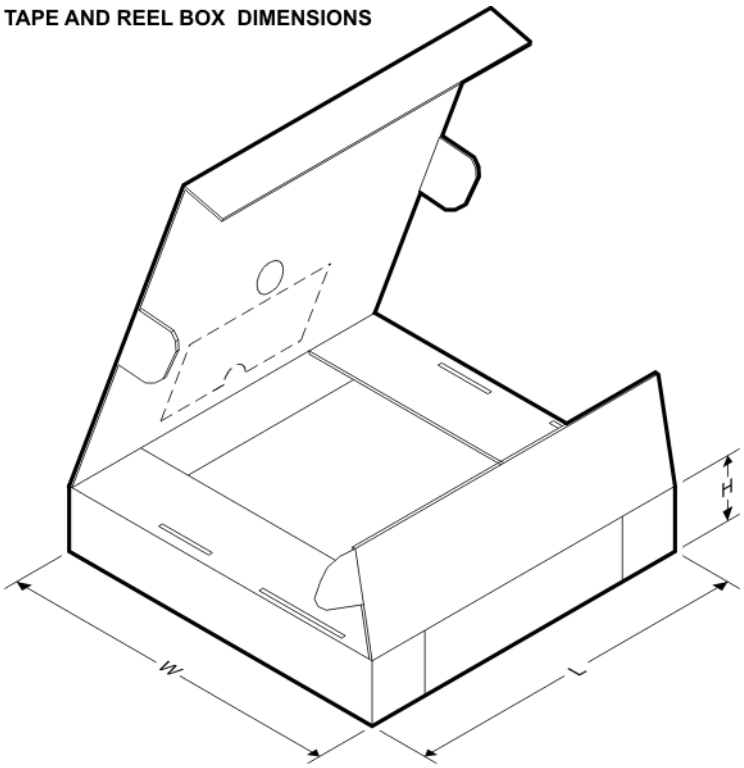
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN7404DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS04DBR	SSOP	DB	14	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1
SN74LS04DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74S04DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74S04NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



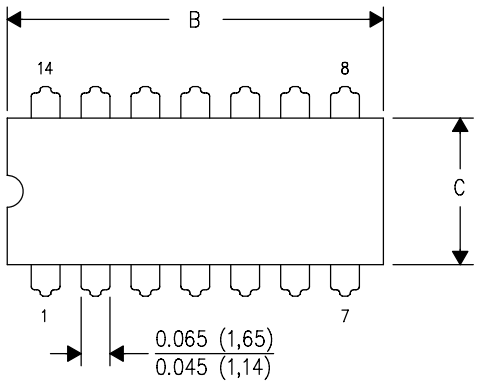
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN7404DR	SOIC	D	14	2500	367.0	367.0	38.0
SN74LS04DBR	SSOP	DB	14	2000	367.0	367.0	38.0
SN74LS04DR	SOIC	D	14	2500	367.0	367.0	38.0
SN74S04DR	SOIC	D	14	2500	367.0	367.0	38.0
SN74S04NSR	SO	NS	14	2000	367.0	367.0	38.0

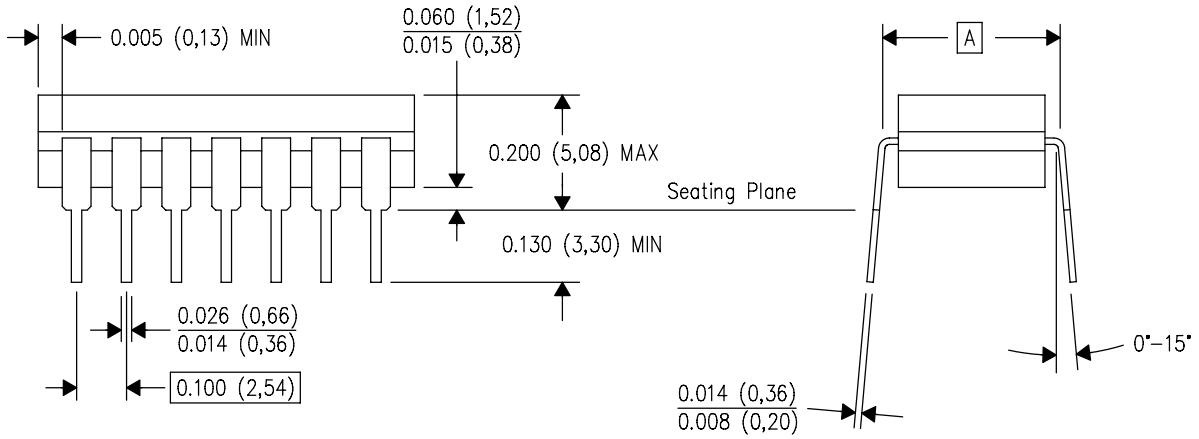
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



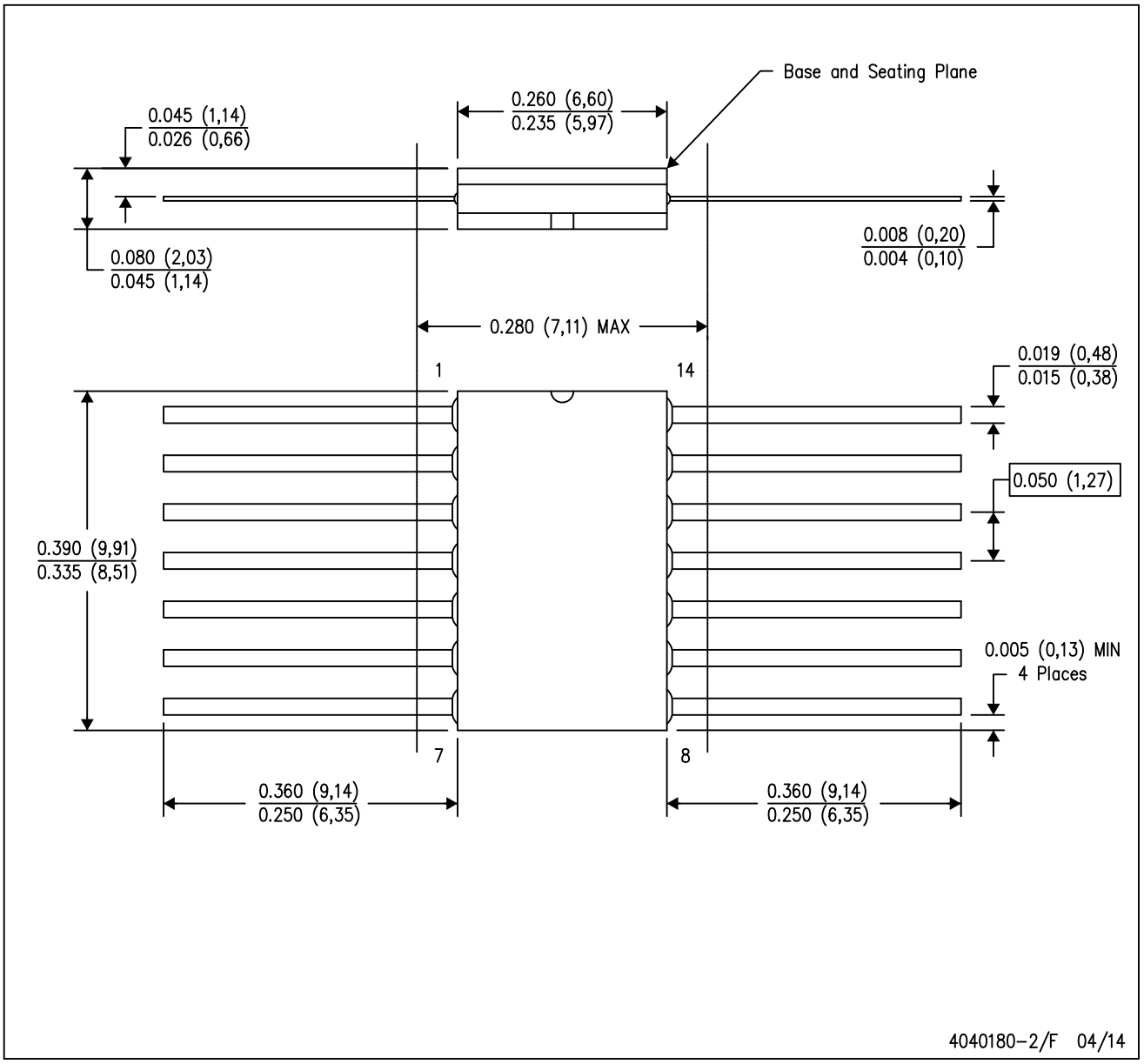
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

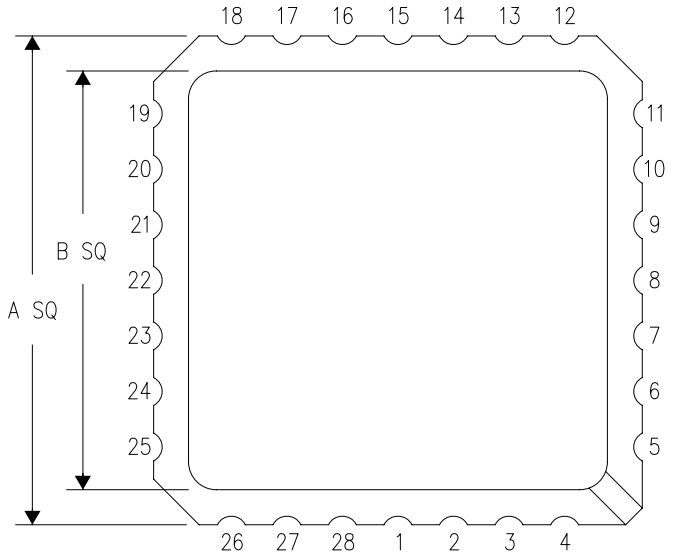
W (R–GDFP–F14) CERAMIC DUAL FLATPACK



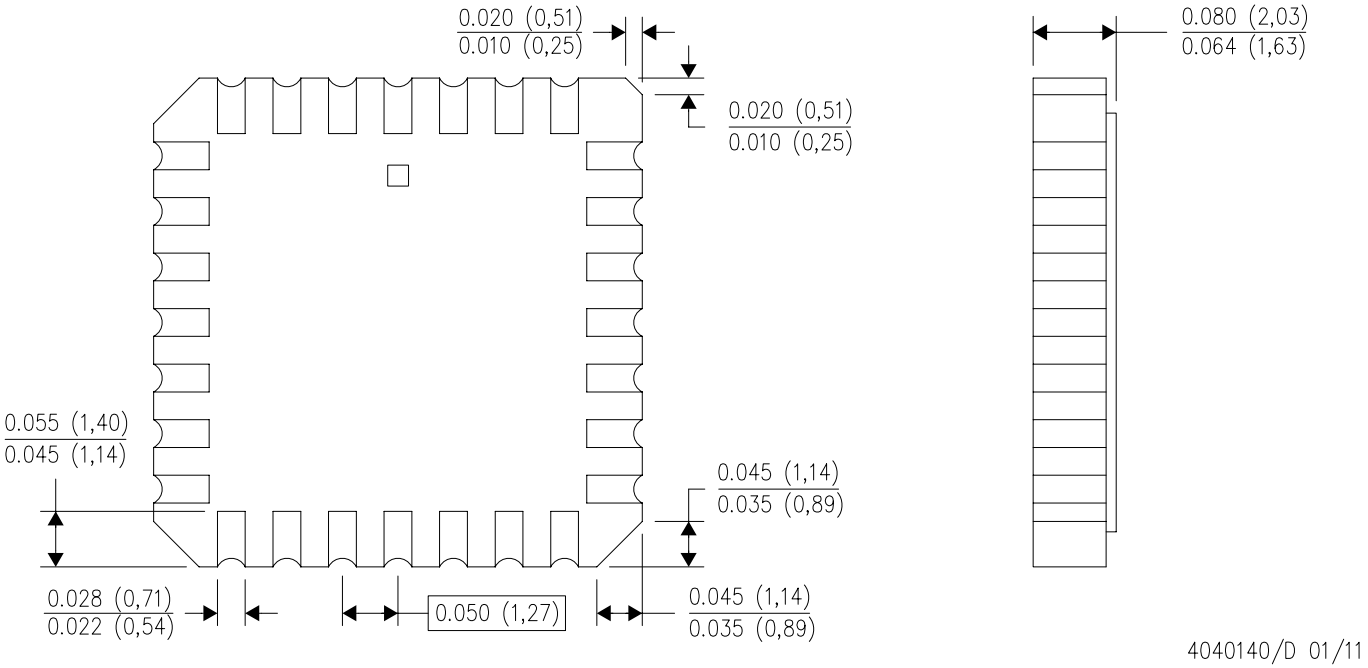
NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F14

FK (S–CQCC–N**) LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



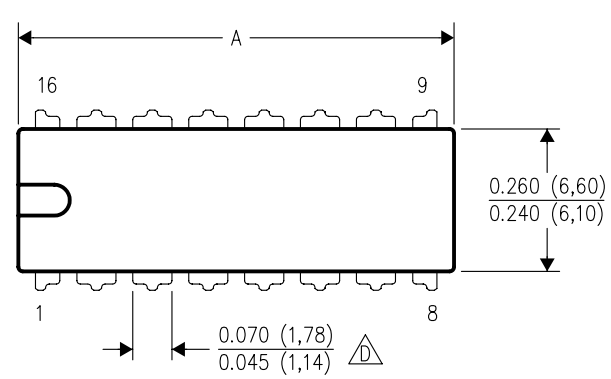
4040140/D 01/11

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. Falls within JEDEC MS–004

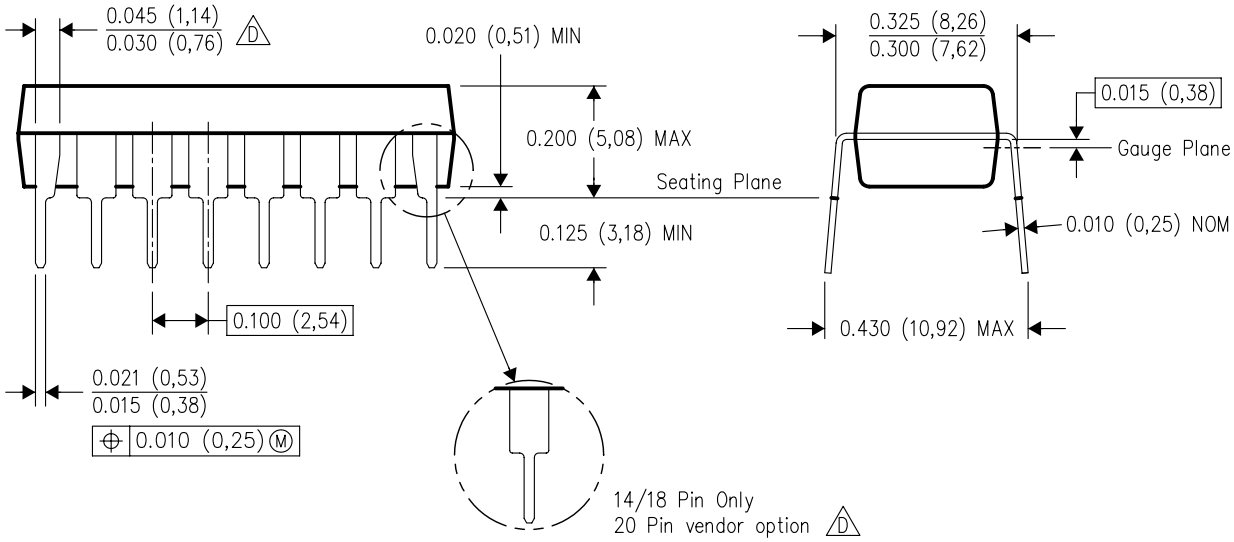
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



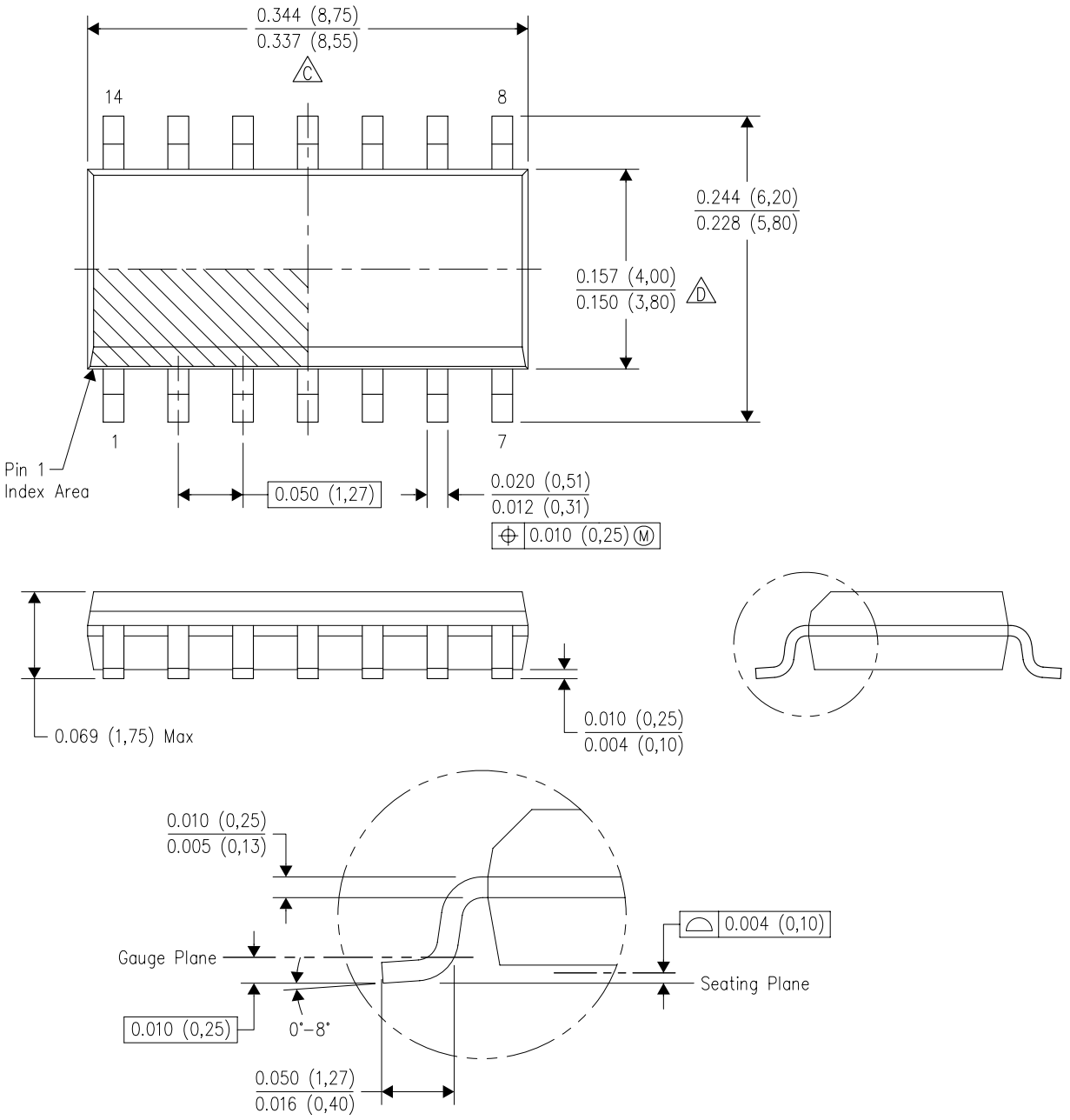
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

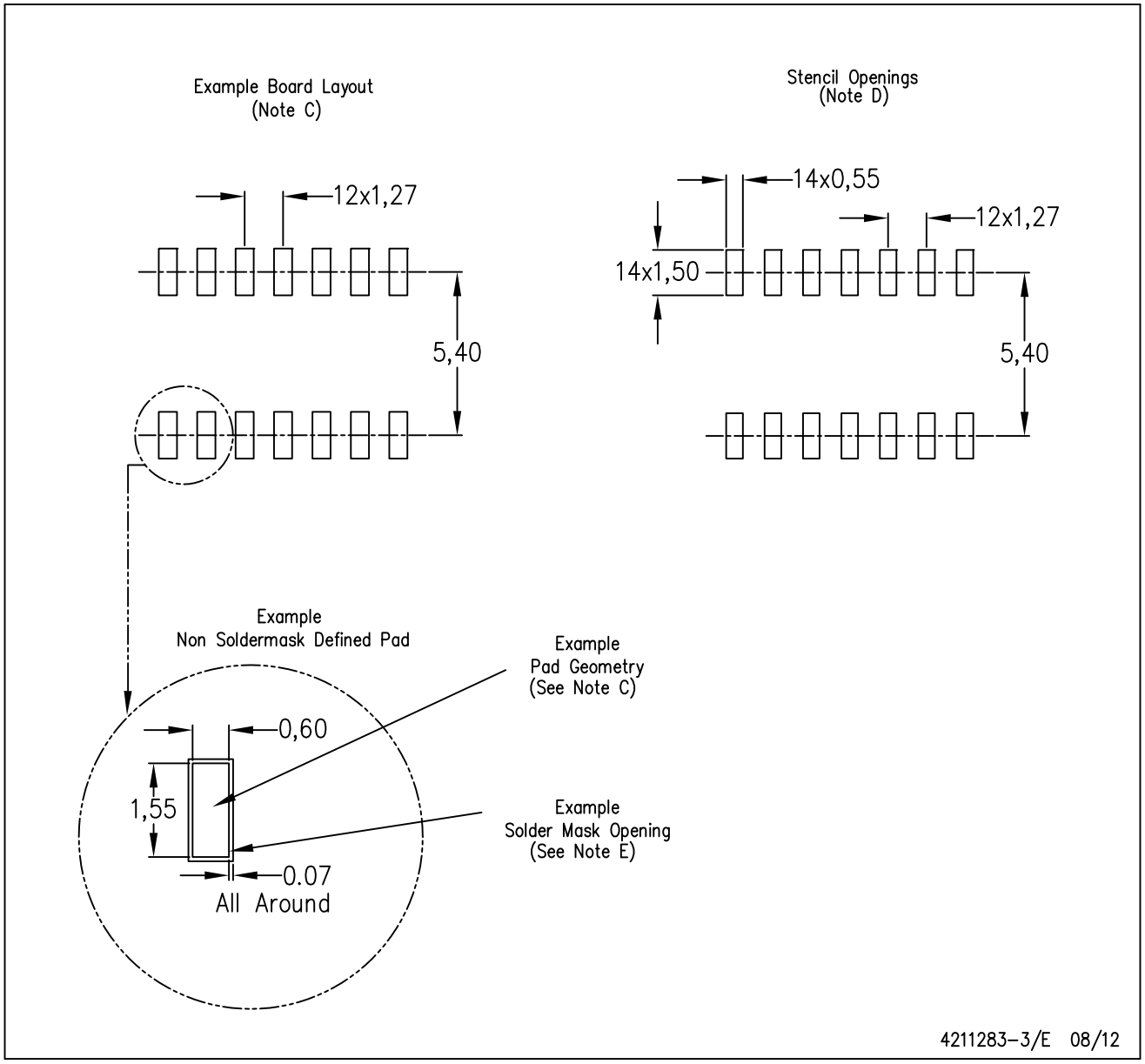
D (R–PDSO–G14) PLASTIC SMALL OUTLINE



4040047–5/M 06/11

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AB.

D (R–PDSO–G14) PLASTIC SMALL OUTLINE

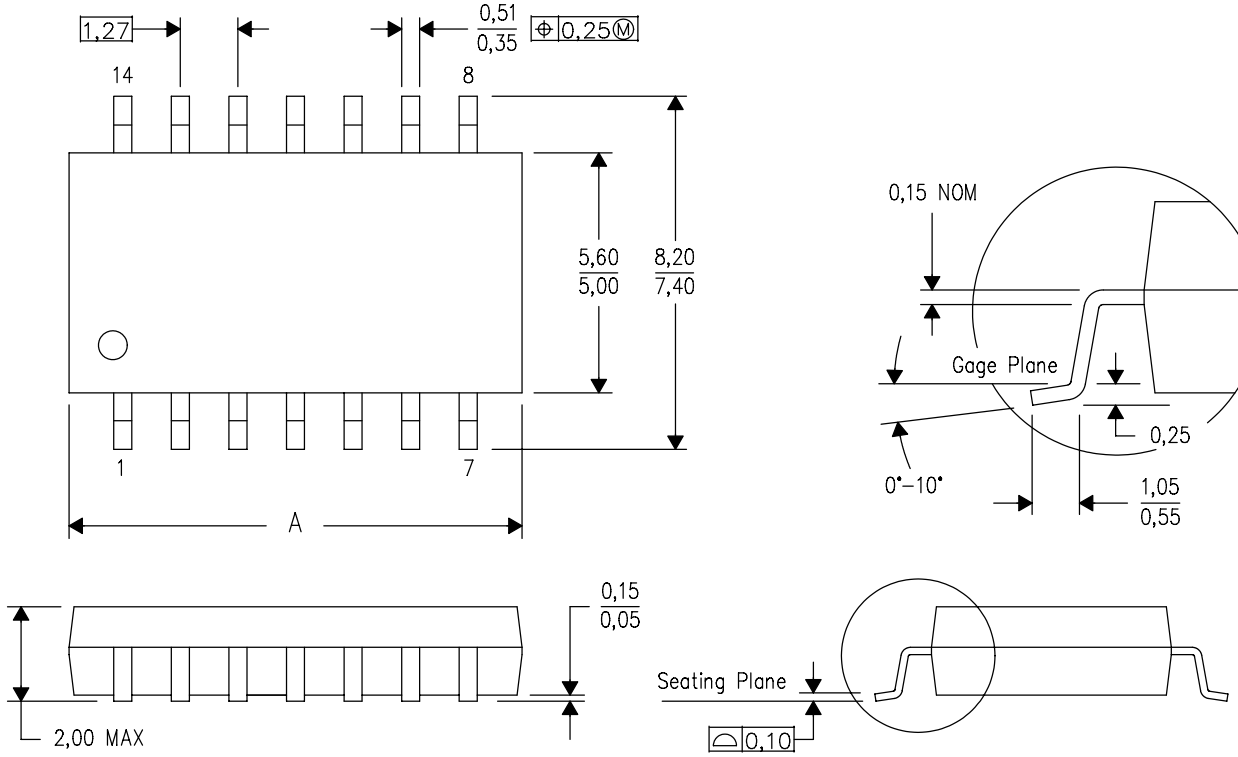


NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC–7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC–7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

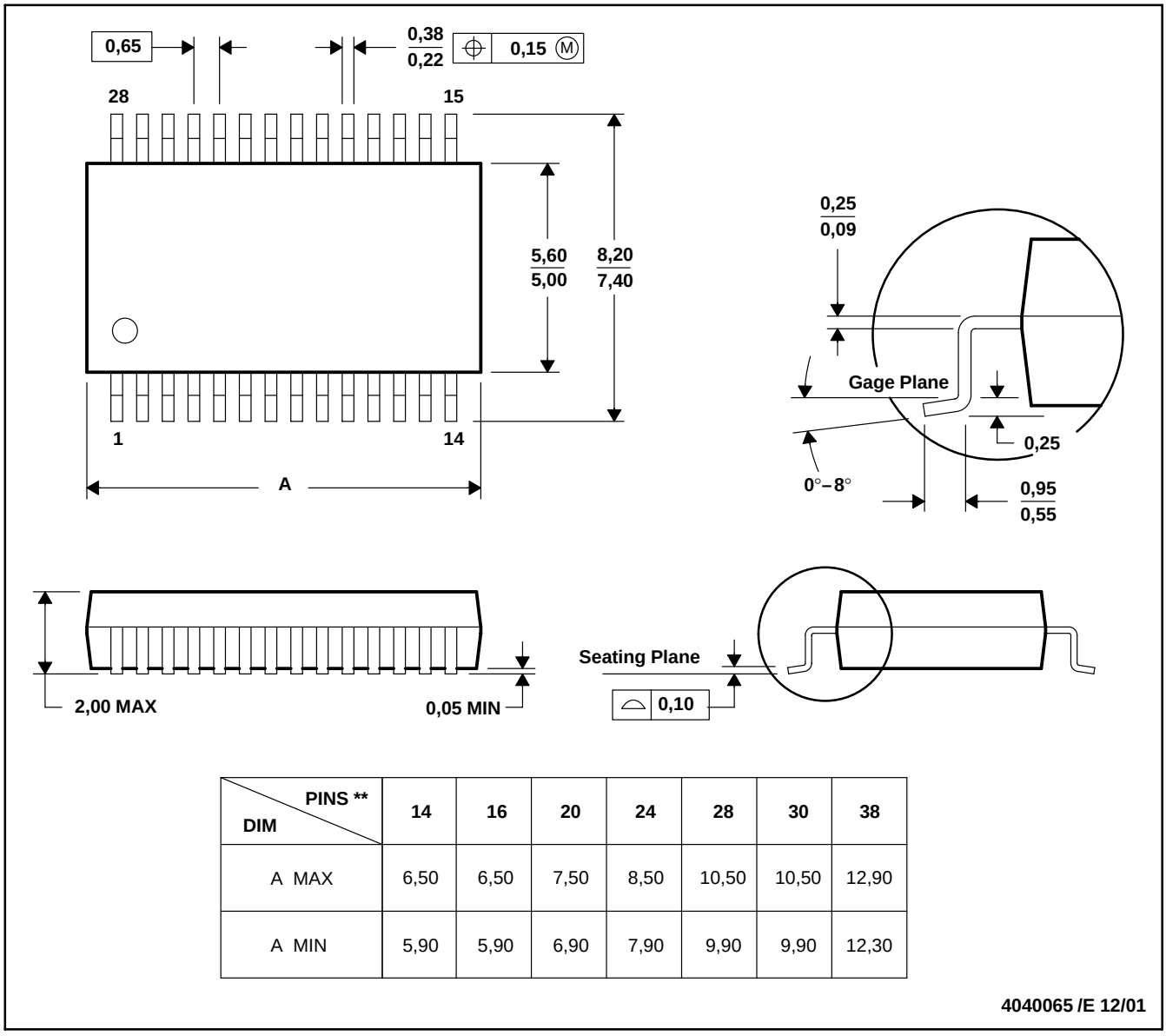
4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

MSSO002E – JANUARY 1995 – REVISED DECEMBER 2001

DB (R-PDSO-G)** **PLASTIC SMALL-OUTLINE**

28 PINS SHOWN



DIM \ PINS **	14	16	20	24	28	30	38
A MAX	6,50	6,50	7,50	8,50	10,50	10,50	12,90
A MIN	5,90	5,90	6,90	7,90	9,90	9,90	12,30

4040065 /E 12/01

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-150

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FAIRCHILD SEMICONDUCTOR™

March 1998

DM7408
Quad 2-Input AND Gates

General Description

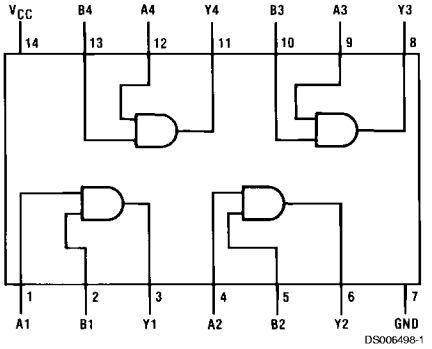
This device contains four independent gates each of which performs the logic AND function.

Features

- Alternate Military/Aerospace device (5408) is available. Contact a Fairchild Semiconductor Sales Office/Distributor for specifications.

Connection Diagram

Dual-In-Line Package



Order Number 5408DMQB, 5408FMQB, DM5408J, DM5408W or DM7408N
See Package Number J14A, N14A or W14B

Function Table

Y = AB

Inputs		Output
A	B	Y
L	L	L
L	H	L
H	L	L
H	H	H

H = High Logic Level
L = Low Logic Level

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Absolute Maximum Ratings (Note 1)

Supply Voltage	7V
Input Voltage	5.5V
Operating Free Air Temperature Range	
DM54 and 54	−55°C to +125°C
DM74	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Recommended Operating Conditions

Symbol	Parameter	DM5408			DM7408			Units
		Min	Nom	Max	Min	Nom	Max	
V_{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High Level Input Voltage	2			2			V
V_{IL}	Low Level Input Voltage			0.8			0.8	V
I_{OH}	High Level Output Current			−0.8			−0.8	mA
I_{OL}	Low Level Output Current			16			16	mA
T_A	Free Air Operating Temperature	−55		125	0		70	°C

Note 1: *The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.*

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −12 mA				−1.5	V
V_{OH}	High Level Output Voltage	V_{CC} = Min, I_{OH} = Max V_{IL} = Max		2.4	3.4		V
V_{OL}	Low Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IH} = Min			0.2	0.4	V
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 5.5V				1	mA
I_{IH}	High Level Input Current	V_{CC} = Max, V_I = 2.4V				40	µA
I_{IL}	Low Level Input Current	V_{CC} = Max, V_I = 0.4V				−1.6	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	DM54	−20		−55	mA
			DM74	−18		−55	
I_{CCH}	Supply Current with Outputs High	V_{CC} = Max			11	21	mA
I_{CCL}	Supply Current with Outputs Low	V_{CC} = Max			20	33	mA

Switching Characteristics

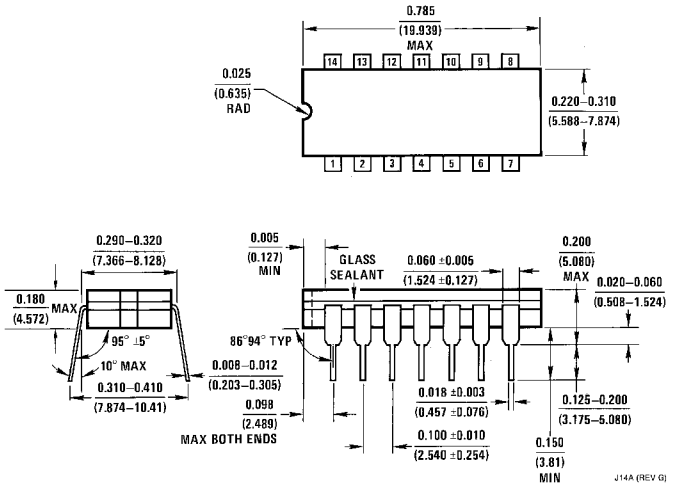
at V_{CC} = 5V and T_A = 25°C (See Section 1 for Test Waveforms and Output Load)

Symbol	Parameter	Conditions	Min	Max	Units
t_{PLH}	Propagation Delay Time Low to High Level Output	C_L = 15 pF R_L = 400Ω		27	ns
t_{PHL}	Propagation Delay Time High to Low Level Output			19	ns

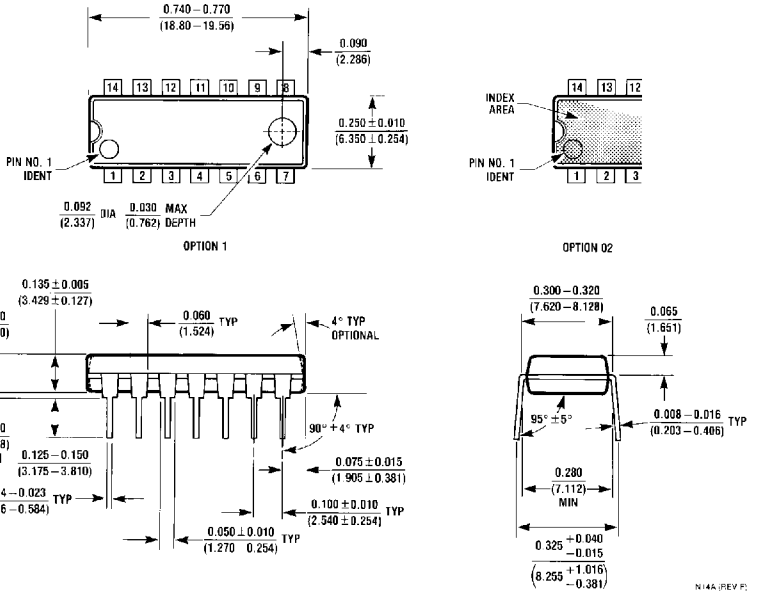
Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 3: Not more than one output should be shorted at a time.

Physical Dimensions inches (millimeters) unless otherwise noted

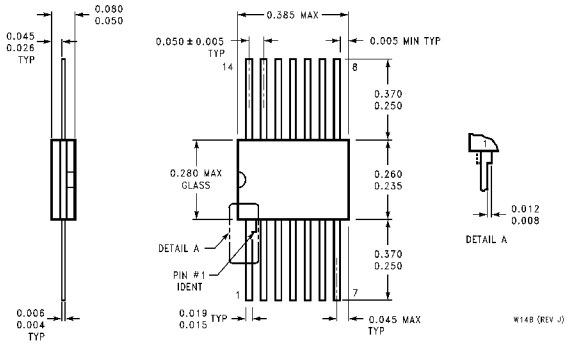


14-Lead Ceramic Dual-In-Line Package (J)
Order Number 5408DMQB or DM5408J
Package Number J14A



14-Lead Molded Dual-In-Line Package (N)
Order Number DM7408N
Package Number N14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Ceramic Flat Package (W)
Order Number 5408FMQB or DM5408W
Package Number W14B

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Fairchild Semiconductor Corporation
Americas
Customer Response Center
Tel: 1-888-522-5372

Fairchild Semiconductor Europe
Fax: +49 (0) 1 80-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 8 141-35-0
English Tel: +44 (0) 1 793-85-68-56
Italy Tel: +39 (0) 2 57 5631

Fairchild Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: +852 2737-7200
Fax: +852 2314-0061

National Semiconductor Japan Ltd.
Tel: 81-3-5620-6175
Fax: 81-3-5620-6179

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FAIRCHILD SEMICONDUCTOR™

June 1986
Revised March 2000

DM74LS32
Quad 2-Input OR Gate

General Description

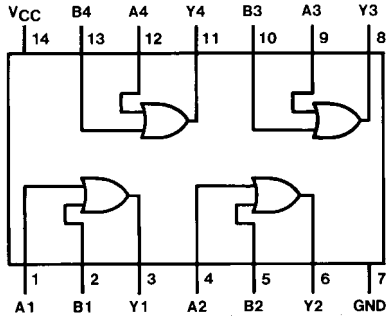
This device contains four independent gates each of which performs the logic OR function.

Ordering Code:

Order Number	Package Number	Package Description
DM74LS32M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
DM74LS32SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74LS32N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Function Table

$Y = A + B$

Inputs		Output
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	H

H = HIGH Logic Level
L = LOW Logic Level

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Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−0.4	mA
I_{OL}	LOW Level Output Current			8	mA
T_A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max, V_{IH} = Min	2.7	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max, V_{IL} = Max		0.35	0.5	V
		I_{OL} = 4 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.36	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	−20		−100	mA
I_{CCH}	Supply Current with Outputs HIGH	V_{CC} = Max		3.1	6.2	mA
I_{CCL}	Supply Current with Outputs LOW	V_{CC} = Max		4.9	9.8	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

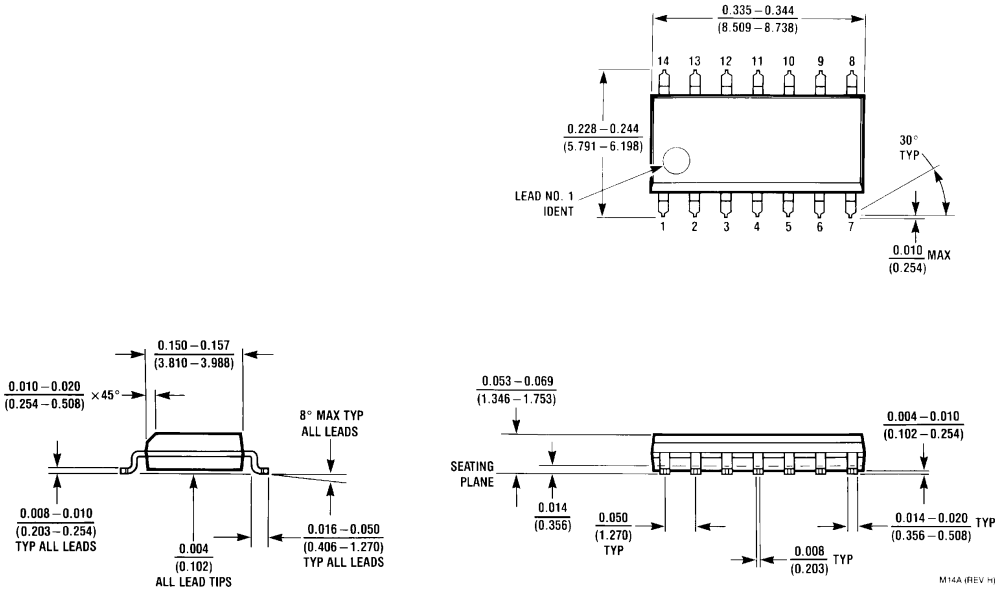
Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

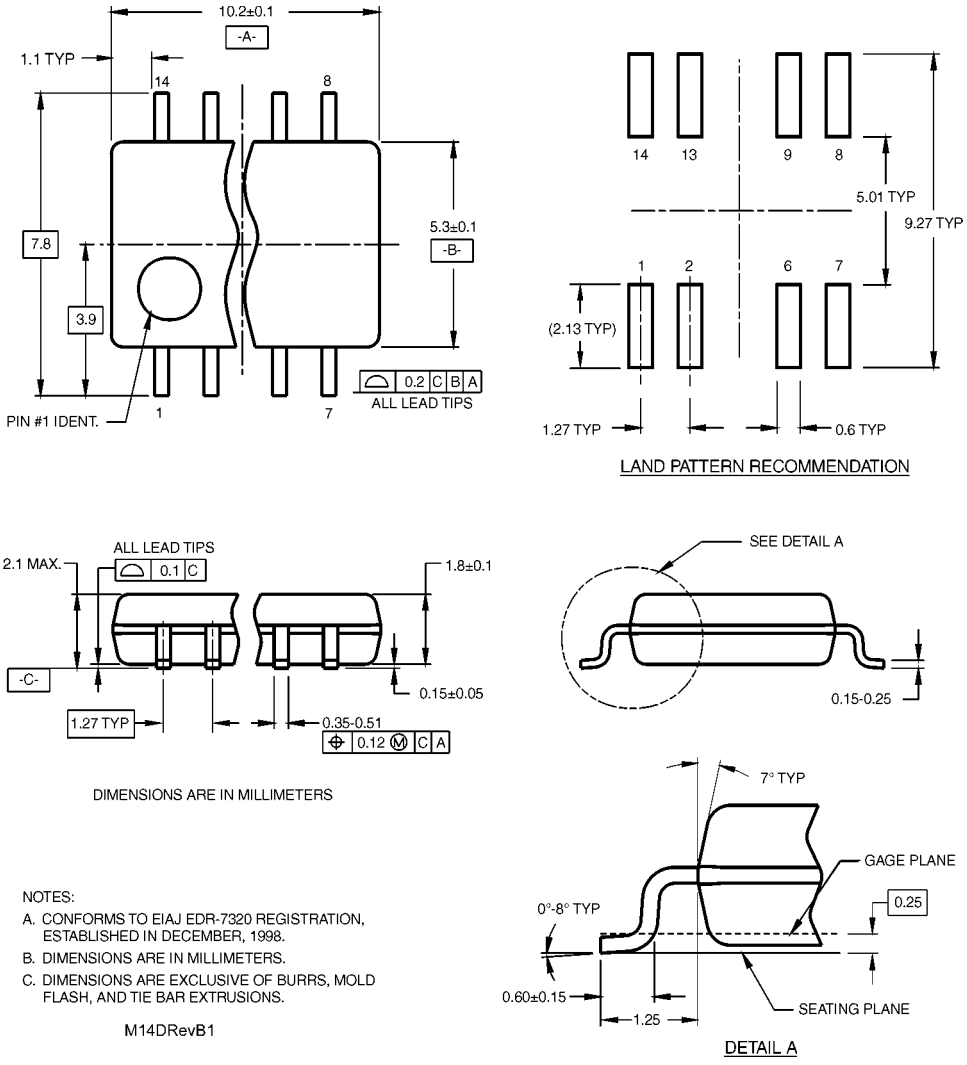
Symbol	Parameter	R_L = 2 kΩ				Units
		C_L = 15 pF		C_L = 50 pF		
		Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	3	11	4	15	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	3	11	4	15	ns

Physical Dimensions inches (millimeters) unless otherwise noted



14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



NOTES:

A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.

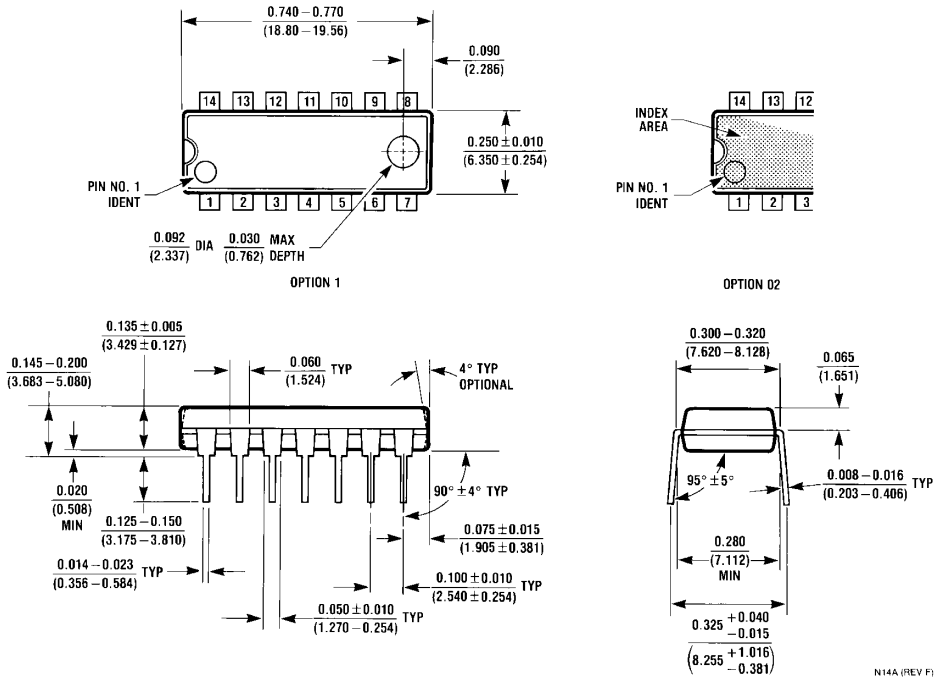
B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M14DRevB1

14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M14D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N14A

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National Semiconductor

June 1989

DM7446A, DM5447A/DM7447A BCD to 7-Segment Decoders/Drivers

General Description

The 46A and 47A feature active-low outputs designed for driving common-anode LEDs or incandescent indicators directly. All of the circuits have full ripple-blanking input/output controls and a lamp test input. Segment identification and resultant displays are shown on a following page. Display patterns for BCD input counts above nine are unique symbols to authenticate input conditions.

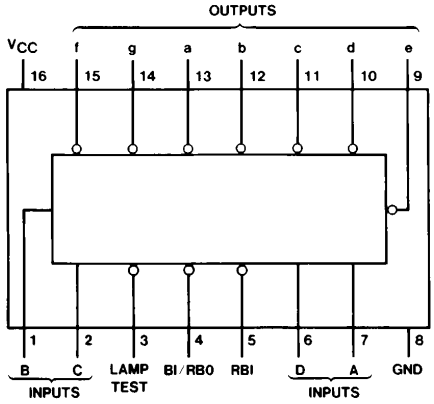
All of the circuits incorporate automatic leading and/or trailing-edge, zero-blanking control (RBI and RBO). Lamp test (LT) of these devices may be performed at any time when the BI/RBO node is at a high logic level. All types contain an overriding blanking input (BI) which can be used to control the lamp intensity (by pulsing) or to inhibit the outputs.

Features

- All circuit types feature lamp intensity modulation capability
- Open-collector outputs drive indicators directly
- Lamp-test provision
- Leading/trailing zero suppression

Connection Diagram

Dual-In-Line Package



TL/F/6518–1

Order Number DM5447AJ, DM7446AN or DM7447AN
See NS Package Number J16A or N16E

DM7446A, DM5447A/DM7447A BCD to 7-Segment Decoders/Drivers

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RRD-B30M105/Printed in U. S. A.

Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	5.5V
Operating Free Air Temperature Range	
DM54	−55°C to +125°C
DM74	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note: *The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.*

Recommended Operating Conditions

Symbol	Parameter	DM7446A			Units
		Min	Nom	Max	
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	High Level Input Voltage	2			V
V_{IL}	Low Level Input Voltage			0.8	V
V_{OH}	High Level Output Voltage (a thru g)			30	V
I_{OH}	High Level Output Current (BI/RBO)			−0.2	μA
I_{OL}	Low Level Output Current (a thru g)			40	mA
I_{OL}	Low Level Output Current (BI/RBO)			8	mA
T_A	Free Air Operating Temperature	0		70	°C

'46A Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ (Note 1)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −12 mA				−1.5	V
V_{OH}	High Level Output Voltage (BI/RBO)	V_{CC} = Min I_{OH} = Max		2.4	3.7		V
I_{CEX}	High Level Output Current (a thru g)	V_{CC} = Max, V_O = 30V V_{IL} = Max, V_{IH} = Min				250	μA
V_{OL}	Low Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IH} = Min, V_{IL} = Max			0.3	0.4	V
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 5.5V (Except BI/RBO)				1	mA
I_{IH}	High Level Input Current	V_{CC} = Max, V_I = 2.4V (Except BI/RBO)				40	μA
I_{IL}	Low Level Input Current	V_{CC} = Max V_I = 0.4V	BI/RBO			−4	mA
			Others			−1.6	
I_{OS}	Short Circuit Output Current	V_{CC} = Max (BI/RBO)				−4	mA
I_{CC}	Supply Current	V_{CC} = Max (Note 2)			60	103	mA

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 2: I_{CC} is measured with all outputs open and all inputs at 4.5V.

'46A Switching Characteristics

at V_{CC} = 5V and T_A = 25°C (See Section 1 for Test Waveforms and Output Load)

Symbol	Parameter	Conditions	Min	Max	Units
t_{PLH}	Propagation Delay Time Low to High Level Output	C_L = 15 pF R_L = 120Ω		100	ns
t_{PHL}	Propagation Delay Time High to Low Level Output			100	ns

Recommended Operating Conditions

Symbol	Parameter	DM5447A			DM7447A			Units
		Min	Nom	Max	Min	Nom	Max	
V_{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High Level Input Voltage	2			2			V
V_{IL}	Low Level Input Voltage			0.8			0.8	V
V_{OH}	High Level Output Voltage (a thru g)			15			15	V
I_{OH}	High Level Output Current (BI/RBO)			−0.2			−0.2	μA
I_{OL}	Low Level Output Current (a thru g)			40			40	mA
I_{OL}	Low Level Output Current (BI/RBO)			8			8	mA
T_A	Free Air Operating Temperature	−55		125	0		70	°C

'47A Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ (Note 1)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −12 mA				−1.5	V
V_{OH}	High Level Output Voltage (BI/RBO)	V_{CC} = Min I_{OH} = Max		2.4	3.7		V
I_{CEX}	High Level Output Current (a thru g)	V_{CC} = Max, V_O = 15V V_{IL} = Max, V_{IH} = Min				250	μA
V_{OL}	Low Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IH} = Min, V_{IL} = Max			0.3	0.4	V
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 5.5V				1	mA
I_{IH}	High Level Input Current	V_{CC} = Max, V_I = 2.4V				40	μA
I_{IL}	Low Level Input Current	V_{CC} = Max V_I = 0.4V	BI/RBO			−4	mA
			Others			−1.6	
I_{OS}	Short Circuit Output Current	V_{CC} = Max (BI/RBO)				−4	mA
I_{CC}	Supply Current	V_{CC} = Max (Note 2)	DM54		60	85	mA
			DM74		60	103	

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 2: I_{CC} is measured with all outputs open and all inputs at 4.5V.

’47A Switching Characteristics

at V_{CC} = 5V and T_A = 25°C (See Section 1 for Test Waveforms and Output Load)

Symbol	Parameter	Conditions	Min	Max	Units
t_{PLH}	Propagation Delay Time Low to High Level Output	C_L = 15 pF R_L = 120Ω		100	ns
t_{PHL}	Propagation Delay Time High to Low Level Output			100	ns

Function Table

46A, 47A

Decimal or Function	Inputs						BI/RBO (Note 1)	Outputs							Note
	LT	RBI	D	C	B	A		a	b	c	d	e	f	g	
0	H	H	L	L	L	L	H	L	L	L	L	L	L	H	(2)
1	H	X	L	L	L	H	H	H	L	L	H	H	H	H	
2	H	X	L	L	H	L	H	L	L	H	L	L	H	L	
3	H	X	L	L	H	H	H	L	L	L	L	H	H	L	
4	H	X	L	H	L	L	H	H	L	L	H	H	L	L	
5	H	X	L	H	L	H	H	L	H	L	L	H	L	L	
6	H	X	L	H	H	L	H	H	H	L	L	L	L	L	
7	H	X	L	H	H	H	H	L	L	L	H	H	H	H	
8	H	X	H	L	L	L	H	L	L	L	L	L	L	L	
9	H	X	H	L	L	H	H	L	L	L	H	H	L	L	
10	H	X	H	L	H	L	H	H	H	H	L	L	H	L	
11	H	X	H	L	H	H	H	H	H	L	L	H	H	L	
12	H	X	H	H	L	L	H	H	L	H	H	H	L	L	
13	H	X	H	H	L	H	H	L	H	H	L	H	L	L	
14	H	X	H	H	H	L	H	H	H	H	L	L	L	L	
15	H	X	H	H	H	H	H	H	H	H	H	H	H	H	
BI	X	X	X	X	X	X	L	H	H	H	H	H	H	H	(3)
RBI	H	L	L	L	L	L	L	H	H	H	H	H	H	H	(4)
LT	L	X	X	X	X	X	H	L	L	L	L	L	L	L	(5)

Note 1: BI/RBO is a wire-AND logic serving as blanking input (BI) and/or ripple-blanking output (RBO).

Note 2: The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input (RBI) must be open or high if blanking of a decimal zero is not desired.

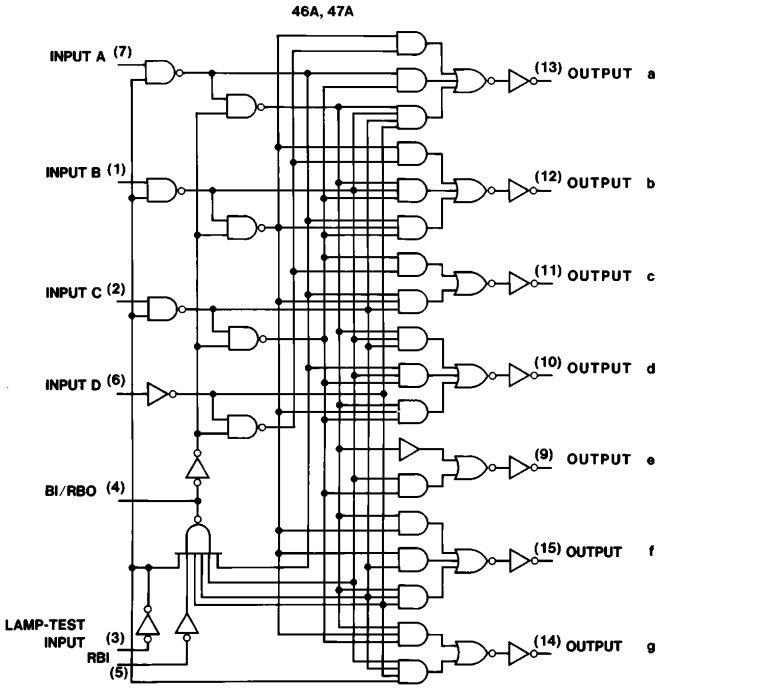
Note 3: When a low logic level is applied directly to the blanking input (BI), all segment outputs are high regardless of the level of any other input.

Note 4: When ripple-blanking input (RBI) and inputs A, B, C, and D are at a low level with the lamp test input high, all segment outputs go H and the ripple-blanking output (RBO) goes to a low level (response condition).

Note 5: When the blanking input/ripple-blanking output (BI/RBO) is open or held high and a low is applied to the lamp-test input, all segment outputs are L .

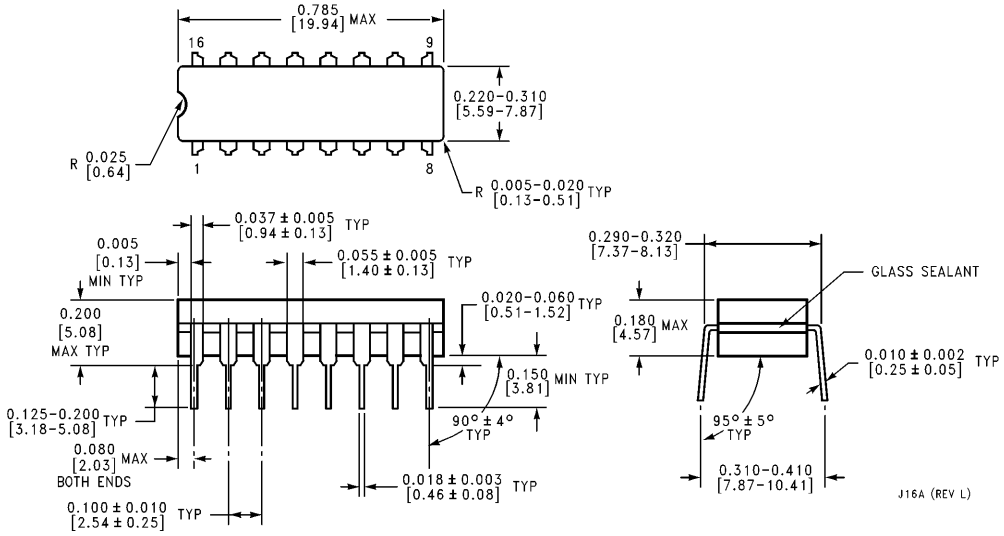
H = High level, L = Low level, X = Don’t Care

Logic Diagram



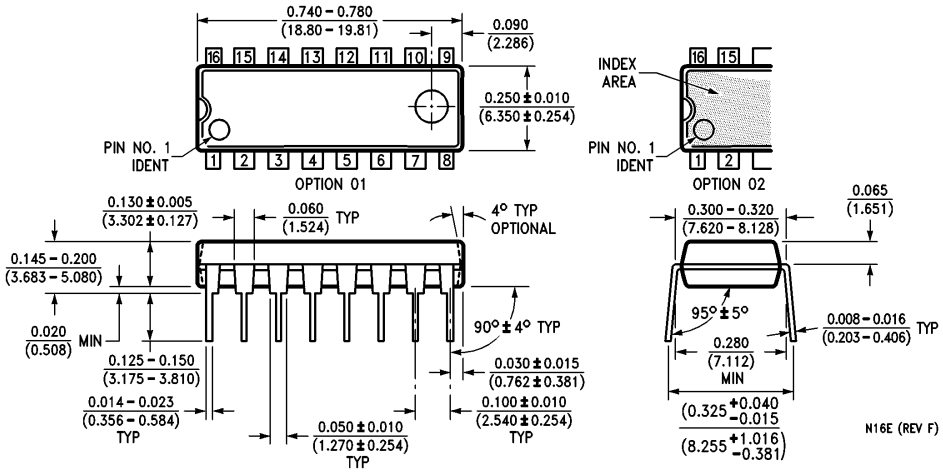
TL/F/6518–2

Physical Dimensions inches (millimeters)



16-Lead Ceramic Dual-In-Line Package (J)
Order Number DM5447AJ
NS Package Number J16A

Physical Dimensions inches (millimeters) (Continued)



16-Lead Molded Dual-In-Line Package (N)
Order Number DM7446AN or DM7447AN
NS Package Number N16E

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National Semiconductor Corporation
1111 West Bardin Road
Arlington, TX 76017
Tel: 1(800) 272-9959
Fax: 1(800) 737-7018

National Semiconductor Europe
Fax: (+49) 0-180-530 85 86
Email: cnjwge@tevm2.nsc.com
Deutsch Tel: (+49) 0-180-530 85 85
English Tel: (+49) 0-180-532 78 32
Français Tel: (+49) 0-180-532 93 58
Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: (852) 2737-1600
Fax: (852) 2736-9960

National Semiconductor Japan Ltd.
Tel: 81-043-299-2309
Fax: 81-043-299-2408

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DUAL D-TYPE POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH PRESET AND CLEAR

SDLS119 – DECEMBER 1983 – REVISED MARCH 1988

- **Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs**
- **Dependable Texas Instruments Quality and Reliability**

description

These devices contain two independent D-type positive-edge-triggered flip-flops. A low level at the preset or clear inputs sets or resets the outputs regardless of the levels of the other inputs. When preset and clear are inactive (high), data at the D input meeting the setup time requirements are transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold time interval, data at the D input may be changed without affecting the levels at the outputs.

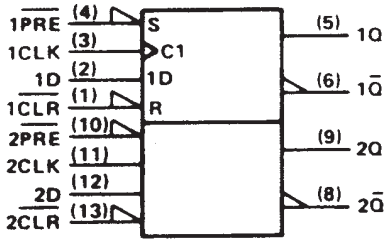
The SN54' family is characterized for operation over the full military temperature range of −55°C to 125°C. The SN74' family is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

INPUTS				OUTPUTS	
$\overline{PRE}$	$\overline{CLR}$	CLK	D	Q	$\overline{Q}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H†	H†
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	L	X	Q_0	$\overline{Q}_0$

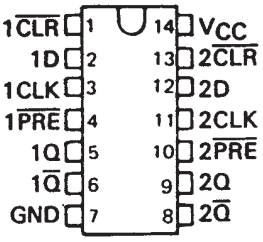
† The output levels in this configuration are not guaranteed to meet the minimum levels in V_{OH} if the lows at preset and clear are near V_{IL} maximum. Furthermore, this configuration is nonstable; that is, it will not persist when either preset or clear returns to its inactive (high) level.

logic symbol‡

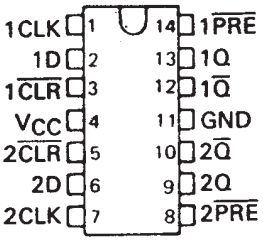


‡This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

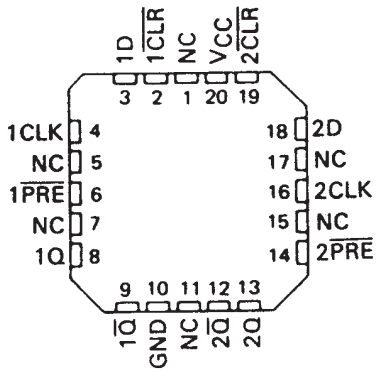
SN5474 . . . J PACKAGE
SN54LS74A, SN54S74 . . . J OR W PACKAGE
SN7474 . . . N PACKAGE
SN74LS74A, SN74S74 . . . D OR N PACKAGE
(TOP VIEW)



SN5474 . . . W PACKAGE
(TOP VIEW)

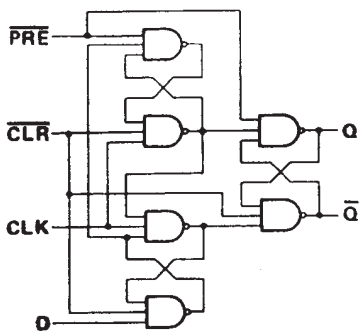


SN54LS74A, SN54S74 . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

logic diagram (positive logic)



PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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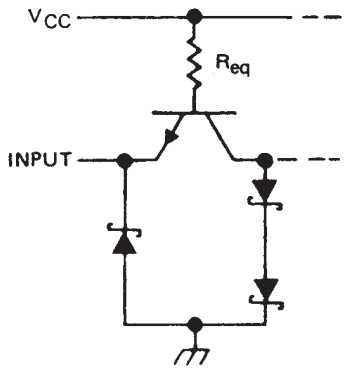
schematics of inputs and outputs

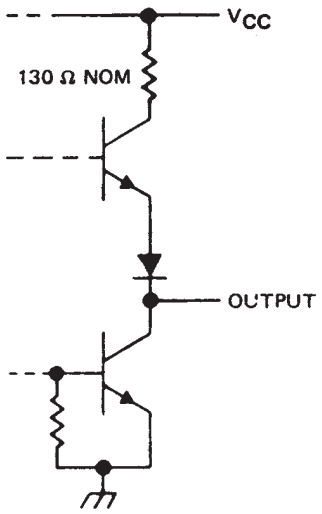
'74

EQUIVALENT OF EACH INPUT



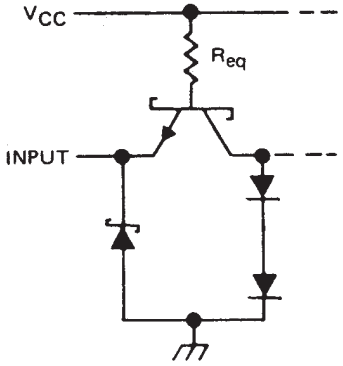
I_{IL} MAX	R_{eq} NOM
–1.6 mA	4 kΩ
–3.2 mA	2 kΩ

TYPICAL OF ALL OUTPUTS



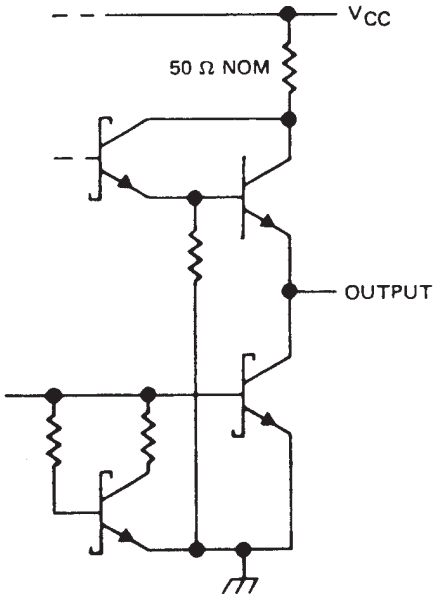
'S74

EQUIVALENT OF EACH INPUT



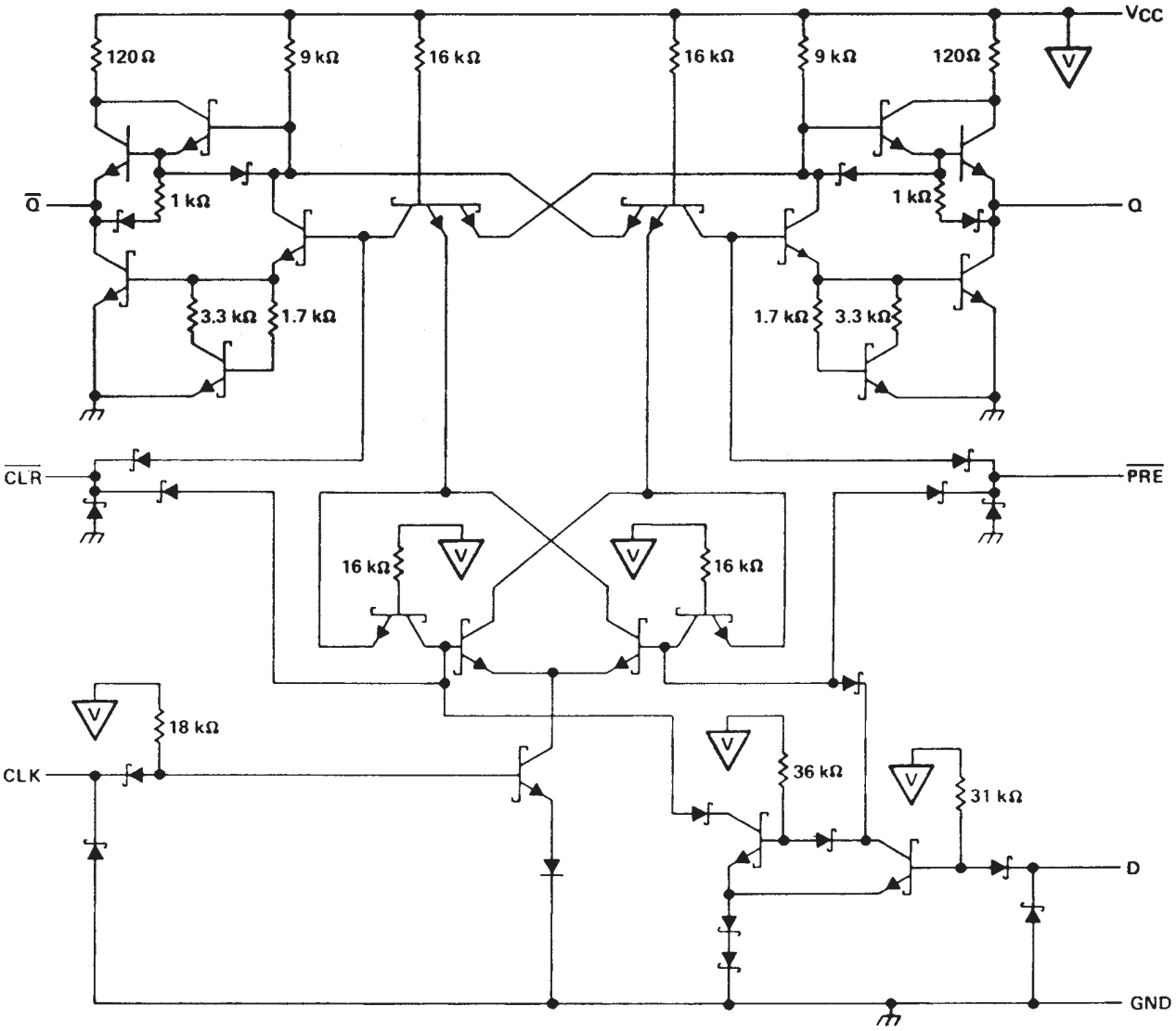
I_{IL} MAX	R_{eq} NOM
–2 mA	2.8 kΩ
–4 mA	1.4 kΩ
–6 mA	940 Ω

TYPICAL OF ALL OUTPUTS



schematic

'LS74A



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: '74, 'S74 . . . . . 5.5 V
'LS74A . . . . . 7 V
Operating free-air temperature range: SN54' . . . . . −55°C to 125°C
SN74' . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5474			SN7474			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.8			0.8	V
I_{OH}	High-level output current				−0.4			−0.4	mA
I_{OL}	Low-level output current				16			16	mA
t_w	Pulse duration	CLK high	30			30			ns
		CLK low	37			37			
		$\overline{PRE}$ or $\overline{CLR}$ low	30			30			
t_{su}	Input setup time before CLK↑		20			20			ns
t_h	Input hold time-data after CLK↑		5			5			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN5474			SN7474			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −0.4 mA	2.4	3.4		2.4	3.4		V
V_{OL}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I		V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	D	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
	$\overline{CLR}$				120			120	
	All Other				80			80	
I_{IL}	D	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
	$\overline{PRE}$§				−1.6			−1.6	
	$\overline{CLR}$§				−3.2			−3.2	
	CLK				−3.2			−3.2	
I_{OS}¶		V_{CC} = MAX	−20		−57	−18		−57	mA
I_{CC}#		V_{CC} = MAX, See Note 2		8.5	15		8.5	15	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Clear is tested with preset high and preset is tested with clear high.
¶Not more than one output should be shown at a time.
#Average per flip-flop.
NOTE 2: With all outputs open, I_{CC} is measured with the Q and $\overline{Q}$ outputs high in turn. At the time of measurement, the clock input is grounded.

switching charateristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			R_L = 400 Ω, C_L = 15 pF	15	25		MHz
t_{PLH}	$\overline{PRE}$ or $\overline{CLR}$	Q or $\overline{Q}$				25	ns
t_{PHL}						40	ns
t_{PLH}	CLK	Q or $\overline{Q}$			14	25	ns
t_{PHL}					20	40	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

			SN54LS74A			SN74LS74A			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
I_{OH}	High-level output current				−0.4			−0.4	mA
I_{OL}	Low-level output current				4			8	mA
f_{clock}	Clock frequency		0		25	0		25	MHz
t_w	Pulse duration	CLK high	25			25			ns
		$\overline{PRE}$ or $\overline{CLR}$ low	25			25			
t_{su}	Setup time-before CLK↑	High-level data	20			20			ns
		Low-level data	20			20			
t_h	Hold time-data after CLK↑		5			5			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†			SN54LS74A			SN74LS74A			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}		V_{CC} = MIN, I_{OH} = −0.4 mA	V_{IH} = 2 V,	V_{IL} = MAX,	2.5	3.4		2.7	3.4		V
V_{OL}		V_{CC} = MIN, I_{OL} = 4 mA	V_{IL} = MAX,	V_{IH} = 2 V,		0.25	0.4		0.25	0.4	V
		V_{CC} = MIN, I_{OL} = 8 mA	V_{IL} = MAX,	V_{IH} = 2 V,					0.35	0.5	
I_I	D or CLK	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
	$\overline{CLR}$ or $\overline{PRE}$						0.2			0.2	
I_{IH}	D or CLK	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
	$\overline{CLR}$ or $\overline{PRE}$						40			40	
I_{IL}	D or CLK	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
	$\overline{CLR}$ or $\overline{PRE}$						−0.8			−0.8	
I_{OS}§		V_{CC} = MAX,	See Note 4		−20		−100	−20		−100	mA
I_{CC} (Total)		V_{CC} = MAX,	See Note 2			4	8		4	8	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.
NOTE 2: With all outputs open, I_{CC} is measured with the Q and $\overline{Q}$ outputs high in turn. At the time of measurement, the clock input is grounded.
NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V_O = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively, with the minimum and maximum limits reduced to one half of their stated values.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
f_{max}			R_L = 2 kΩ,	C_L = 15 pF	25	33		MHz
t_{PLH}	$\overline{CLR}$, $\overline{PRE}$ or CLK	Q or $\overline{Q}$				13	25	ns
t_{PHL}						25	40	ns

Note 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

			SN54S74			SN74S74			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.8			0.8	V
I_{OH}	High-level output current				−1			−1	mA
I_{OL}	Low-level output current				20			20	mA
t_w	Pulse duration	CLK high	6			6			ns
		CLK low	7.3			7.3			
		$\overline{CLR}$ or $\overline{PRE}$ low	7			7			
t_{su}	Setup time, before CLK ↑	High-level data	3			3			ns
		Low-level data	3			3			
t_h	Input hold time - data after CLK ↑		2			2			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54S74			SN74S74			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN, I_I = −18 mA,			−1.2			−1.2	V
V_{OH}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −1 mA	2.5	3.4		2.7	3.4		V
V_{OL}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 20 mA			0.5			0.5	V
I_I		V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	D	V_{CC} = MAX, V_I = 2.7 V			50			50	μA
	$\overline{CLR}$				150			150	
	$\overline{PRE}$ or CLK				100			100	
I_{IL}	D	V_{CC} = MAX, V_I = 0.5 V			−2			−2	mA
	$\overline{CLR}$¶				−6			−6	
	$\overline{PRE}$¶				−4			−4	
	CLK				−4			−4	
I_{OS}§		V_{CC} = MAX	−40		−100	−40		−100	mA
I_{CC}#		V_{CC} = MAX, See Note 2		15	25		15	25	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.
¶Clear is tested with preset high and preset is tested with clear high.
#Average per flip-flop.
NOTE 2: With all outputs open, I_{CC} is measured with the Q and $\overline{Q}$ outputs high in turn. At the time of measurement, the clock input is grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			R_L = 280 Ω, C_L = 15 pF	75	110		MHz
t_{PLH}	$\overline{PRE}$ or $\overline{CLR}$	Q or $\overline{Q}$			4	6	ns
t_{PHL}	$\overline{PRE}$ or $\overline{CLR}$ (CLK high)	$\overline{Q}$ or Q			9	13.5	ns
	$\overline{PRE}$ or $\overline{CLR}$ (CLK low)				5	8	
t_{PLH}	CLK	Q or $\overline{Q}$			6	9	ns
t_{PHL}					6	9	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
JM38510/00205BCA	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
JM38510/00205BDA	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
JM38510/00205BDA	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
JM38510/07101BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07101BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07101BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/07101BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102BDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102SCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102SCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102SDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30102SDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SN5474J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN5474J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN54LS74AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54LS74AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54S74J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54S74J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN7474DR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN7474DR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN7474N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7474N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7474N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7474N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS74AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADBRE4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADBRE4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
						no Sb/Br)		
SN74LS74ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74LS74AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74LS74AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS74AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS74AN3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS74AN3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS74ANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS74ANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS74ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ANSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS74ANSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S74N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S74N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
SN74S74N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74S74NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S74NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S74NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S74NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ5474J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5474J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ5474W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ5474W	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI
SNJ54LS74AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS74AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS74AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS74AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS74AW	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS74AW	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S74FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S74FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S74J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S74J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S74W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54S74W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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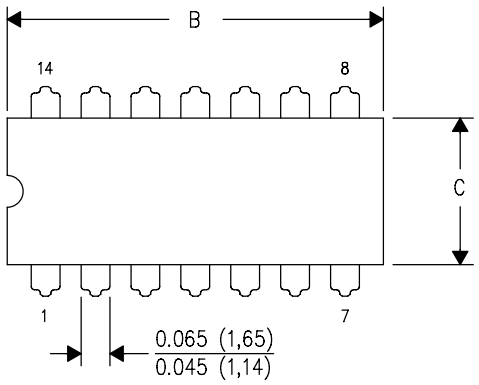
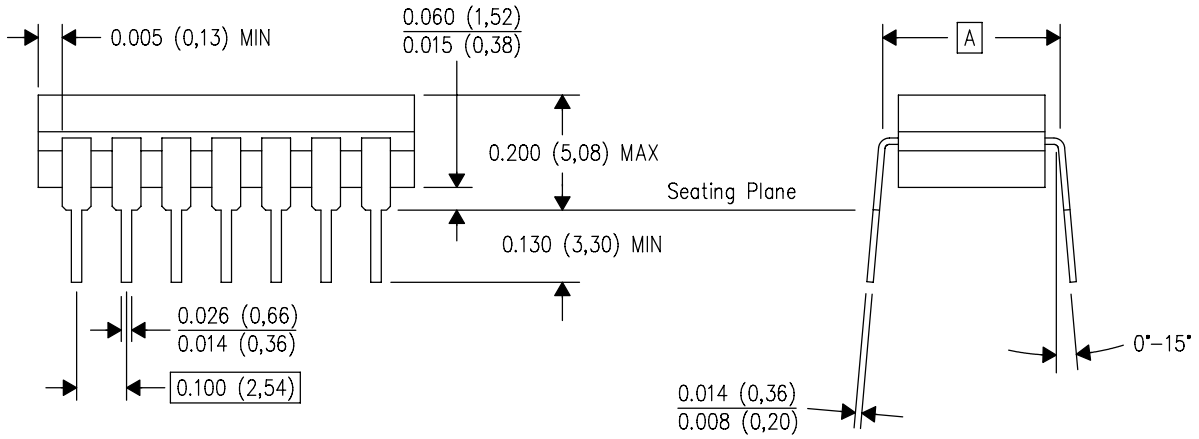
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



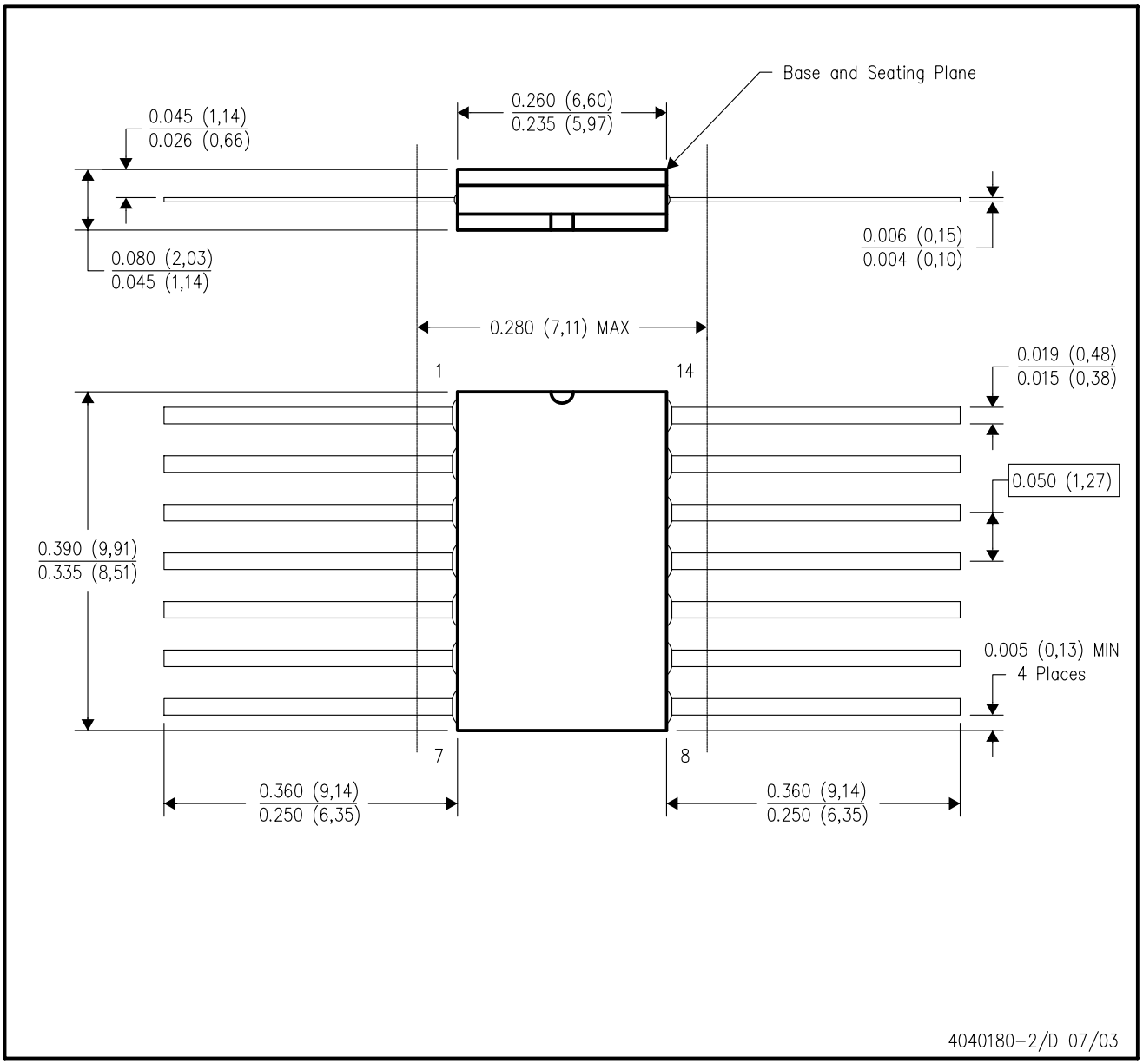
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

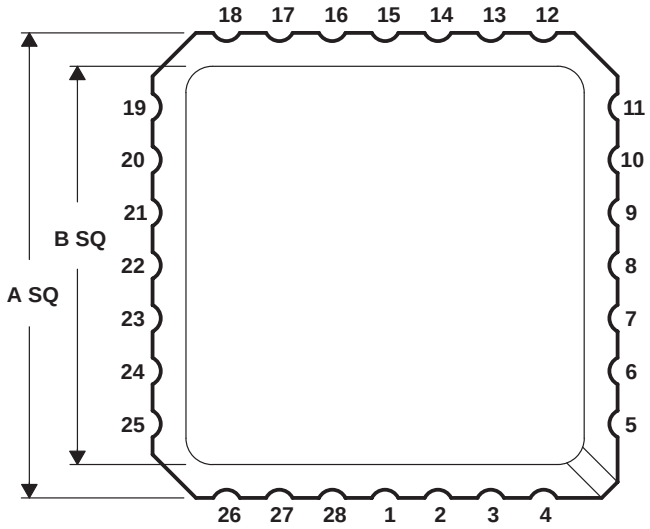
W (R–GDFP–F14) CERAMIC DUAL FLATPACK



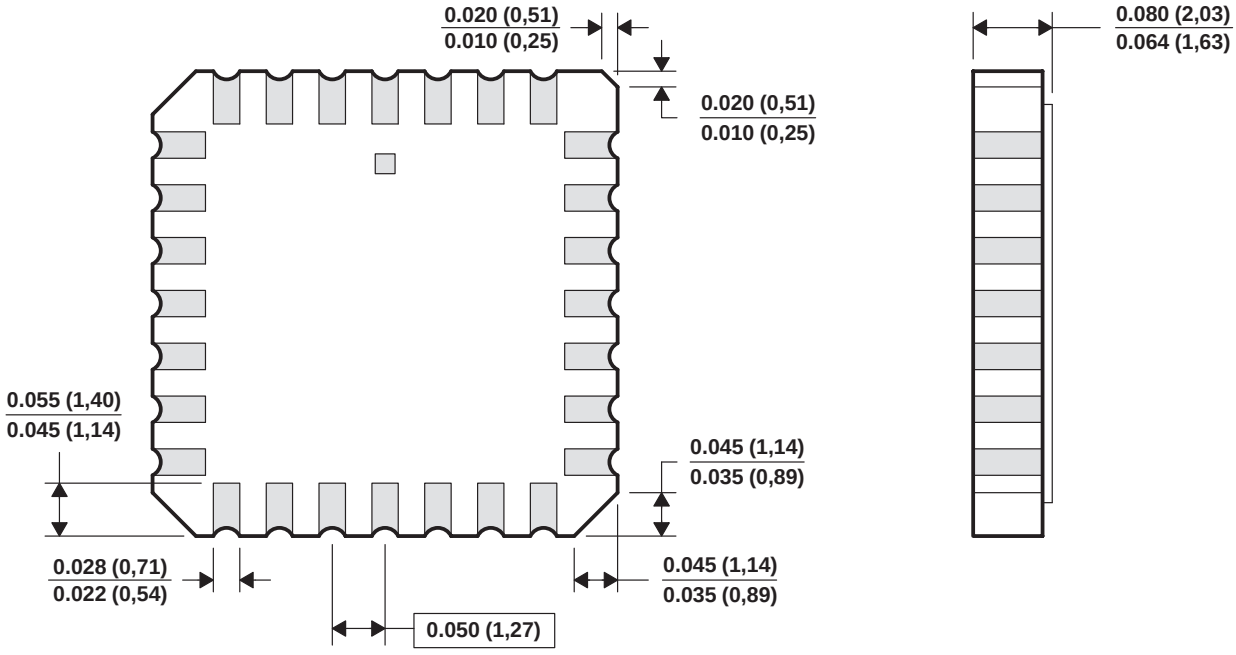
NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F14 and JEDEC MO–092AB

FK (S-CQCC-N)** **LEADLESS CERAMIC CHIP CARRIER**

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.739 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



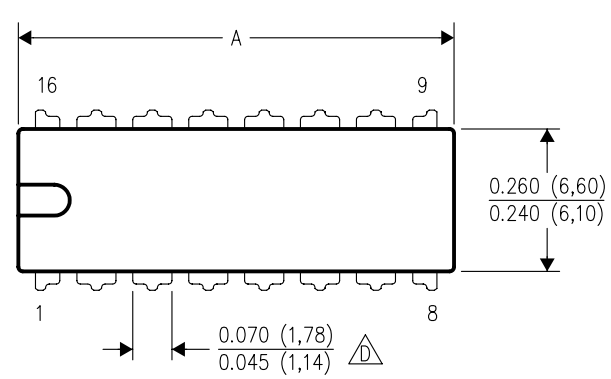
4040140/D 10/96

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

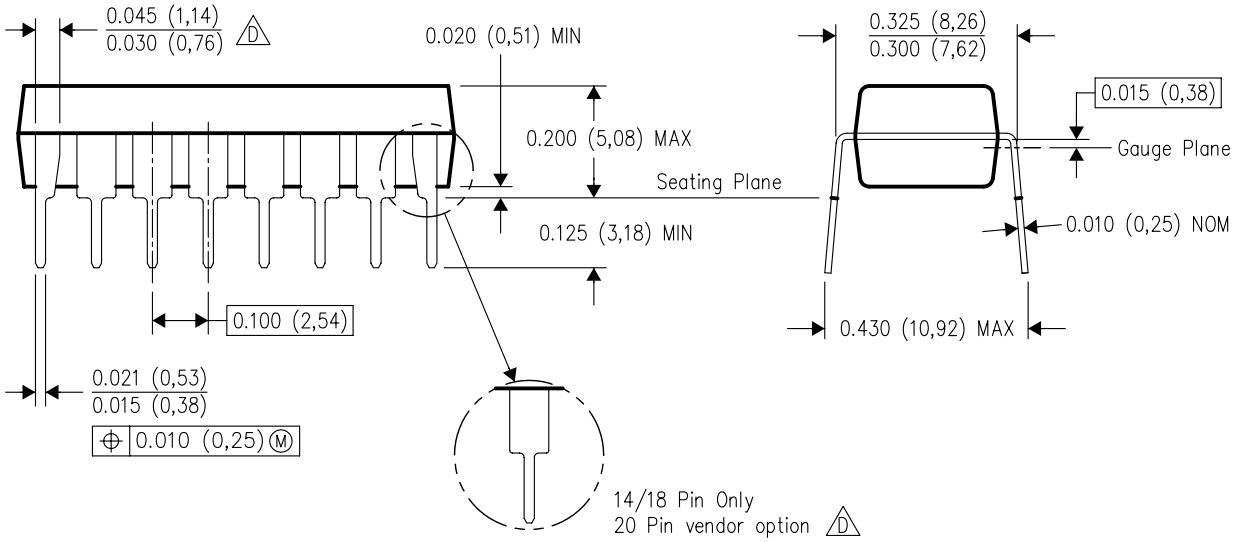
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



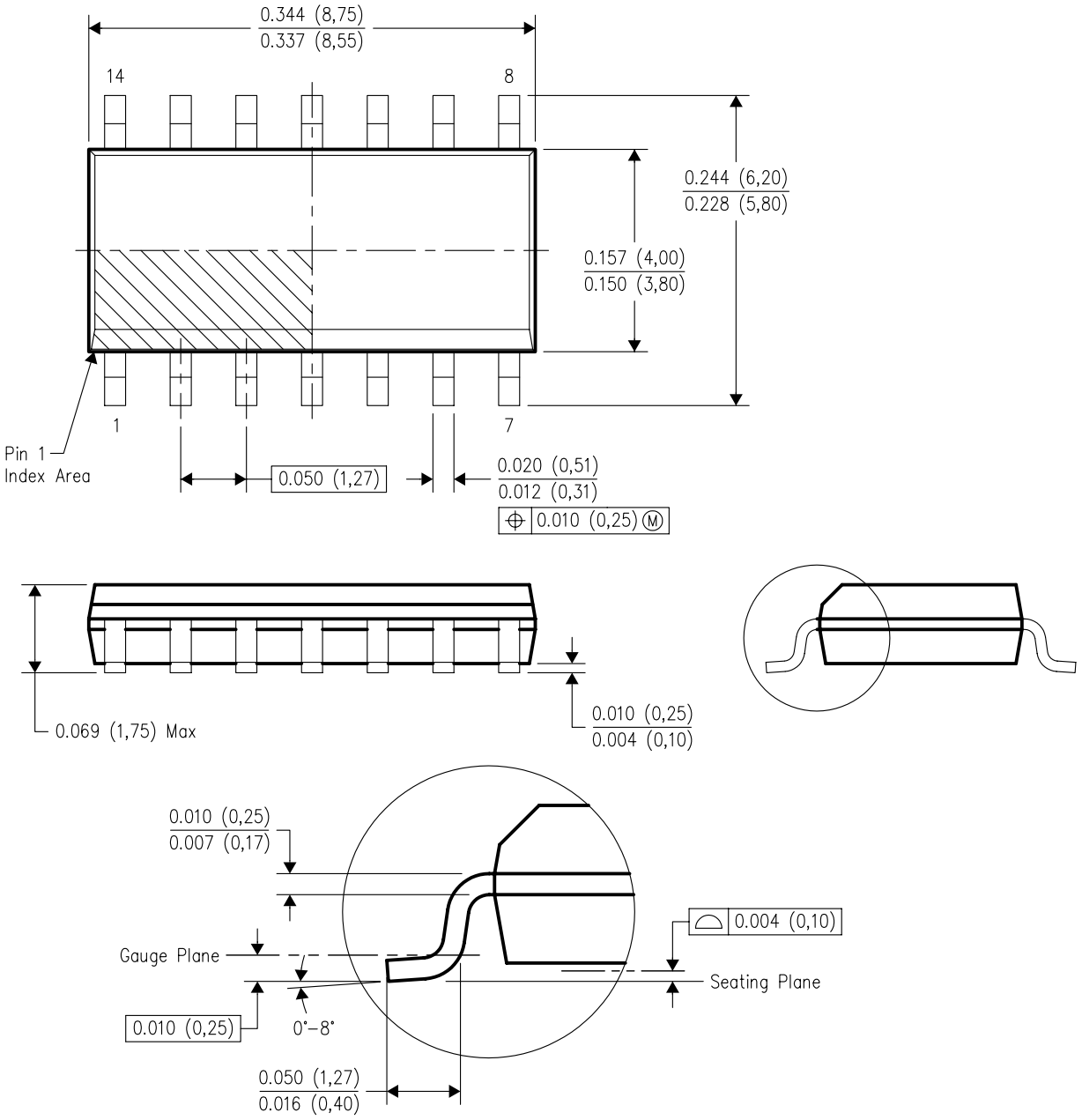
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R–PDSO–G14) PLASTIC SMALL–OUTLINE PACKAGE

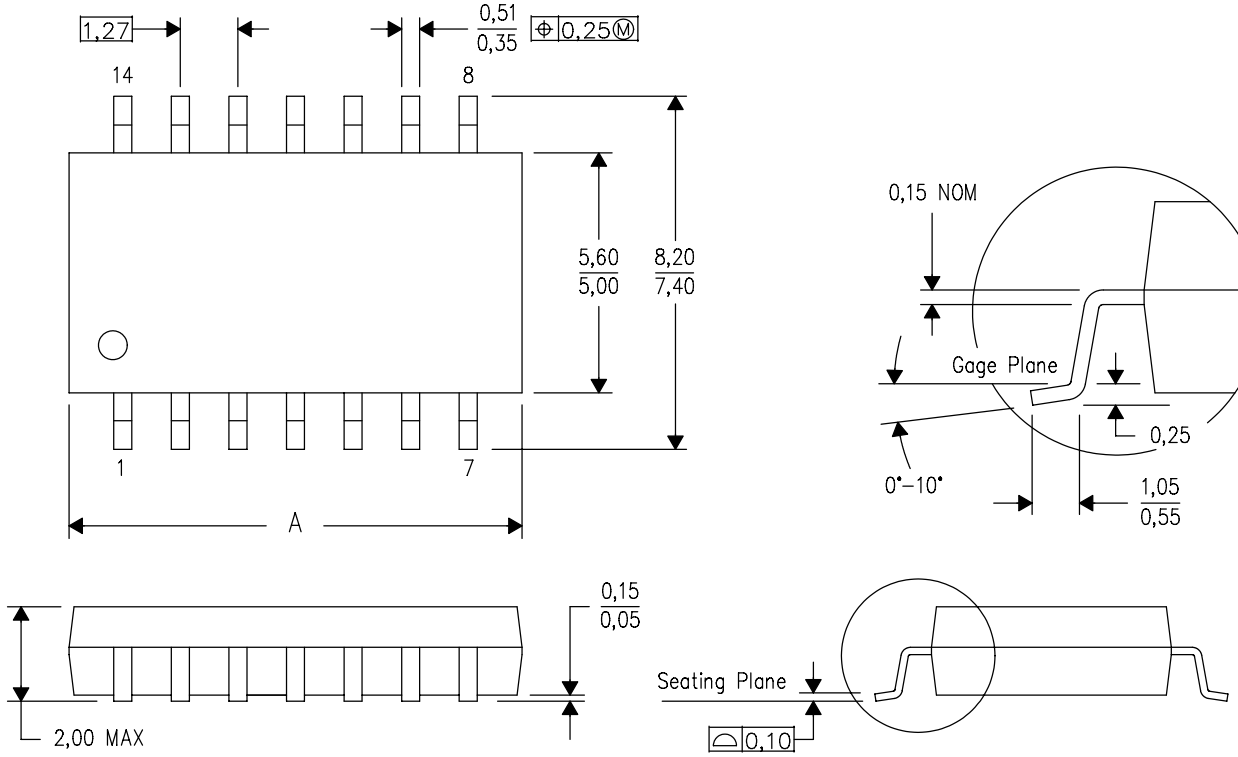


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–012 variation AB.

MECHANICAL DATA

NS (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

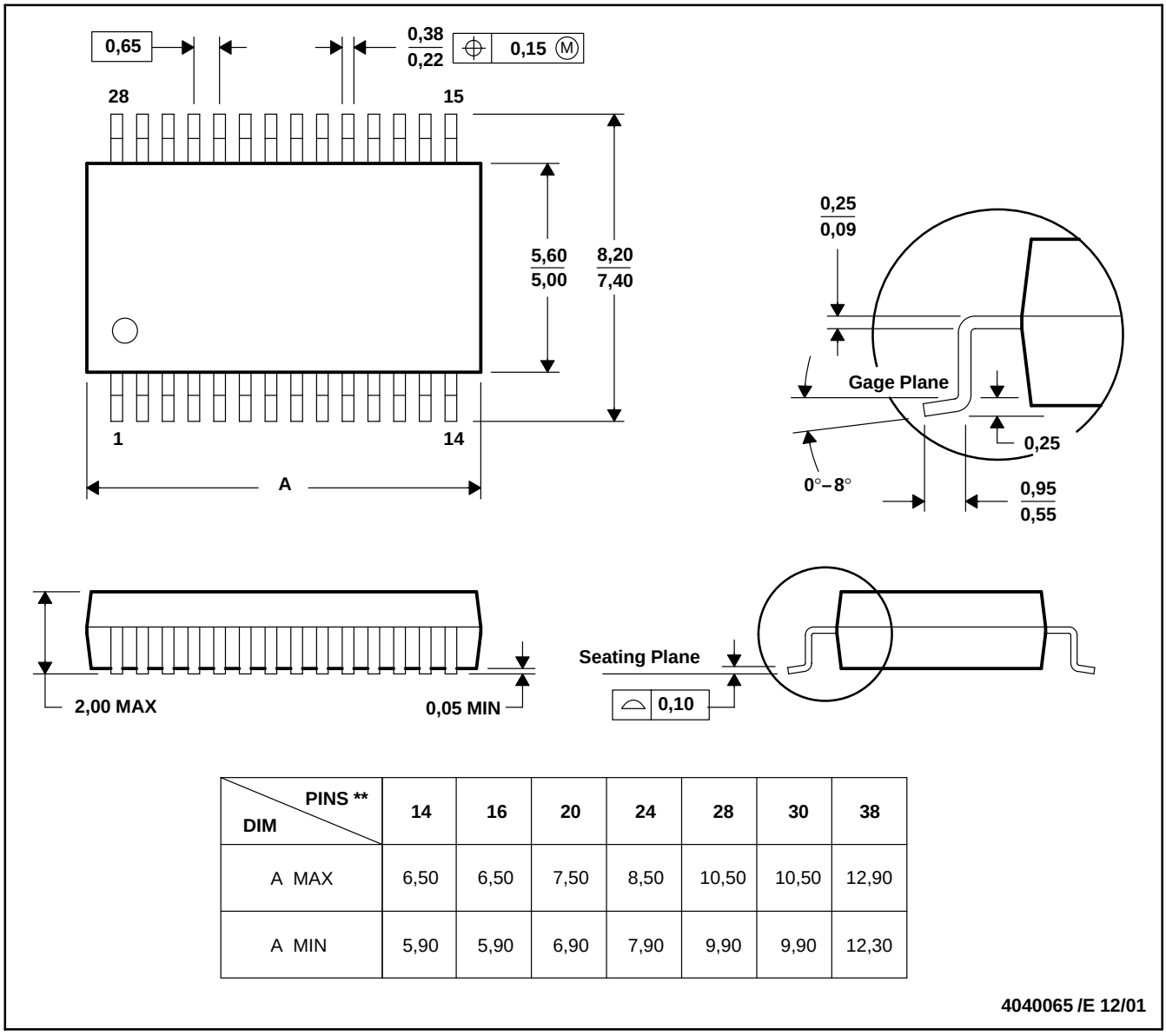
4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

MSSO002E – JANUARY 1995 – REVISED DECEMBER 2001

DB (R-PDSO-G)** **PLASTIC SMALL-OUTLINE**

28 PINS SHOWN



DIM \ PINS **	14	16	20	24	28	30	38
A MAX	6,50	6,50	7,50	8,50	10,50	10,50	12,90
A MIN	5,90	5,90	6,90	7,90	9,90	9,90	12,30

4040065 /E 12/01

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
D. Falls within JEDEC MO-150

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DUAL J-K FLIP-FLOPS WITH PRESET AND CLEAR

SDLS121 – DECEMBER 1983 – REVISED MARCH 1988

- **Package Options Include Plastic and Ceramic DIPs and Ceramic Flat Packages**
- **Dependable Texas Instruments Quality and Reliability**

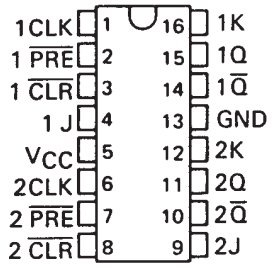
description

The '76 contains two independent J-K flip-flops with individual J-K, clock, preset, and clear inputs. The '76 is a positive-edge-triggered flip-flop. J-K input is loaded into the master while the clock is high and transferred to the slave on the high-to-low transition. For these devices the J and K inputs must be stable while the clock is high.

The 'LS76A contain two independent negative-edge-triggered flip-flops. The J and K inputs must be stable one setup time prior to the high-to-low clock transition for predicatble operation. The preset and clear are asynchronous active low inputs. When low they override the clock and data inputs forcing the outputs to the steady state levels as shown in the function table.

The SN5476 and the SN54LS76A are characterized for operation over the full military temperature range of −55°C to 125°C. The SN7476 and the SN74LS76A are characterized for operation from 0°C to 70°C.

SN5476, SN54LS76A . . . J PACKAGE
SN7476 . . . N PACKAGE
SN74LS76A . . . D OR N PACKAGE
(TOP VIEW)



'76
FUNCTION TABLE

INPUTS					OUTPUTS	
PRE	CLR	CLK	J	K	Q	Q̄
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H†	H†
H	H	⎍	L	L	Q_0	$\overline{Q}_0$
H	H	⎍	H	L	H	L
H	H	⎍	L	H	L	H
H	H	⎍	H	H	TOGGLE	

'LS76A
FUNCTION TABLE

INPUTS					OUTPUTS	
PRE	CLR	CLK	J	K	Q	Q̄
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H†	H†
H	H	↓	L	L	Q_0	$\overline{Q}_0$
H	H	↓	H	L	H	L
H	H	↓	L	H	L	H
H	H	↓	H	H	TOGGLE	
H	H	H	X	X	Q_0	$\overline{Q}_0$

† This configuration is nonstable; that is, it will not persist when either preset or clear returns to its inactive (high) level.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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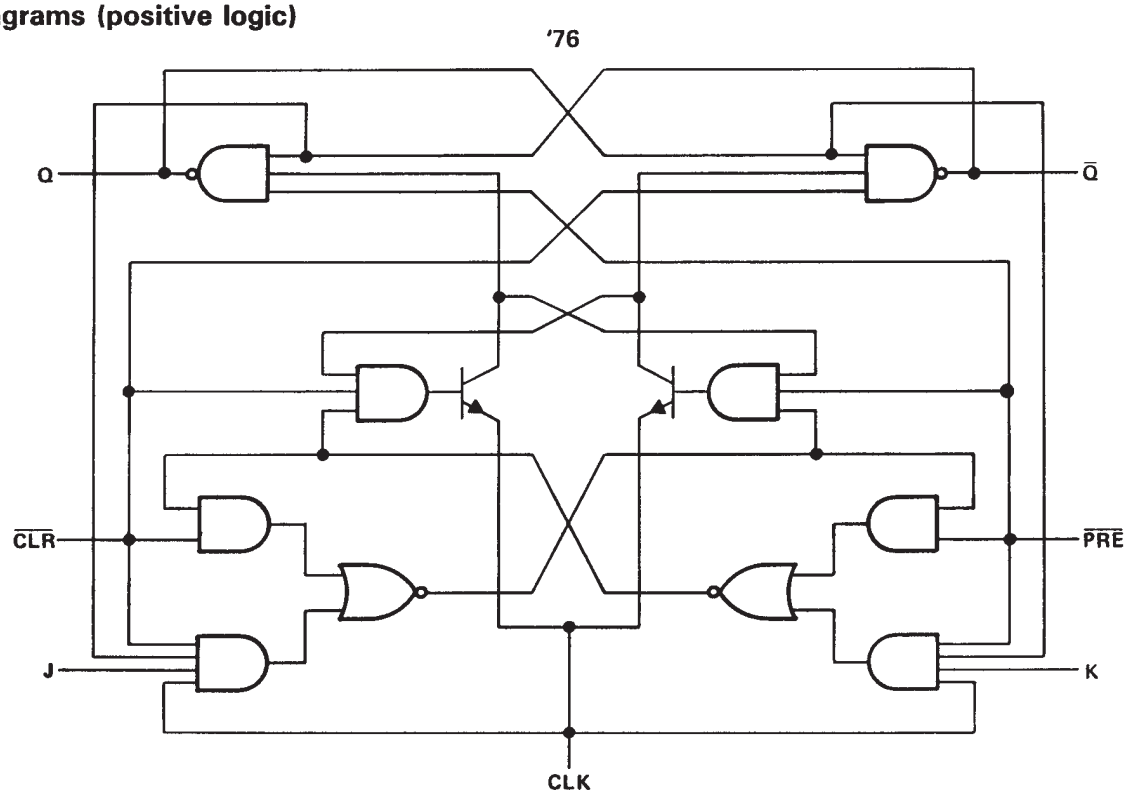
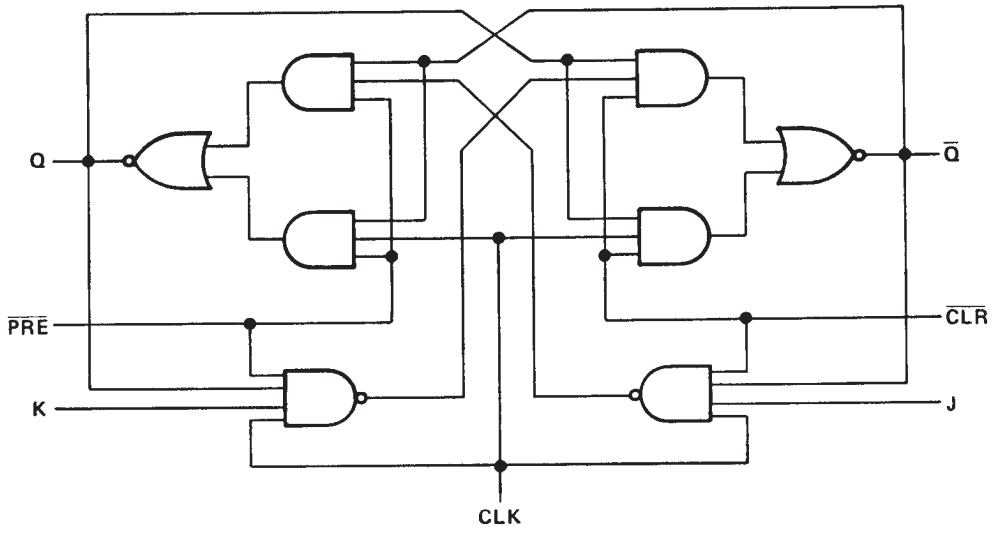
logic diagrams (positive logic)



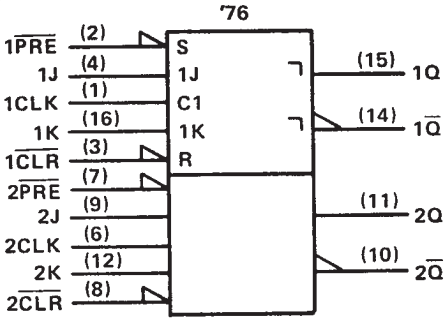
logic diagrams (positive logic) (continued)

'LS76A

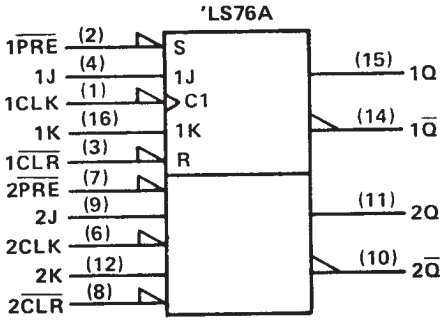


logic symbols†

'76



'LS76A

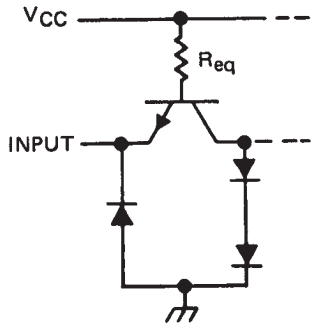


†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematics of inputs and outputs

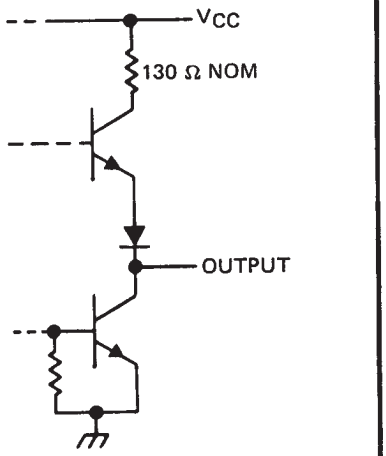
'76

EQUIVALENT OF EACH INPUT



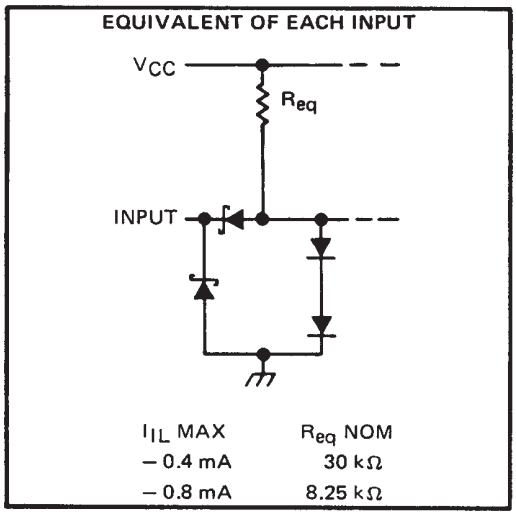
I_{IL} MAX	R_{eq} NOM
– 1.6 mA	4 kΩ
– 3.2 mA	2 kΩ

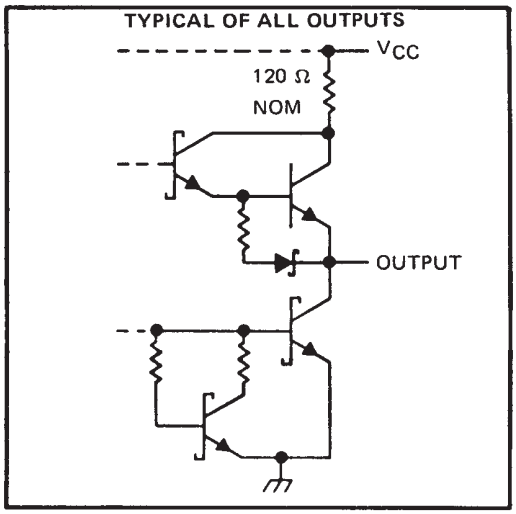
TYPICAL OF ALL OUTPUTS



schematics of inputs and outputs (continued)

'LS76A





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: '76 . . . . . 5.5 V
'LS76A . . . . . 7 V
Operating free-air temperature range: SN54' . . . . . −55°C to 125°C
SN74' . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN5476			SN7476			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.8			0.8	V
I_{OH}	High-level output current				−0.4			−0.4	mA
I_{OL}	Low-level output current				16			16	mA
t_w	Pulse duration	CLK high	20			20			ns
		CLK low	47			47			
		$\overline{PRE}$ or $\overline{CLR}$ low	25			25			
t_{su}	Input setup time before CLK↑		0			0			ns
t_h	Input hold time-data after CLK↓		0			0			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN5476			SN7476			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −0.4 mA	2.4	3.4		2.4	3.4		V
V_{OL}		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I		V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	J or K	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
	All other				80			80	
I_{IL}	J or K	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
	All other¶				−3.2			−3.2	
I_{OS}§		V_{CC} = MAX	−20		−57	−18		−57	mA
I_{CC}#		V_{CC} = MAX, See Note 2		10	20		10	20	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
¶ Clear is tested with preset high and preset is tested with clear high.
# Average per flip-flop.
NOTE 2: With all outputs open, I_{CC} is measured with the Q and $\overline{Q}$ outputs high in turn. At the time of measurement, the clock input is grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f_{max}			R_L = 400 Ω, C_L = 15 pF	15	20		MHz
t_{PLH}	$\overline{PRE}$ or $\overline{CLR}$	Q or $\overline{Q}$			16	25	ns
t_{PHL}					25	40	ns
t_{PLH}	CLK	Q or $\overline{Q}$			16	25	ns
t_{PHL}					25	40	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

recommended operating conditions

			SN54LS76A			SN74LS76A			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.75	V
V_{IH}	High-level input voltage		2			2			V
V_{IL}	Low-level input voltage				0.7			0.8	V
I_{OH}	High-level output current				−0.4			−0.4	mA
I_{OL}	Low-level output current				4			8	mA
f_{clock}	Clock frequency		0		30	0		30	MHz
t_w	Pulse duration	CLK high	20			20			ns
		$\overline{PRE}$ or $\overline{CLR}$ low	25			25			
t_{su}	Setup time before CLK↓	data high or low	20			20			ns
		$\overline{CLR}$ inactive	20			20			
		$\overline{PRE}$ inactive	25			25			
t_h	Hold time-data after CLK↓		0			0			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†			SN54LS76A			SN74LS76A			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}		V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}		V_{CC} = MIN, I_{OH} = −0.4 mA	V_{IH} = 2 V,	V_{IL} = MAX,	2.5	3.4		2.7	3.4		V
V_{OL}		V_{CC} = MIN, I_{OL} = 4 mA	V_{IL} = MAX,	V_{IH} = 2 V,		0.25	0.4		0.25	0.4	V
		V_{CC} = MIN, I_{OL} = 8 mA	V_{IL} = MAX,	V_{IH} = 2 V,					0.35	0.5	
I_I	J or K	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
	$\overline{CLR}$ or $\overline{PRE}$						0.3			0.3	
	CLK						0.4			0.4	
I_{IH}	J or K	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
	$\overline{CLR}$ or $\overline{PRE}$						60			60	
	CLK						80			80	
I_{IL}	J or K	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
	All other						−0.8			−0.8	
I_{OS}§		V_{CC} = MAX,	See Note 4		−20		−100	−20		−100	mA
I_{CC} (Total)		V_{CC} = MAX,	See Note 2			4	6		4	6	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.
NOTE 2: With all outputs open, I_{CC} is measured with the Q and $\overline{Q}$ outputs high in turn. At the time of measurement, the clock input is grounded.
NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V_O = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively, with the minimum and maximum limits reduced to one half of their stated values.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
f_{max}			R_L = 2 kΩ,	C_L = 15 pF	30	45		MHz
t_{PLH}	$\overline{PRE}$, $\overline{CLR}$ or CLK	Q or $\overline{Q}$				15	20	ns
t_{PHL}						15	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

PACKAGING INFORMATION

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
5962-9557501QEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
5962-9557501QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
5962-9557501QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
7601301EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
7601301EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/00204BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/00204BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN5476J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN5476J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS76AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS76AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN7476N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN7476N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN7476N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN7476N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS76AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS76AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS76ADR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS76ADR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS76AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS76AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS76AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS76AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SNJ5476J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ5476J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ5476W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ5476W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS76AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS76AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS76AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS76AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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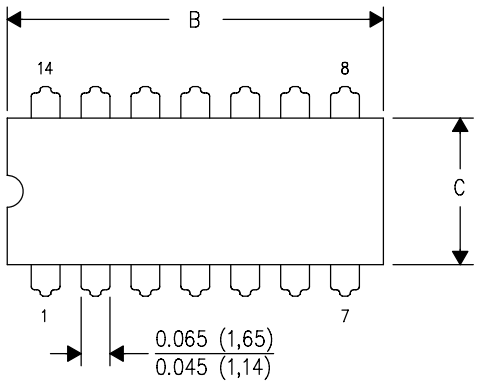
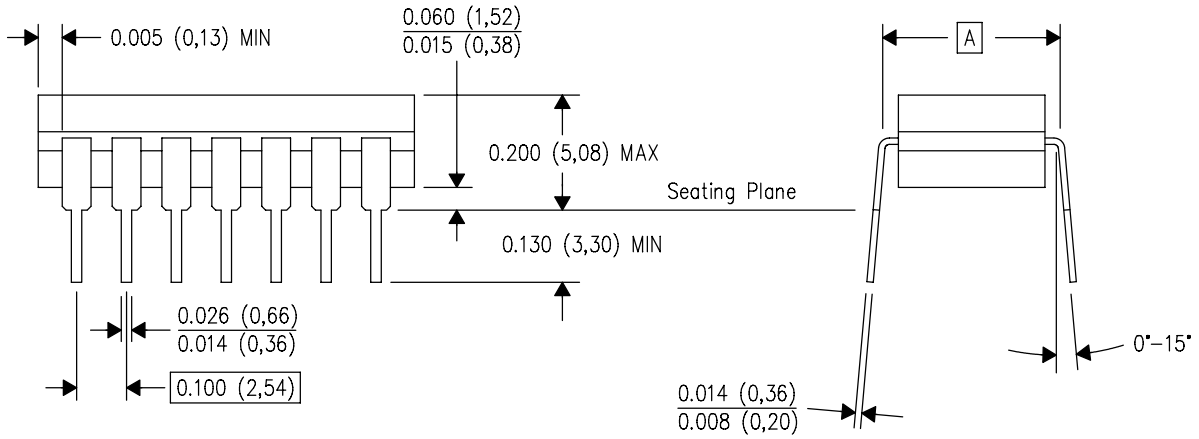
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



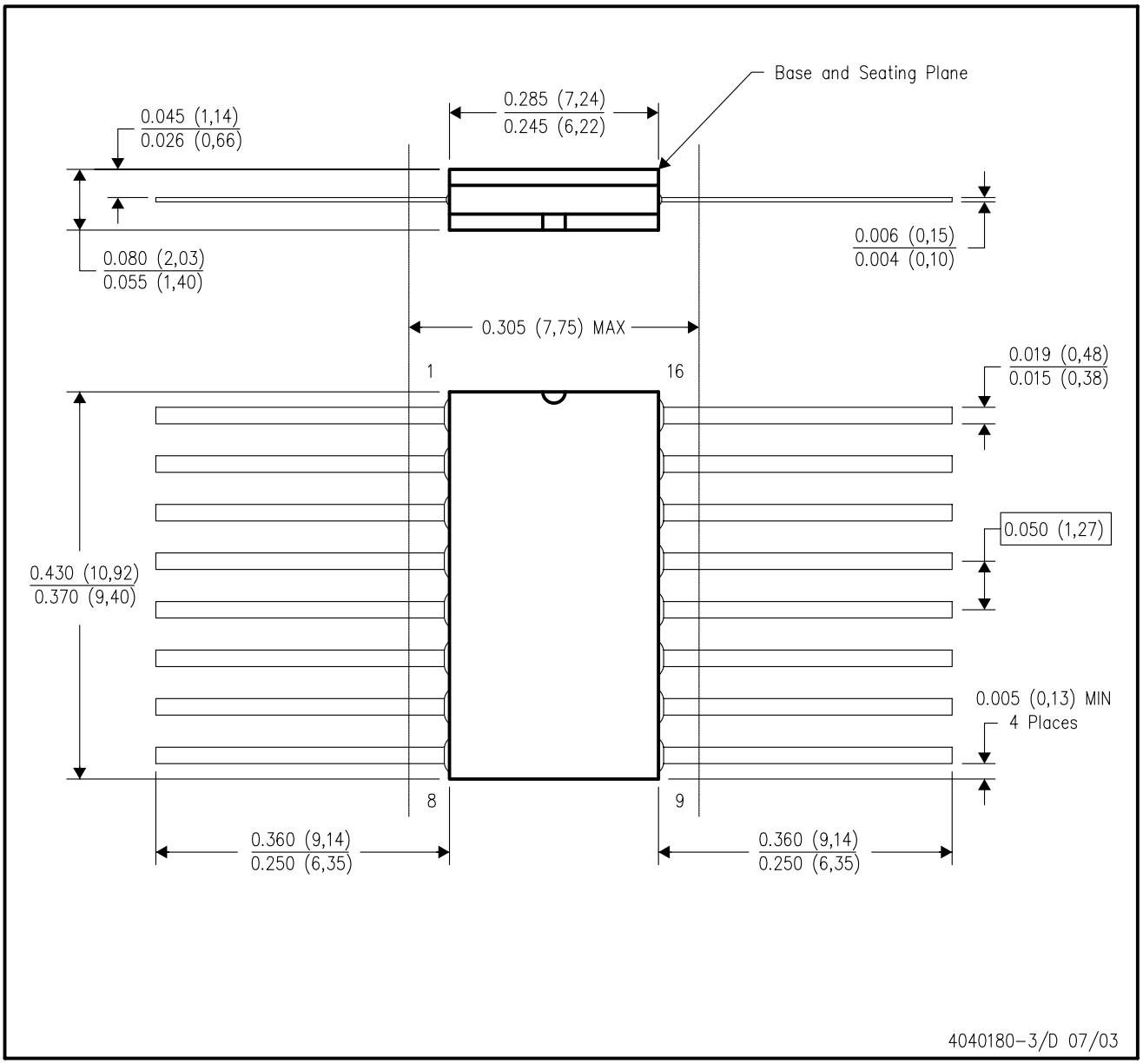
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

W (R–GDFP–F16) CERAMIC DUAL FLATPACK

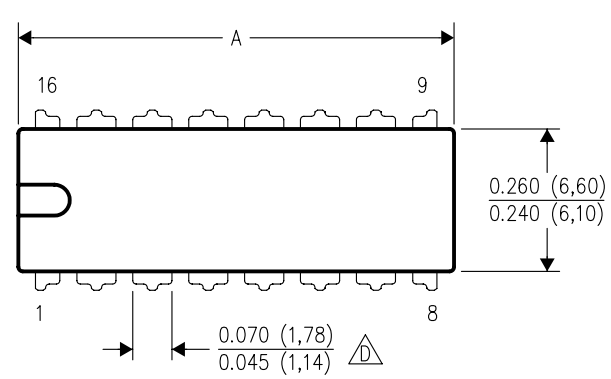


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F16 and JEDEC MO–092AC

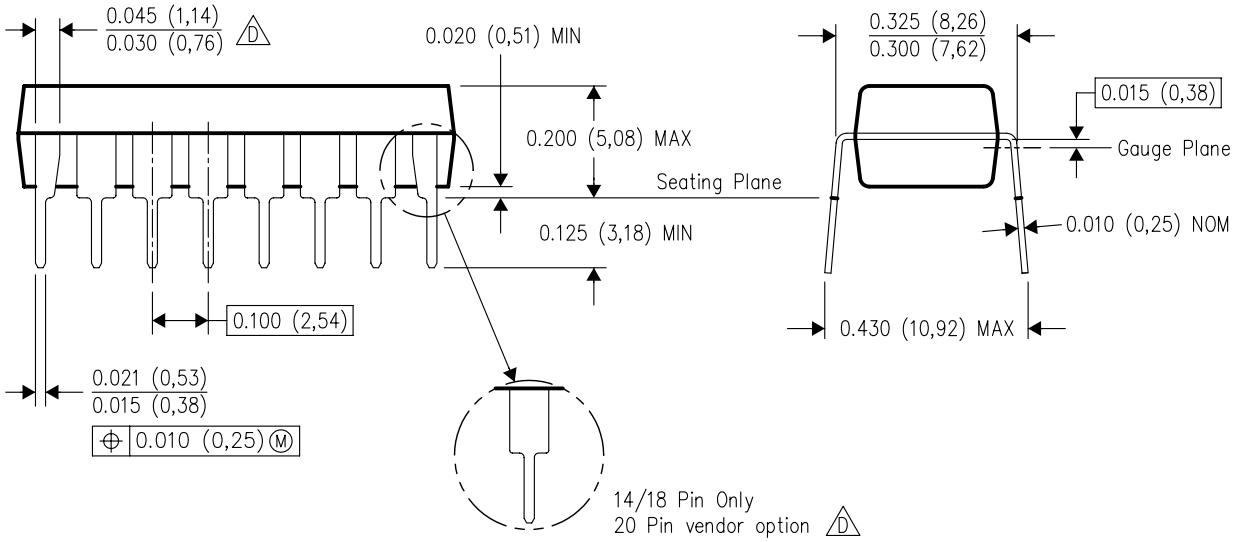
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



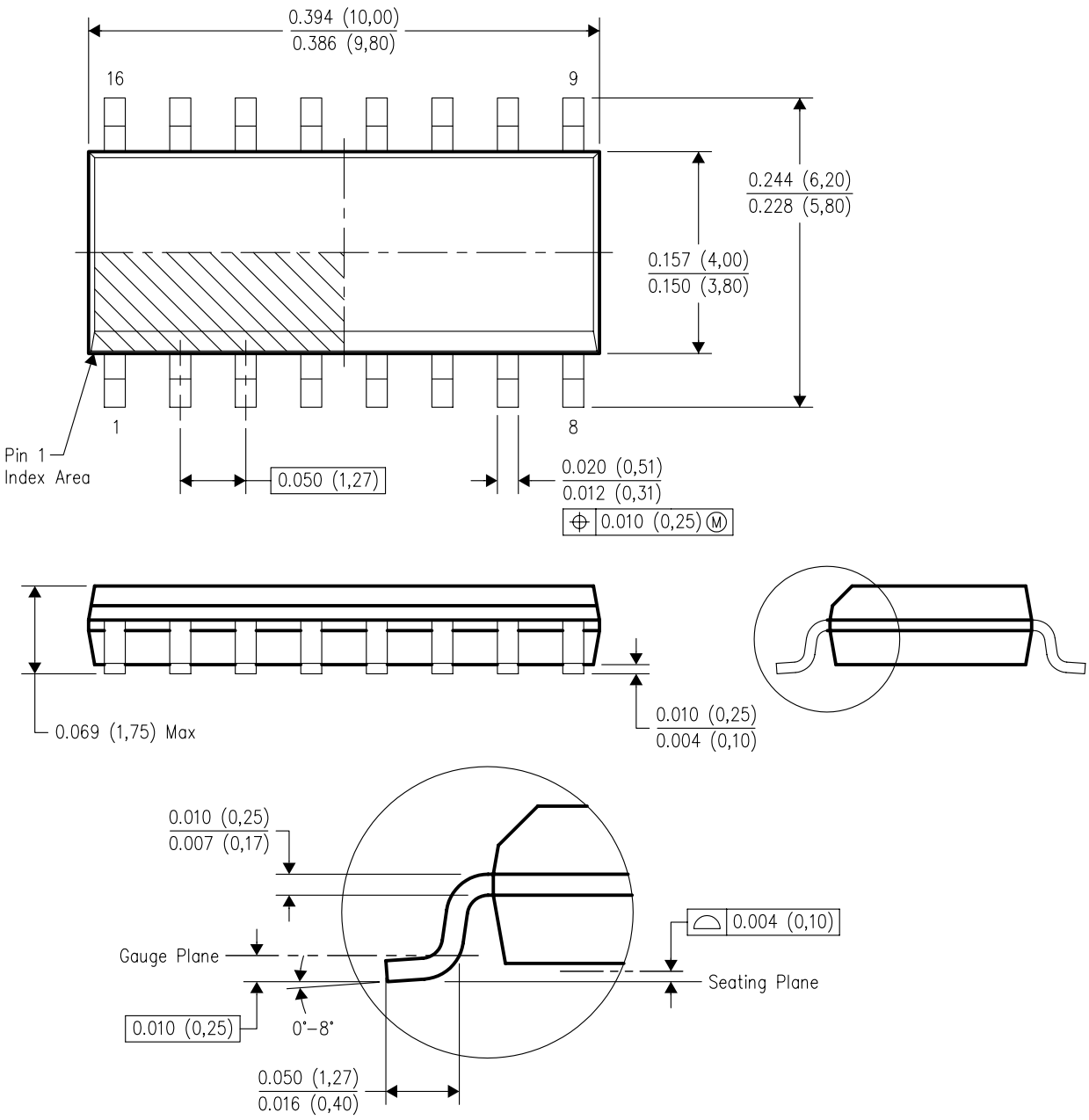
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R–PDSO–G16) PLASTIC SMALL–OUTLINE PACKAGE



NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–012 variation AC.

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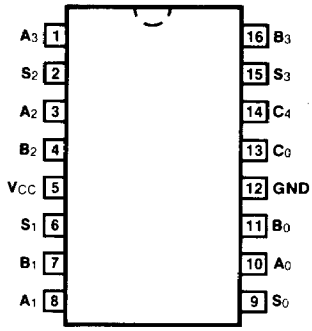
54/7483A
54LS/74LS83A

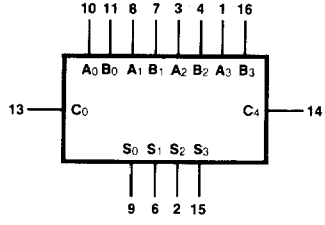
4-BIT BINARY FULL ADDER
(With Fast Carry)

CONNECTION DIAGRAM
PINOUT A



DESCRIPTION — The '83A high speed 4-bit binary full adders with internal carry lookahead accept two 4-bit binary words ($A_0 — A_3$, $B_0 — B_3$) and a Carry input (C_0). They generate the binary Sum outputs ($S_0 — S_3$) and the Carry output (C_4) from the most significant bit. They operate with either HIGH or active LOW operands (positive or negative logic). The '283 is recommended for new designs since it features standard corner power pins.

LOGIC SYMBOL



V_{CC} = Pin 5
GND = Pin 12

ORDERING CODE: See Section 9

PKGS	PIN OUT	COMMERCIAL GRADE	MILITARY GRADE	PKG TYPE
		V_{CC} = +5.0 V ±5%, T_A = 0°C to +70°C	V_{CC} = +5.0 V ±10%, T_A = -55°C to +125°C	
Plastic DIP (P)	A	7483APC, 74LS83APC		9B
Ceramic DIP (D)	A	7483ADC, 74LS83ADC	5483ADM, 54LS83ADM	6B
Flatpak (F)	A	7483AFC, 74LS83AFC	5483AFM, 54LS83AFM	4L

INPUT LOADING/FAN-OUT: See Section 3 for U.L. definitions

PIN NAMES	DESCRIPTION	54/74 (U.L.) HIGH/LOW	54/74LS (U.L.) HIGH/LOW
$A_0 — A_3$	A Operand Inputs	1.0/1.0	1.0/0.5
$B_0 — B_3$	B Operand Inputs	1.0/1.0	1.0/0.5
C_0	Carry Input	1.0/1.0	0.5/0.25
$S_0 — S_3$	Sum Outputs	20/10	10/5.0 (2.5)
C_4	Carry Output	10/5.0	10/5.0 (2.5)

FUNCTIONAL DESCRIPTION — The '83A adds two 4-bit binary words (A and B) plus the incoming carry. The binary sum appears on the sum outputs (S_0 — S_3) and outgoing carry (C_4) outputs.

$$C_0 + (A_0 + B_0) + 2(A_1 + B_1) + 4(A_2 + B_2) + 8(A_3 + B_3) = S_0 + 2S_1 + 4S_2 + 8S_3 + 16C_4$$

Where: (+) = plus

Due to the symmetry of the binary add function the '83A can be used with either all inputs and outputs active HIGH (positive logic) or with all inputs and outputs active LOW (negative logic). Note that with active HIGH inputs, Carry In can not be left open, but must be held LOW when no carry in is intended.

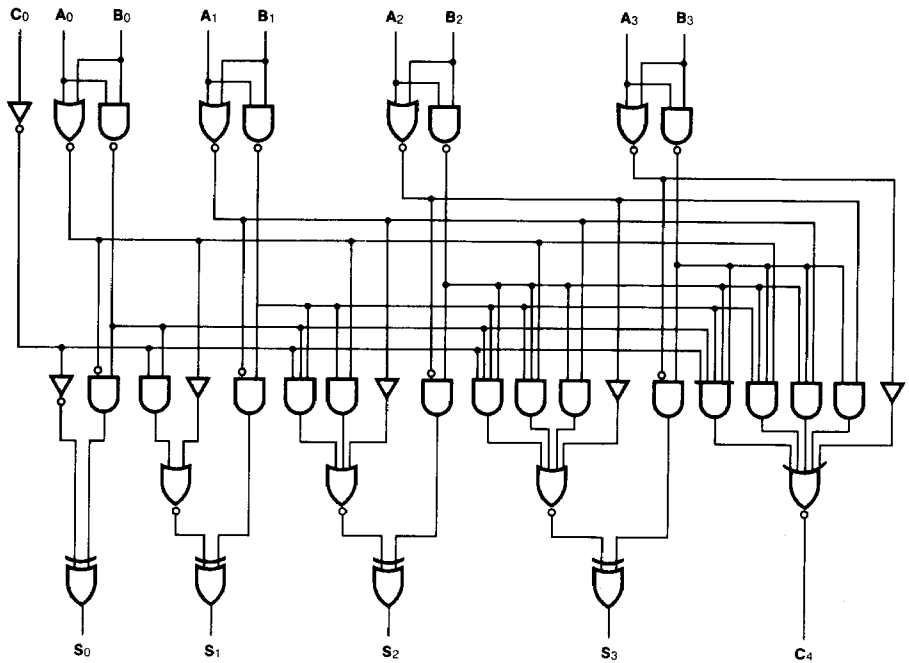
Interchanging inputs of equal weight does not affect the operation, thus C_0, A_0, B_0 can be arbitrarily assigned to pins 10, 11, 13, etc.

TRUTH TABLE

	INPUTS									OUTPUTS					
	C_0	A_0	A_1	A_2	A_3	B_0	B_1	B_2	B_3	S_0	S_1	S_2	S_3	C_4	
Logic Levels	L	L	H	L	H	H	L	L	H	H	H	L	L	H	
Active HIGH	0	0	1	0	1	1	0	0	1	1	1	0	0	1	(10 + 9 = 19)
Active LOW	1	1	0	1	0	0	1	1	0	0	0	1	1	0	(carry + 5 + 6 = 12)

H = HIGH Voltage Level
L = LOW Voltage Level

LOGIC DIAGRAM



DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

SYMBOL	PARAMETER		54/74 Min	54/74 Max	54/74LS Min	54/74LS Max	UNITS	CONDITIONS
I_{OS}	Output Short Circuit Current at S_n	XM	-20	-55	-20	-100	mA	V_{CC} = Max
		XC	-18	-55	-20	-100		
I_{OS}	Output Short Circuit Current at C_4	XM	-20	-70	-20	-100	mA	V_{CC} = Max
		XC	-18	-70	-20	-100		
I_{CC}	Power Supply Current	XM		99		39	mA	V_{CC} = Max, Inputs = Gnd ('LS83A)
		XC		110		39		Inputs = 4.5 V ('83A)

AC CHARACTERISTICS: V_{CC} = 5.0 V, T_A = 25° C (See Section 3 for waveforms and load configurations)

SYMBOL	PARAMETER	54/74 C_L = 15 pF, R_L = 400 Ω Min	54/74 Max	54/74LS C_L = 15 pF Min	54/74LS Max	UNITS	CONDITIONS
t_{PLH}	Propagation Delay C_0 to S_n		21		24	ns	Figs. 3-1, 3-20
t_{PHL}			21		24		
t_{PLH}	Propagation Delay A_n or B_n to S_n		24		24	ns	Figs. 3-1, 3-20
t_{PHL}			24		24		
t_{PLH}	Propagation Delay C_0 to C_4		14		17	ns	Figs. 3-1, 3-5 R_L = 780 Ω ('83A)
t_{PHL}			16		17		
t_{PLH}	Propagation Delay A_n or B_n to C_4		14		17	ns	Figs. 3-1, 3-5 R_L = 780 Ω ('83A)
t_{PHL}			16		17		

FAIRCHILD SEMICONDUCTOR™

September 1986
Revised February 2000

DM7486
Quad 2-Input Exclusive-OR Gate

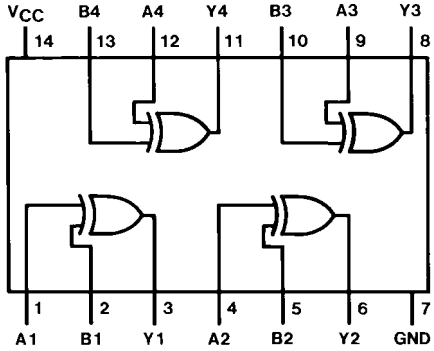
General Description

This device contains four independent gates each of which performs the logic exclusive-OR function.

Ordering Code:

Order Number	Package Number	Package Description
DM7486N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Connection Diagram



Function Table

$Y = A \oplus B$

Inputs		Output
A	B	Y
L	L	L
L	H	H
H	L	H
H	H	L

H = HIGH Logic Level
L = LOW Logic Level

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Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	5.5V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−0.8	mA
I_{OL}	LOW Level Output Current			16	mA
T_A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −12 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max, V_{IL} = Max, V_{IH} = Min	2.4	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max, V_{IH} = Min, V_{IL} = Max		0.2	0.4	V
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 5.5V			1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.4V			40	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−1.6	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	−18		−55	mA
I_{CCH}	Supply Current with Outputs HIGH	V_{CC} = Max (Note 4)		30	50	mA
I_{CCL}	Supply Current with Outputs LOW	V_{CC} = Max (Note 3)(Note 5)		36	57	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 3: Not more than one output should be shorted at a time.

Note 4: I_{CCH} is measured with all outputs open, one input of each gate at 4.5V, and the other inputs grounded.

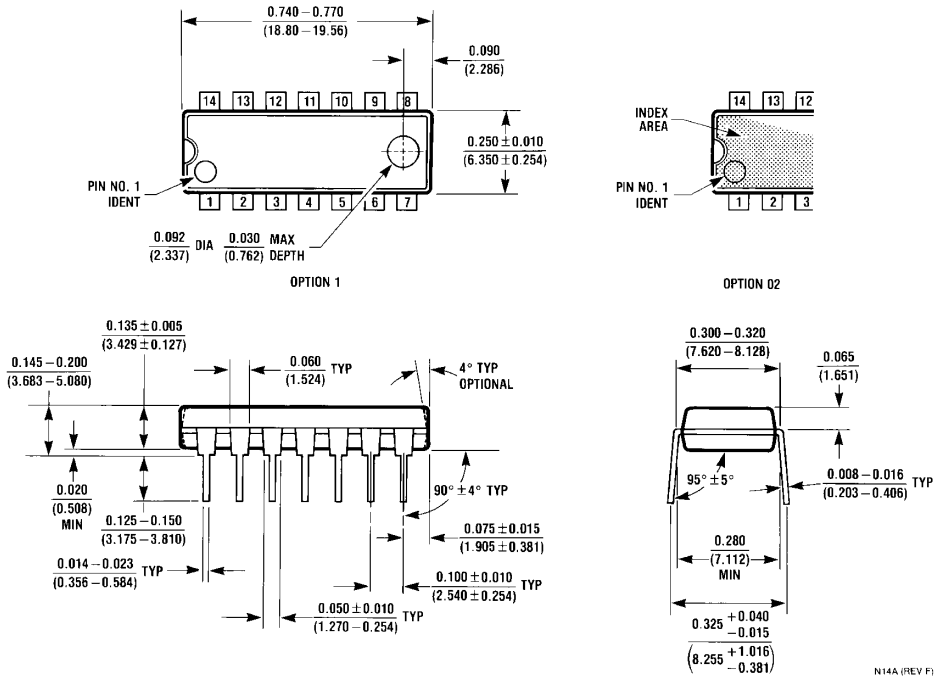
Note 5: I_{CCL} is measured with all outputs open, and all inputs at ground.

Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

Symbol	Parameter	Conditions	C_L = 15 pF, R_L = 400Ω		Units
			Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Other Input LOW		23	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output			17	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Other Input HIGH		30	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output			22	ns

Physical Dimensions inches (millimeters) unless otherwise noted



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N14A

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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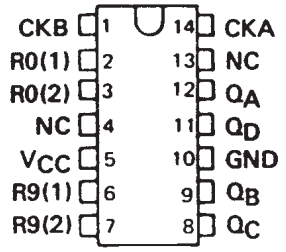
'90A, 'LS90 . . . Decade Counters

'92A, 'LS92 . . . Divide By-Twelve Counters

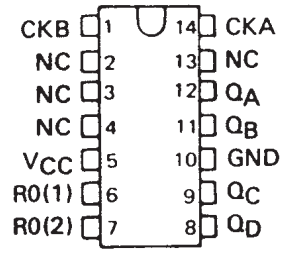
'93A, 'LS93 . . . 4-Bit Binary Counters

TYPES	TYPICAL POWER DISSIPATION
'90A	145 mW
'92A, '93A	130 mW
'LS90, 'LS92, 'LS93	45 mW

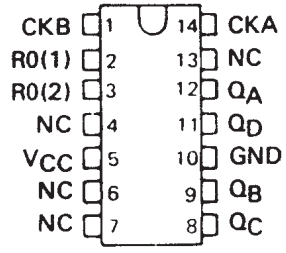
SN5490A, SN54LS90 . . . J OR W PACKAGE
SN7490A . . . N PACKAGE
SN74LS90 . . . D OR N PACKAGE
(TOP VIEW)



SN5492A, SN54LS92 . . . J OR W PACKAGE
SN7492A . . . N PACKAGE
SN74LS92 . . . D OR N PACKAGE
(TOP VIEW)



SN5493A, SN54LS93 . . . J OR W PACKAGE
SN7493 . . . N PACKAGE
SN74LS93 . . . D OR N PACKAGE
(TOP VIEW)



description

Each of these monolithic counters contains four master-slave flip-flops and additional gating to provide a divide-by-two counter and a three-stage binary counter for which the count cycle length is divide-by-five for the '90A and 'LS90, divide-by-six for the '92A and 'LS92, and the divide-by-eight for the '93A and 'LS93.

All of these counters have a gated zero reset and the '90A and 'LS90 also have gated set-to-nine inputs for use in BCD nine's complement applications.

To use their maximum count length (decade, divide-by-twelve, or four-bit binary) of these counters, the CKB input is connected to the Q_A output. The input count pulses are applied to CKA input and the outputs are as described in the appropriate function table. A symmetrical divide-by-ten count can be obtained from the '90A or 'LS90 counters by connecting the Q_D output to the CKA input and applying the input count to the CKB input which gives a divide-by-ten square wave at output Q_A.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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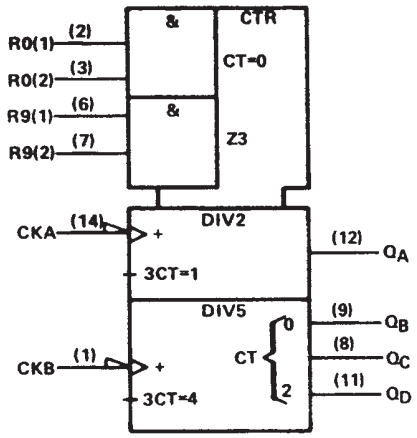
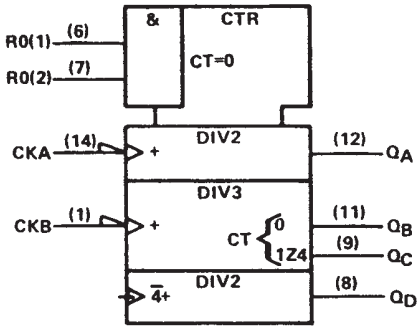
logic symbols†

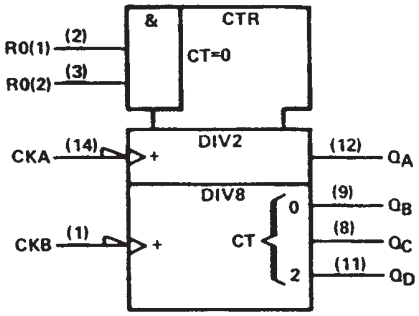
'90



'92



'93A, 'LS93



†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

'90A, 'LS90
BCD COUNT SEQUENCE
(See Note A)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H

'90A, 'LS90
BI-QUINARY (5-2)
(See Note B)

COUNT	OUTPUT			
	Q_A	Q_D	Q_C	Q_B
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	H	L	L	L
6	H	L	L	H
7	H	L	H	L
8	H	L	H	H
9	H	H	L	L

'92A, 'LS92
COUNT SEQUENCE
(See Note C)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	H	L	L	L
7	H	L	L	H
8	H	L	H	L
9	H	L	H	H
10	H	H	L	L
11	H	H	L	H

'90A, 'LS90
RESET/COUNT FUNCTION TABLE

RESET INPUTS				OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	$R_{9(1)}$	$R_{9(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	X	L	L	L	L
H	H	X	L	L	L	L	L
X	X	H	H	H	L	L	H
X	L	X	L	COUNT			
L	X	L	X	COUNT			
L	X	X	L	COUNT			
X	L	L	X	COUNT			

'92A, 'LS92, '93A, 'LS93
RESET/COUNT FUNCTION TABLE

RESET INPUTS		OUTPUT			
$R_{0(1)}$	$R_{0(2)}$	Q_D	Q_C	Q_B	Q_A
H	H	L	L	L	L
L	X	COUNT			
X	L	COUNT			

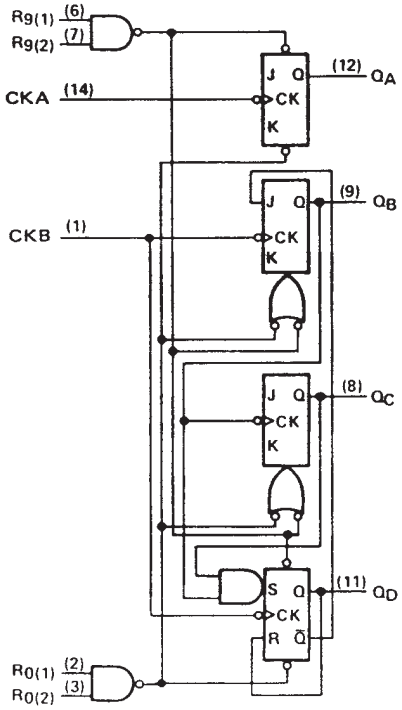
'93A, 'LS93
COUNT SEQUENCE
(See Note C)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

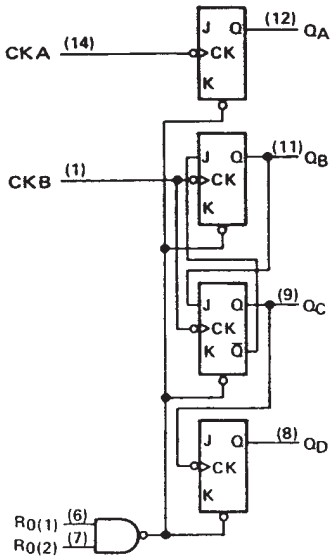
NOTES: A. Output Q_A is connected to input CKB for BCD count.
B. Output Q_D is connected to input CKA for bi-quinary count.
C. Output Q_A is connected to input CKB.
D. H = high level, L = low level, X = irrelevant

logic diagrams (positive logic)

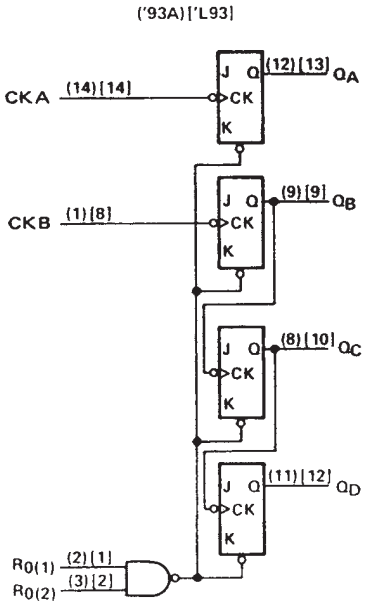
'90A, 'LS90



'92A, 'LS92



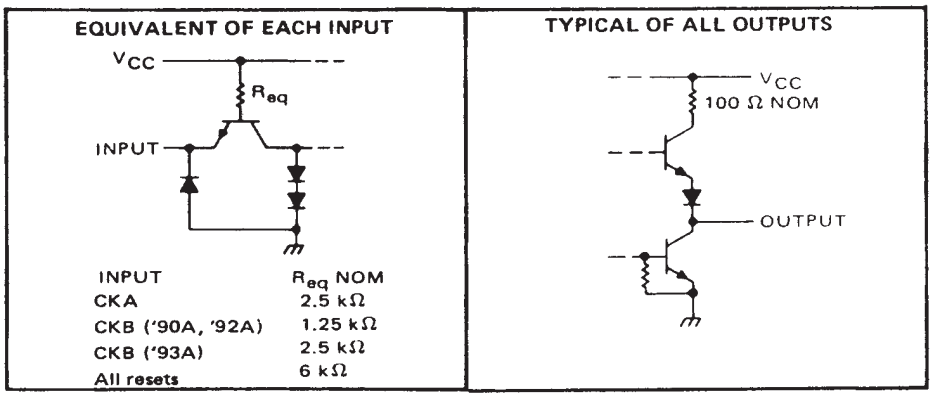
'93A, 'LS93



The J and K inputs shown without connection are for reference only and are functionally at a high level.
Pin numbers shown in ( ) are for the 'LS93 and '93A and pin numbers shown in [ ] are for the 54L93.

schematics of inputs and outputs

'90A, '92A, '93A

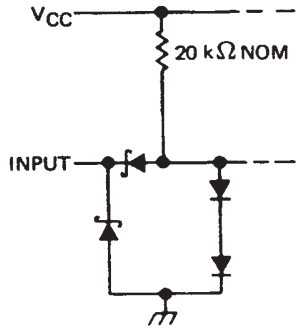


INPUT	R_{eq} NOM
CKA	2.5 kΩ
CKB ('90A, '92A)	1.25 kΩ
CKB ('93A)	2.5 kΩ
All resets	6 kΩ

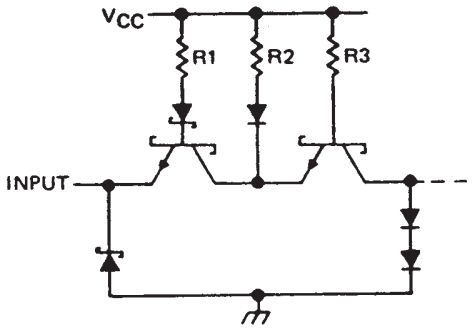
schematics of inputs and outputs (continued)

'LS90, 'LS92, 'LS93

EQUIVALENT OF EACH RESET INPUT

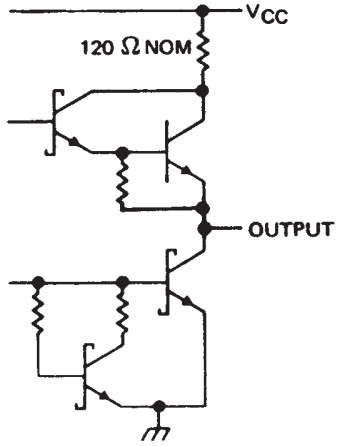


EQUIVALENT OF A AND B INPUTS



INPUT	NOMINAL VALUES R1	R2	R3
CKA	10 kΩ	10 kΩ	10 kΩ
CKB ('LS90, 'LS92)	6.7 kΩ	6.7 kΩ	5 kΩ
CKB ('LS93)	15 kΩ	15 kΩ	10 kΩ

TYPICAL OF ALL OUTPUTS



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Interemitter voltage (see Note 2) . . . . . 5.5 V
Operating free-air temperature range: SN5490A, SN5492A, SN5493A . . . . . −55°C to 125°C
SN7490A, SN7492A, SN7493A . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.
2. This is the voltage between two emitters of a multiple-emitter transistor. For these circuits, this rating applies between the two R_0 inputs, and for the '90A circuit, it also applies between the two R_9 inputs.

recommended operating conditions

		SN5490A, SN5492A SN5493A			SN7490A, SN7492A SN7493A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−800			−800	μA
Low-level output current, I_{OL}				16			16	mA
Count frequency, f_{count} (see Figure 1)	A input	0		32	0		32	MHz
	B input	0		16	0		16	
Pulse width, t_w	A input	15			15			ns
	B input	30			30			
	Reset inputs	15			15			
Reset inactive-state setup time, t_{su}		25			25			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER ¶		TEST CONDITIONS†		'90A MIN	'90A TYP‡	'90A MAX	'92A MIN	'92A TYP‡	'92A MAX	'93A MIN	'93A TYP‡	'93A MAX	UNIT
V_{IH}	High-level input voltage			2			2			2			V
V_{IL}	Low-level input voltage					0.8			0.8			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −12 mA				−1.5			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA		2.4	3.4		2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA¶			0.2	0.4		0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V				1			1			1	mA
I_{IH}	High-level input current	V_{CC} = MAX, V_I = 2.4 V	Any reset			40			40			40	μA
			CKA			80			80			80	
			CKB			120			120			80	
I_{IL}	Low-level input current	V_{CC} = MAX, V_I = 0.4 V	Any reset			−1.6			−1.6			−1.6	mA
			CKA			−3.2			−3.2			−3.2	
			CKB			−4.8			−4.8			−3.2	
I_{OS}	Short-circuit output current§	V_{CC} = MAX	SN54'	−20		−57	−20		−57	−20		−57	mA
			SN74'	−18		−57	−18		−57	−18		−57	
I_{CC}	Supply current	V_{CC} = MAX, See Note 3			29	42		26	39		26	39	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time.
¶Q_A outputs are tested at I_{OL} = 16 mA plus the limit value for I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.
NOTE 3: I_{CC} is measured with all outputs open, both R_0 inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'90A			'92A			'93A			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
f_{max}	CKA	Q_A	C_L = 15 pF, R_L = 400 Ω, See Figure 1	32	42		32	42		32	42		MHz
	CKB	Q_B		16			16			16			
t_{PLH}	CKA	Q_A			10	16		10	16		10	16	ns
t_{PHL}					12	18		12	18		12	18	
t_{PLH}	CKA	Q_D			32	48		32	48		46	70	ns
t_{PHL}					34	50		34	50		46	70	
t_{PLH}	CKB	Q_B			10	16		10	16		10	16	ns
t_{PHL}					14	21		14	21		14	21	
t_{PLH}	CKB	Q_C			21	32		10	16		21	32	ns
t_{PHL}					23	35		14	21		23	35	
t_{PLH}	CKB	Q_D			21	32		21	32		34	51	ns
t_{PHL}					23	35		23	35		34	51	
t_{PHL}	Set-to-0	Any			26	40		26	40		26	40	ns
t_{PLH}	Set-to-9	Q_A, Q_D			20	30							ns
t_{PHL}		Q_B, Q_C			26	40							

† f_{max} = maximum count frequency
t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: R inputs . . . . . 7 V
A and B inputs . . . . . 5.5 V
Operating free-air temperature range: SN54LS' Circuits . . . . . −55°C to 125°C
SN74LS' Circuits . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS90 SN54LS92 SN54LS93			SN74LS90 SN74LS92 SN74LS93			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}				−400			−400	μA
Low-level output current, I_{OL}				4			8	mA
Count frequency, f_{count} (see Figure 1)	A input	0		32	0		32	MHz
	B input	0		16	0		16	
Pulse width, t_w	A input	15			15			ns
	B input	30			30			
	Reset inputs	30			30			
Reset inactive-state setup time, t_{su}		25			25			ns
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†			SN54LS90 SN54LS92			SN74LS90 SN74LS92			UNIT
						MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage					2			2			V
V_{IL}	Low-level input voltage							0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL}max,	V_{IH} = 2 V, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max,	V_{IH} = 2 V,	I_{OL} = 4 mA¶		0.25	0.4		0.25	0.4	V
					I_{OL} = 8 mA¶					0.35	0.5	
I_I	Input current at maximum input voltage	Any reset	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
		CKA	V_{CC} = MAX,	V_I = 5.5 V				0.2			0.2	
		CKB						0.4			0.4	
I_{IH}	High-level input current	Any reset	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
		CKA						40			40	
		CKB						80			80	
I_{IL}	Low-level input current	Any reset	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
		CKA						−2.4			−2.4	
		CKB						−3.2			−3.2	
I_{OS}	Short-circuit output current§		V_{CC} = MAX			−20		−100	−20		−100	mA
I_{CC}	Supply current		V_{CC} = MAX,	See Note 3	'LS90		9	15		9	15	mA
					'LS92		9	15		9	15	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
¶Q_A outputs are tested at specified I_{OL} plus the limit value of I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.

NOTE 3: I_{CC} is measured with all outputs open, both R_O inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†			SN54LS93			SN74LS93			UNIT
						MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage					2			2			V
V_{IL}	Low-level input voltage							0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max,	V_{IH} = 2 V, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = V_{IL} max	V_{IH} = 2 V,	I_{OL} = 4 mA¶		0.25	0.4		0.25	0.4	V
					I_{OL} = 8 mA¶					0.35	0.5	
I_I	Input current at maximum input voltage	Any reset	V_{CC} = MAX,	V_I = 7 V				0.1			0.1	mA
		CKA or CKB	V_{CC} = MAX,	V_I = 5.5 V				0.2			0.2	
I_{IH}	High-level input current	Any reset	V_{CC} = MAX,	V_I = 2.7 V				20			20	μA
		CKA or CKB						40			80	
I_{IL}	Low-level input current	Any reset	V_{CC} = MAX,	V_I = 0.4 V				−0.4			−0.4	mA
		CKA						−2.4			−2.4	
		CKB						−1.6			−1.6	
I_{OS}	Short-circuit output current§		V_{CC} = MAX			−20		−100	−20		−100	mA
I_{CC}	Supply current		V_{CC} = MAX,	See Note 3			9	15		9	15	mA

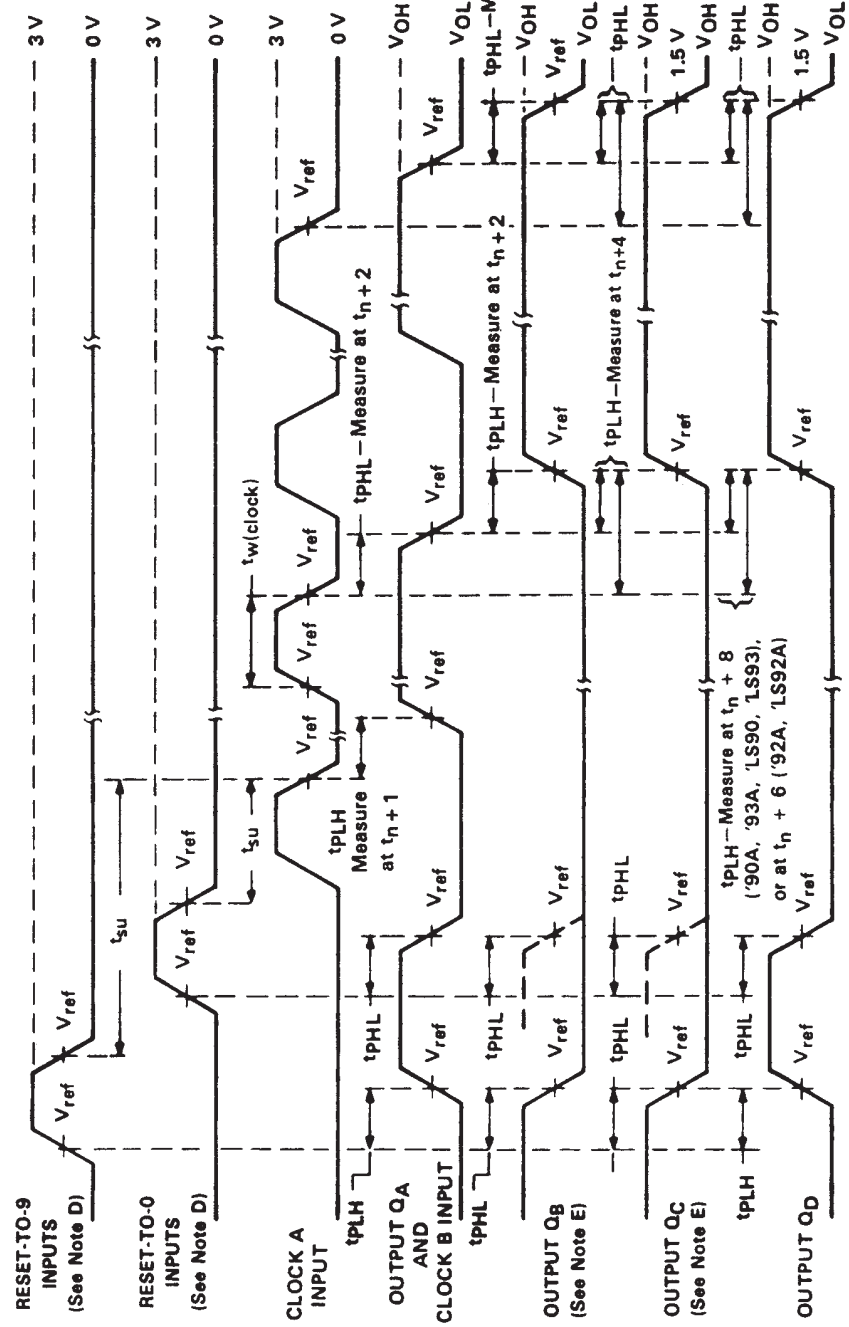
†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.
¶Q_A outputs are tested at specified I_{OL} plus the limit value for I_{IL} for the CKB input. This permits driving the CKB input while maintaining full fan-out capability.
NOTE 3: I_{CC} is measured with all outputs open, both R_0 inputs grounded following momentary connection to 4.5 V, and all other inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER#	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS90			'LS92			'LS93			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
f_{max}	CKA	Q_A	C_L = 15 pF, R_L = 2 kΩ, See Figure 1	32	42		32	42		32	42		MHz
	CKB	Q_B		16			16			16			
t_{PLH}	CKA	Q_A			10	16		10	16		10	16	ns
t_{PHL}					12	18		12	18		12	18	
t_{PLH}	CKA	Q_D			32	48		32	48		46	70	ns
t_{PHL}					34	50		34	50		46	70	
t_{PLH}	CKB	Q_B			10	16		10	16		10	16	ns
t_{PHL}					14	21		14	21		14	21	
t_{PLH}	CKB	Q_C			21	32		10	16		21	32	ns
t_{PHL}					23	35		14	21		23	35	
t_{PLH}	CKB	Q_D			21	32		21	32		34	51	ns
t_{PHL}					23	35		23	35		34	51	
t_{PHL}	Set-to-0	Any			26	40		26	40		26	40	ns
t_{PLH}	Set-to-9	Q_A, Q_D			20	30							ns
t_{PHL}		Q_B, Q_C			26	40							

#f_{max} = maximum count frequency
t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output

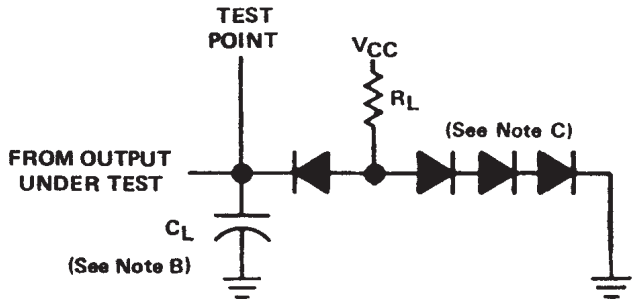
PARAMETER MEASUREMENT INFORMATION



NOTES: A. Input pulses are supplied by a generator having the following characteristics:
for '90A, '92A, '93A, $t_r \le 5$ ns, $t_f \le 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms;
for 'LS90, 'LS92, 'LS93, $t_r \le 15$ ns, $t_f \le 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms.
B. C_L includes probe and jig capacitance.
C. All diodes are 1N3064 or equivalent.
D. Each reset input is tested separately with the other reset at 4.5 V.
E. Reference waveforms are shown with dashed lines.
F. For '90A, '92A, and '93A; V_{ref} = 1.5 V. For 'LS90, 'LS92, and 'LS93; V_{ref} = 1.3 V.

FIGURE 1A

PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

NOTES: A. Input pulses are supplied by a generator having the following characteristics:
for '90A, '92A, '93A, $t_r \leq 5$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms;
for 'LS90, 'LS92, 'LS93, $t_r \leq 15$ ns, $t_f \leq 5$ ns, PRR = 1 MHz, duty cycle = 50%, $Z_{out} \approx 50$ ohms.
B. C_L includes probe and jig capacitance.
C. All diodes are 1N3064 or equivalent.
D. Each reset input is tested separately with the other reset at 4.5 V.
E. Reference waveforms are shown with dashed lines.
F. For '90A, '92A, and '93A; V_{ref} = 1.5 V. For 'LS90, 'LS92, and 'LS93; V_{ref} = 1.3 V.

FIGURE 1B

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
7603201CA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7603201CA SNJ54LS90J	Samples
7700101CA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7700101CA SNJ54LS93J	Samples
7700101DA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7700101DA SNJ54LS93W	Samples
JM38510/31501BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31501BCA	Samples
JM38510/31502BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31502BCA	Samples
JM38510/31502BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31502BDA	Samples
M38510/31501BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31501BCA	Samples
M38510/31502BCA	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31502BCA	Samples
M38510/31502BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/ 31502BDA	Samples
SN5490AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	-55 to 125		
SN5492AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	-55 to 125		
SN54LS90J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS90J	Samples
SN54LS93J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS93J	Samples
SN7490AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70		
SN7492AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70		
SN7493AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70		
SN74LS90-W	ACTIVE	WAFERSALE	YS	0		TBD	Call TI	Call TI			Samples
SN74LS90D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS90	Samples
SN74LS90DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS90	Samples
SN74LS90DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS90	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS90DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS90	Samples
SN74LS90DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS90	Samples
SN74LS90N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS90N	Samples
SN74LS90NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS90N	Samples
SN74LS92D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS92	Samples
SN74LS92DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS92	Samples
SN74LS92N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS92N	Samples
SN74LS92N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70		
SN74LS92NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS92N	Samples
SN74LS92NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS92	Samples
SN74LS93D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS93	Samples
SN74LS93DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS93	Samples
SN74LS93N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS93N	Samples
SN74LS93N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI	0 to 70		
SN74LS93NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS93N	Samples
SNJ5490AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	-55 to 125		
SNJ5490AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI	-55 to 125		
SNJ5492AJ	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI	-55 to 125		
SNJ5492AW	OBSOLETE	CFP	W	14		TBD	Call TI	Call TI	-55 to 125		
SNJ54LS90J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7603201CA SNJ54LS90J	Samples
SNJ54LS93J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7700101CA	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
										SNJ54LS93J	
SNJ54LS93W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	7700101DA SNJ54LS93W	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN5490A, SN5492A, SN54LS90, SN54LS93, SN7490A, SN7492A, SN74LS90, SN74LS93 :

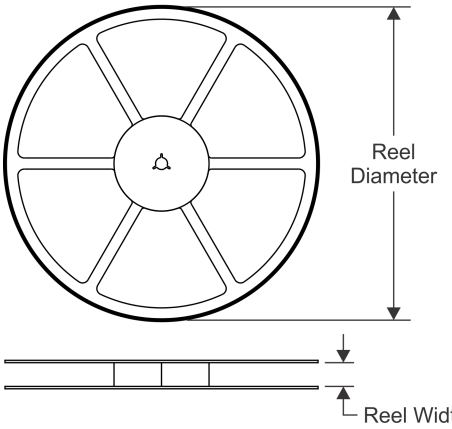
- Catalog: SN7490A, SN7492A, SN74LS90, SN74LS93
- Military: SN5490A, SN5492A, SN54LS90, SN54LS93

NOTE: Qualified Version Definitions:

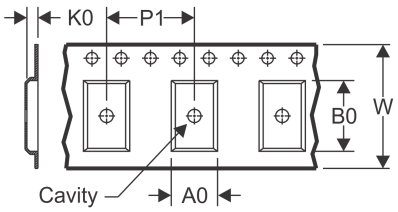
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION

REEL DIMENSIONS

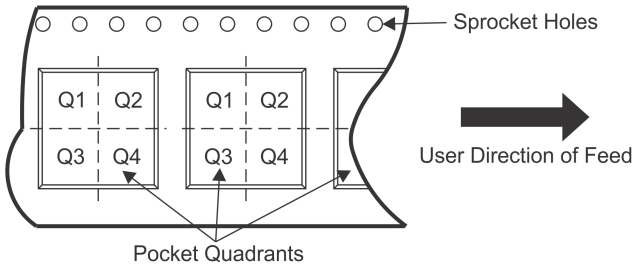


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

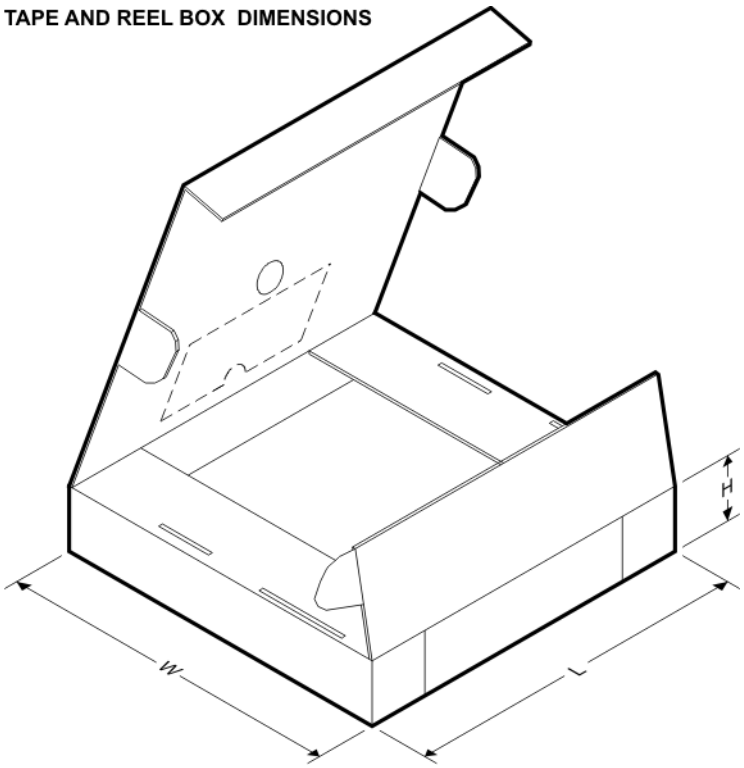
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS90DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS92NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



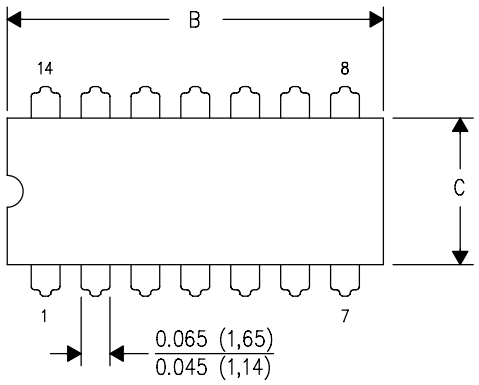
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS90DR	SOIC	D	14	2500	367.0	367.0	38.0
SN74LS92NSR	SO	NS	14	2000	367.0	367.0	38.0

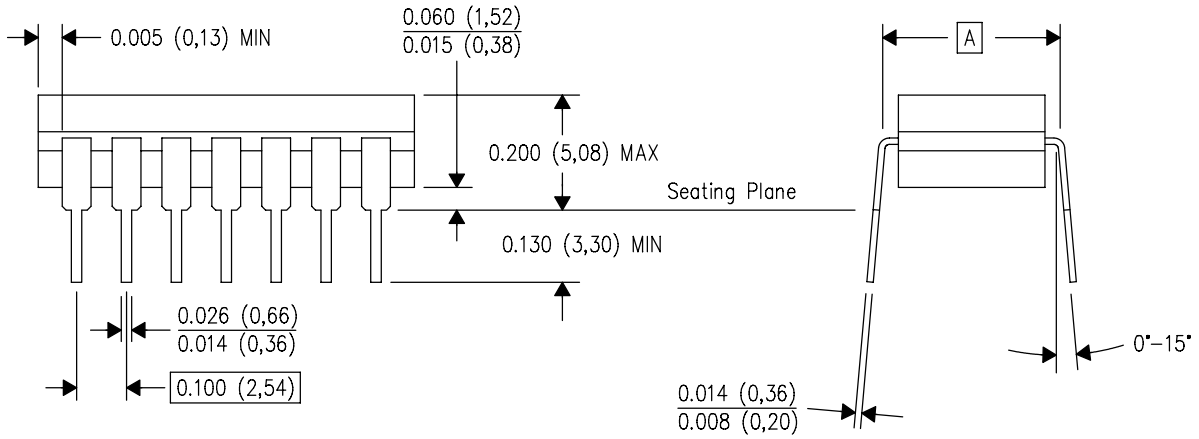
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



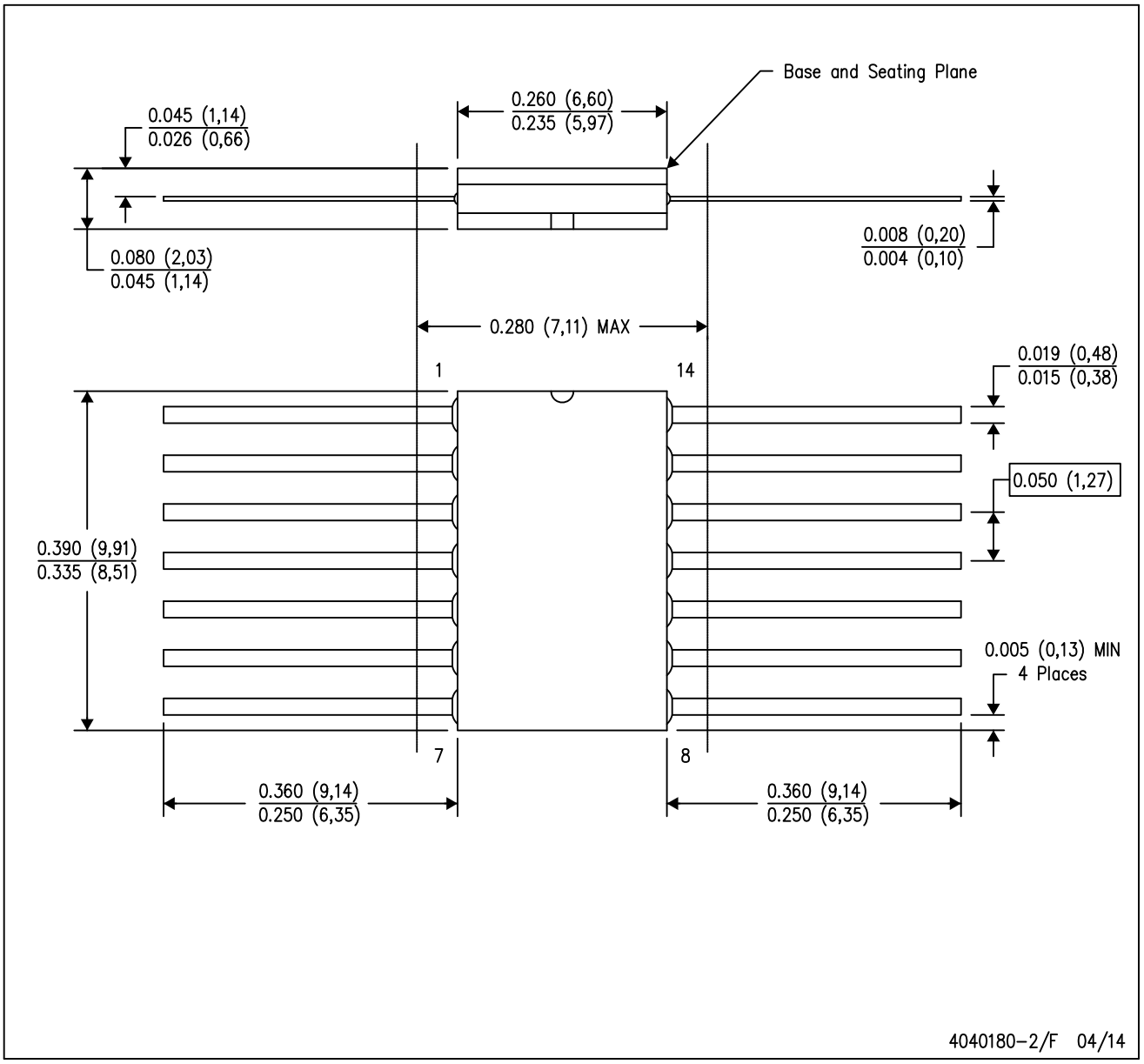
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

W (R–GDFP–F14) CERAMIC DUAL FLATPACK

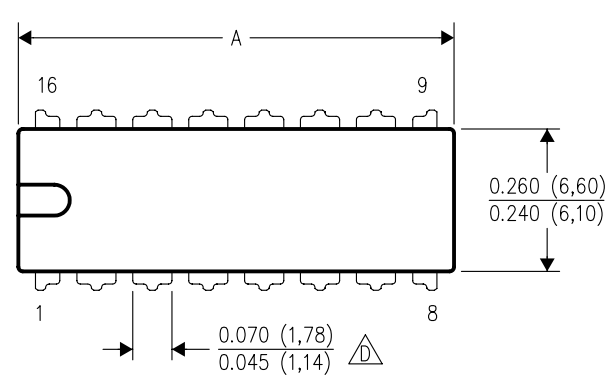


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F14

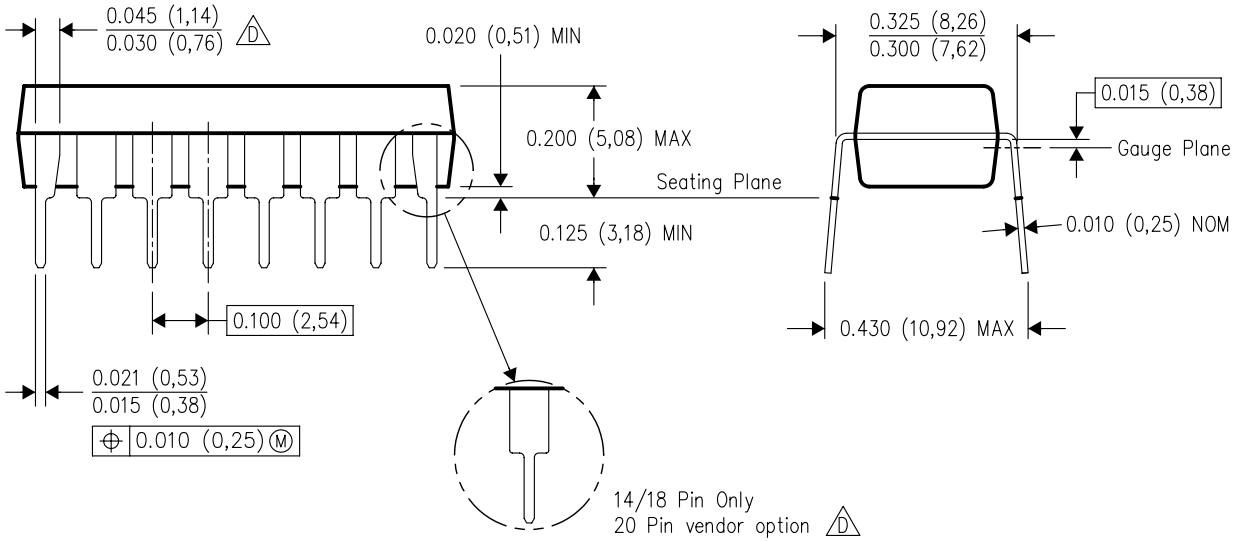
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



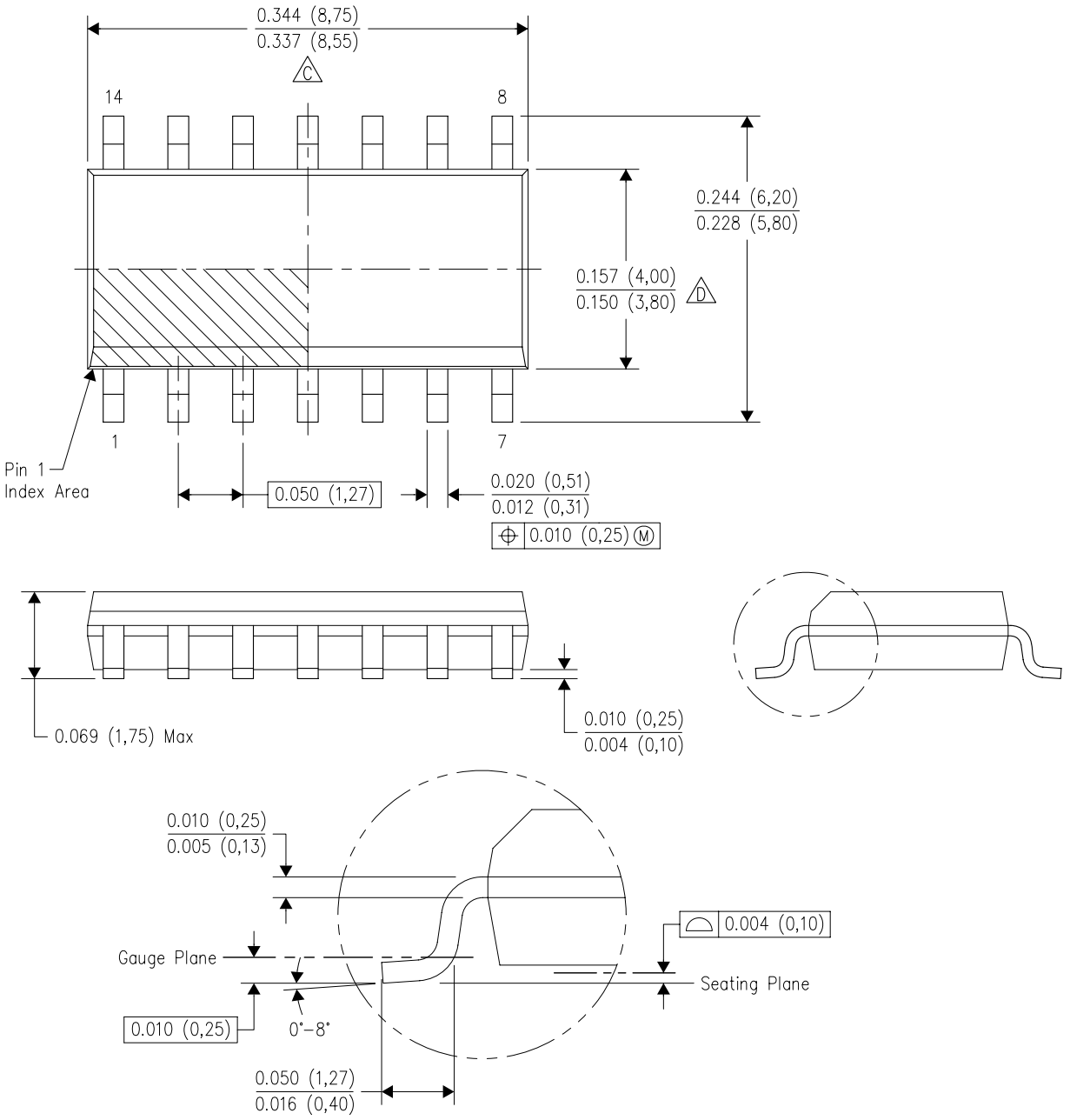
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

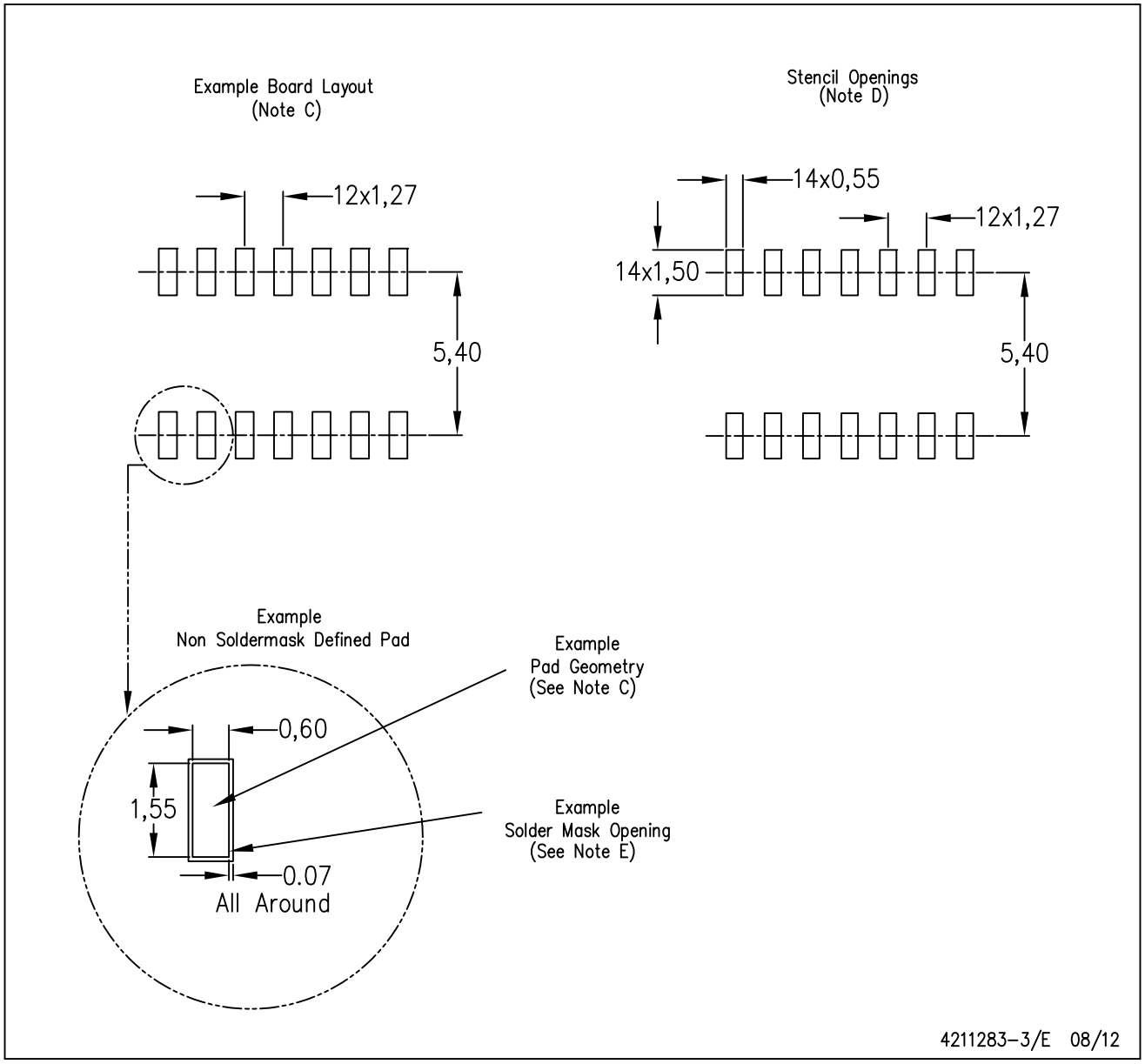
D (R–PDSO–G14) PLASTIC SMALL OUTLINE



4040047–5/M 06/11

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AB.

D (R–PDSO–G14) PLASTIC SMALL OUTLINE

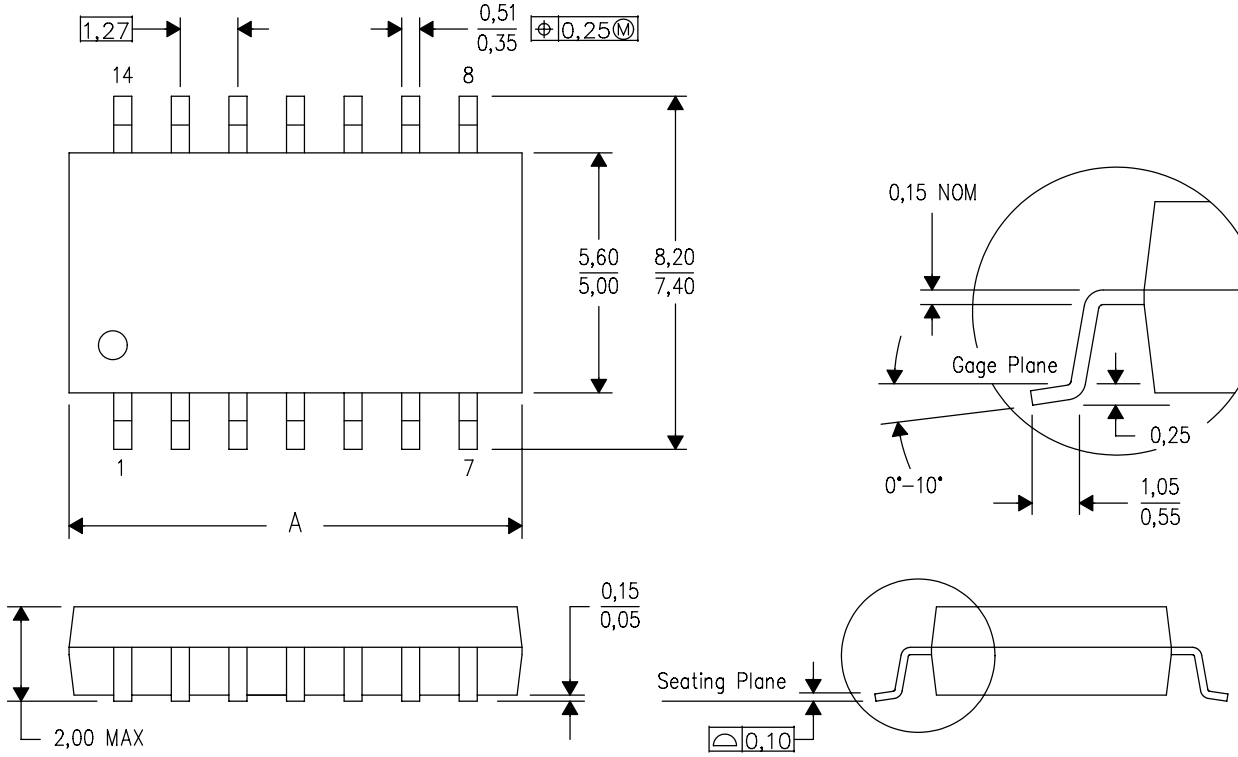


NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC–7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC–7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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FAIRCHILD SEMICONDUCTOR™

August 1986
Revised March 2000

DM74LS138 • DM74LS139 Decoder/Demultiplexer

General Description

These Schottky-clamped circuits are designed to be used in high-performance memory-decoding or data-routing applications, requiring very short propagation delay times. In high-performance memory systems these decoders can be used to minimize the effects of system decoding. When used with high-speed memories, the delay times of these decoders are usually less than the typical access time of the memory. This means that the effective system delay introduced by the decoder is negligible.

The DM74LS138 decodes one-of-eight lines, based upon the conditions at the three binary select inputs and the three enable inputs. Two active-low and one active-high enable inputs reduce the need for external gates or inverters when expanding. A 24-line decoder can be implemented with no external inverters, and a 32-line decoder requires only one inverter. An enable input can be used as a data input for demultiplexing applications.

The DM74LS139 comprises two separate two-line-to-four-line decoders in a single package. The active-low enable input can be used as a data line in demultiplexing applications.

All of these decoders/demultiplexers feature fully buffered inputs, presenting only one normalized load to its driving circuit. All inputs are clamped with high-performance Schottky diodes to suppress line-ringing and simplify system design.

Features

- Designed specifically for high speed:
  - Memory decoders
  - Data transmission systems
- DM74LS138 3-to-8-line decoders incorporates 3 enable inputs to simplify cascading and/or data reception
- DM74LS139 contains two fully independent 2-to-4-line decoders/demultiplexers
- Schottky clamped for high performance
- Typical propagation delay (3 levels of logic)
  - DM74LS138 21 ns
  - DM74LS139 21 ns
- Typical power dissipation
  - DM74LS138 32 mW
  - DM74LS139 34 mW

Ordering Code:

Order Number	Package Number	Package Description
DM74LS138M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74LS138SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74LS138N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
DM74LS139M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74LS139SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74LS139N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

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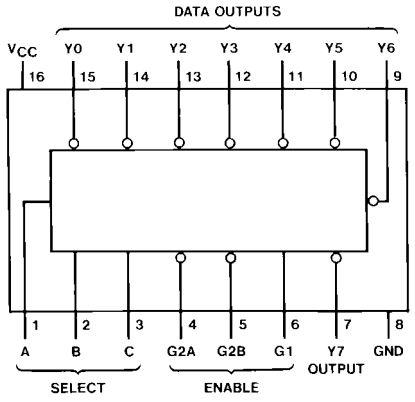
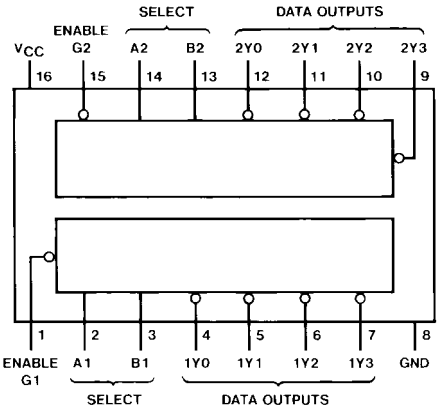
Connection Diagrams

DM74LS138



DM74LS139



Function Tables

DM74LS138

Inputs					Outputs							
Enable		Select										
G1	G2 (Note 1)	C	B	A	YO	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	H	X	X	X	H	H	H	H	H	H	H	H
L	X	X	X	X	H	H	H	H	H	H	H	H
H	L	L	L	L	L	H	H	H	H	H	H	H
H	L	L	L	H	H	L	H	H	H	H	H	H
H	L	L	H	L	H	H	L	H	H	H	H	H
H	L	L	H	H	H	H	H	L	H	H	H	H
H	L	H	L	L	H	H	H	H	L	H	H	H
H	L	H	L	H	H	H	H	H	H	L	H	H
H	L	H	H	L	H	H	H	H	H	H	L	H
H	L	H	H	H	H	H	H	H	H	H	H	L

DM74LS139

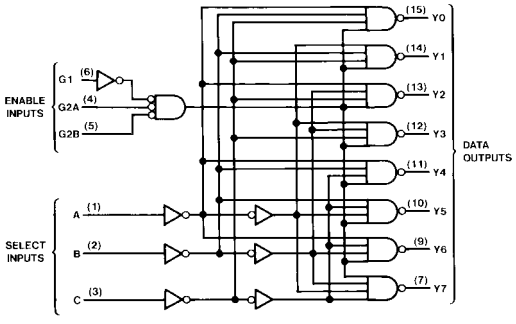
Inputs			Outputs			
Enable	Select					
G	B	A	Y0	Y1	Y2	Y3
H	X	X	H	H	H	H
L	L	L	L	H	H	H
L	L	H	H	L	H	H
L	H	L	H	H	L	H
L	H	H	H	H	H	L

H = HIGH Level
L = LOW Level
X = Don't Care

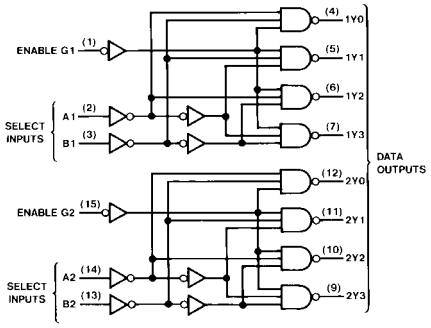
Note 1: G2 = G2A + G2B

Logic Diagrams

DM74LS138



DM74LS139



Absolute Maximum Ratings(Note 2)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 2: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

DM74LS138 Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−0.4	mA
I_{OL}	LOW Level Output Current			8	mA
T_A	Free Air Operating Temperature	0		70	°C

DM74LS138 Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 3)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max, V_{IL} = Max, V_{IH} = Min	2.7	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max, V_{IL} = Max, V_{IH} = Min		0.35	0.5	V
		I_{OL} = 4 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.36	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 4)	−20		−100	mA
I_{CC}	Supply Current	V_{CC} = Max (Note 5)		6.3	10	mA

Note 3: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 4: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Note 5: I_{CC} is measured with all outputs enabled and OPEN.

DM74LS138 Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

Symbol	Parameter	From (Input) To (Output)	Levels of Delay	R_L = 2 kΩ				Units
				C_L = 15 pF		C_L = 50 pF		
				Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Select to Output	2		18		27	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Select to Output	2		27		40	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Select to Output	3		18		27	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Select to Output	3		27		40	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Enable to Output	2		18		27	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Enable to Output	2		24		40	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Enable to Output	3		18		27	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Enable to Output	3		28		40	ns

DM74LS139 Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
I_{OH}	HIGH Level Output Current			−0.4	mA
I_{OL}	LOW Level Output Current			8	mA
T_A	Free Air Operating Temperature	0		70	°C

DM74LS139 Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 6)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
V_{OH}	HIGH Level Output Voltage	V_{CC} = Min, I_{OH} = Max, V_{IL} = Max, V_{IH} = Min	2.7	3.4		V
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max, V_{IL} = Max, V_{IH} = Min		0.35	0.5	V
		I_{OL} = 4 mA, V_{CC} = Min		0.25	0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.1	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			20	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.36	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 7)	−20		−100	mA
I_{CC}	Supply Current	V_{CC} = Max (Note 8)		6.8	11	mA

Note 6: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 7: Not more than one output should be shorted at a time, and the duration should not exceed one second.

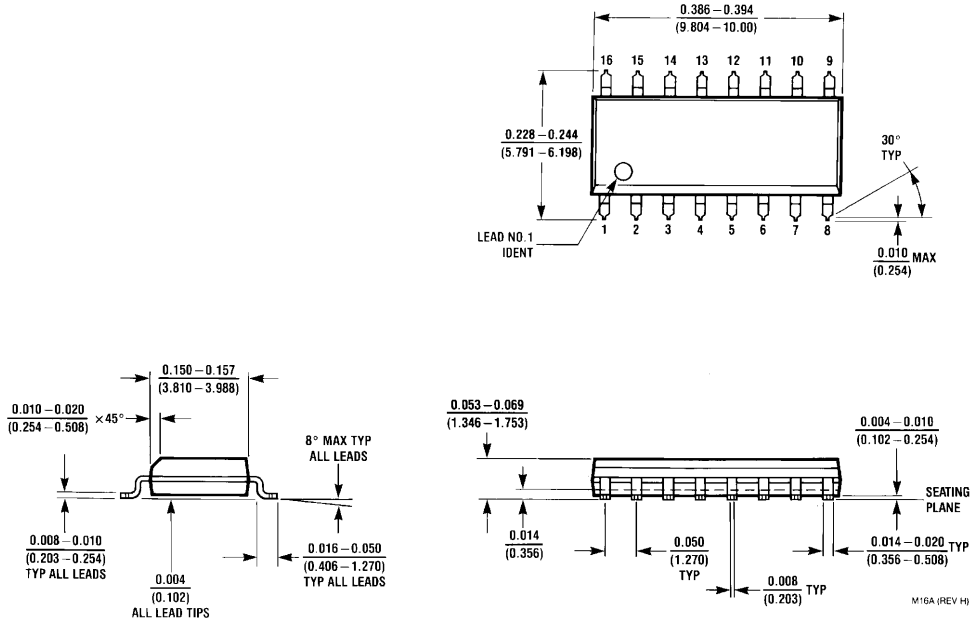
Note 8: I_{CC} is measured with all outputs enabled and OPEN.

DM74LS139 Switching Characteristics

at V_{CC} = 5V and T_A = 25°C

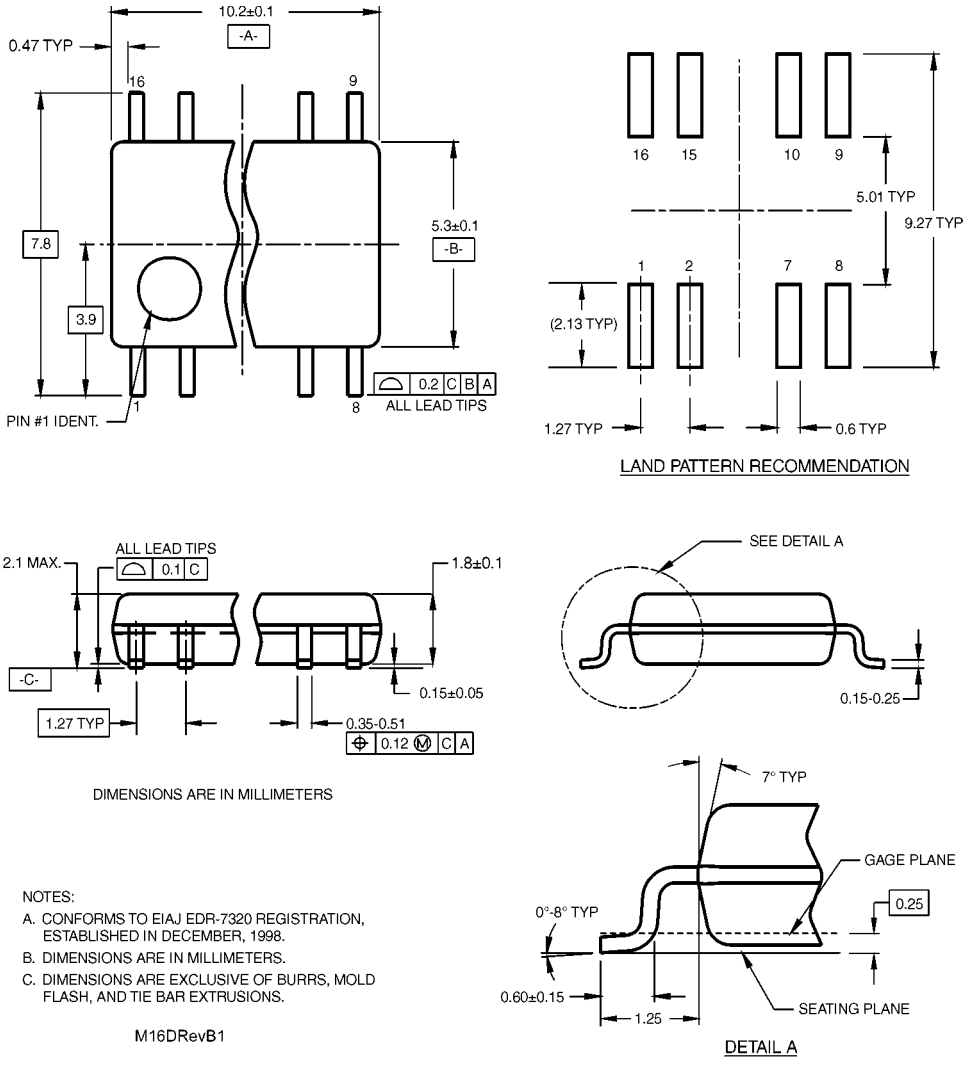
Symbol	Parameter	From (Input) To (Output)	R_L = 2 kΩ				Units
			C_L = 15 pF		C_L = 50 pF		
			Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Select to Output		18		27	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Select to Output		27		40	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Enable to Output		18		27	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Enable to Output		24		40	ns

Physical Dimensions inches (millimeters) unless otherwise noted



16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



NOTES:

A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.

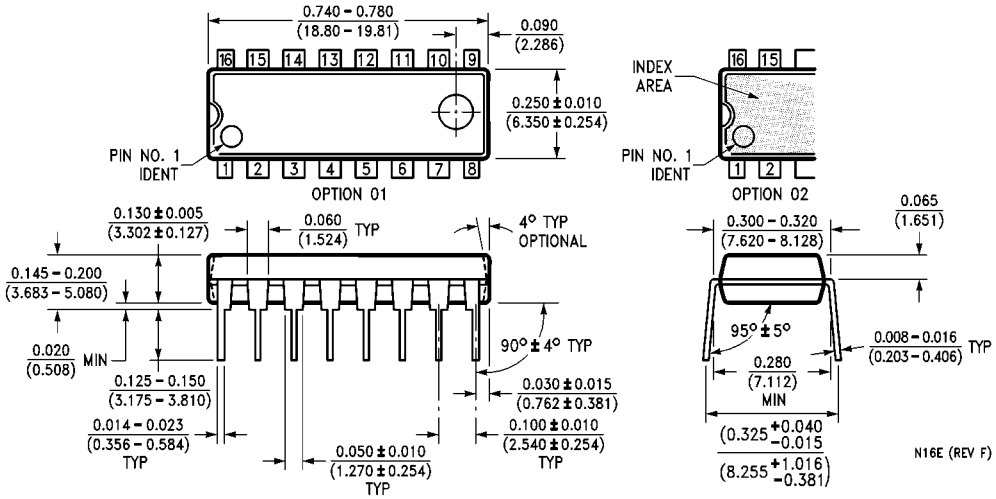
B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M16DRevB1

16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M16D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N16E

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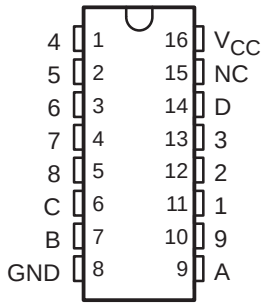
’147, ’LS147

- **Encode 10-Line Decimal to 4-Line BCD**
- **Applications Include:**
  - **Keyboard Encoding**
  - **Range Selection**

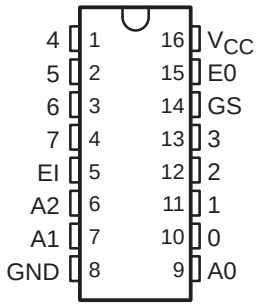
’148, ’LS148

- **Encode 8 Data Lines to 3-Line Binary (Octal)**
- **Applications Include:**
  - **n-Bit Encoding**
  - **Code Converters and Generators**

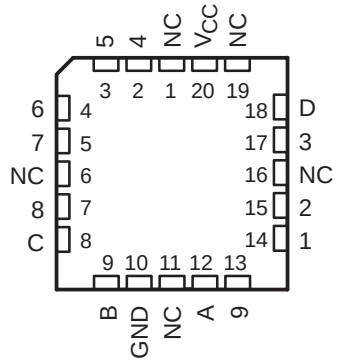
SN54147, SN54LS147 . . . J OR W PACKAGE
SN74147, SN74LS147 . . . D OR N PACKAGE
(TOP VIEW)



SN54148, SN54LS148 . . . J OR W PACKAGE
SN74148, SN74LS148 . . . D, N, OR NS PACKAGE
(TOP VIEW)



SN54LS147 . . . FK PACKAGE
(TOP VIEW)



SN54LS148 . . . FK PACKAGE
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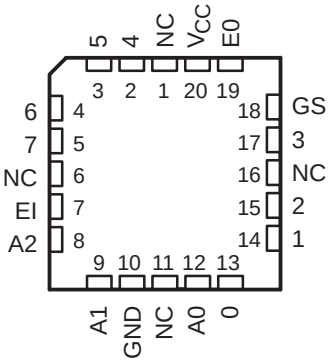

NC − No internal connection

TYPE	TYPICAL DATA DELAY	TYPICAL POWER DISSIPATION
’147	10 ns	225 mW
’148	10 ns	190 mW
’LS147	15 ns	60 mW
’LS148	15 ns	60 mW

NOTE: The SN54147, SN54LS147, SN54148, SN74147, SN74LS147, and SN74148 are obsolete and are no longer supplied.

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description/ordering information

These TTL encoders feature priority decoding of the inputs to ensure that only the highest-order data line is encoded. The ’147 and ’LS147 devices encode nine data lines to four-line (8-4-2-1) BCD. The implied decimal zero condition requires no input condition, as zero is encoded when all nine data lines are at a high logic level. The ’148 and ’LS148 devices encode eight data lines to three-line (4-2-1) binary (octal). Cascading circuitry (enable input EI and enable output EO) has been provided to allow octal expansion without the need for external circuitry. For all types, data inputs and outputs are active at the low logic level. All inputs are buffered to represent one normalized Series 54/74 or 54/74LS load, respectively.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP − N	Tube	SN74LS148N	SN74LS148N
	SOIC − D	Tube	SN74LS148D	LS148
		Tape and reel	SN74LS148DR	
	SOP − NS	Tape and reel	SN74LS148NSR	74LS148
−55°C to 125°C	CDIP − J	Tube	SNJ54LS148J	SNJ54LS148J
	CFP − W	Tube	SNJ54LS148W	SNJ54LS148W
	LCCC − FK	Tube	SNJ54LS148FK	SNJ54LS148FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE − ’147, ’LS147

INPUTS									OUTPUTS			
1	2	3	4	5	6	7	8	9	D	C	B	A
H	H	H	H	H	H	H	H	H	H	H	H	H
X	X	X	X	X	X	X	X	L	L	H	H	L
X	X	X	X	X	X	X	L	H	L	H	H	H
X	X	X	X	X	X	L	H	H	H	L	L	L
X	X	X	X	X	L	H	H	H	H	L	L	H
X	X	X	X	L	H	H	H	H	H	L	H	L
X	X	X	L	H	H	H	H	H	H	L	H	H
X	X	L	H	H	H	H	H	H	H	H	L	L
X	L	H	H	H	H	H	H	H	H	H	L	H
L	H	H	H	H	H	H	H	H	H	H	H	L

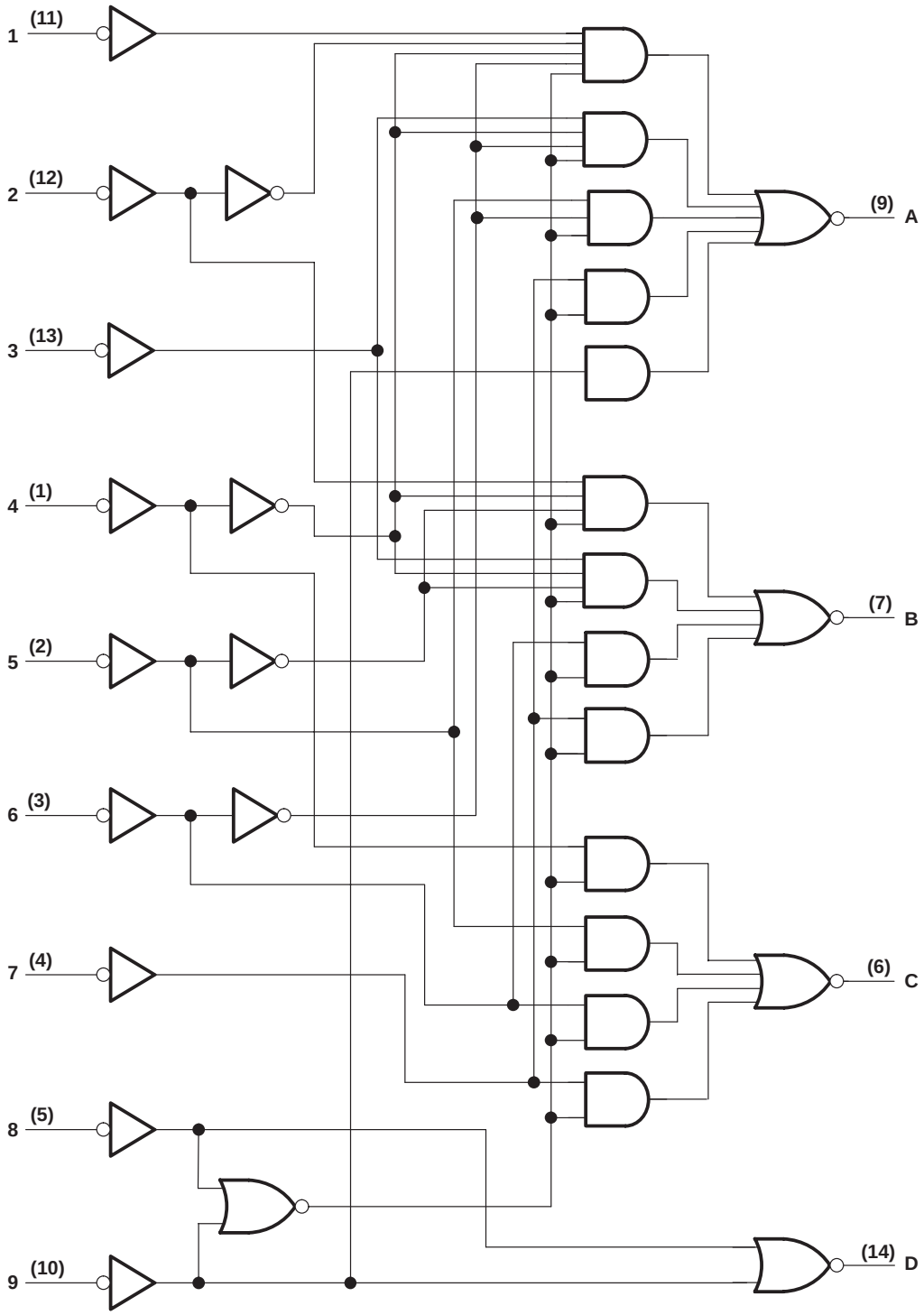
H = high logic level, L = low logic level, X = irrelevant

FUNCTION TABLE − ’148, ’LS148

INPUTS									OUTPUTS				
EI	0	1	2	3	4	5	6	7	A2	A1	A0	GS	EO
H	X	X	X	X	X	X	X	X	H	H	H	H	H
L	H	H	H	H	H	H	H	H	H	H	H	H	L
L	X	X	X	X	X	X	X	L	L	L	L	L	H
L	X	X	X	X	X	X	L	H	L	L	H	L	H
L	X	X	X	X	X	L	H	H	L	H	L	L	H
L	X	X	X	X	L	H	H	H	L	H	H	L	H
L	X	X	X	L	H	H	H	H	H	L	L	L	H
L	X	X	L	H	H	H	H	H	H	L	H	L	H
L	X	L	H	H	H	H	H	H	H	H	L	L	H
L	L	H	H	H	H	H	H	H	H	H	H	L	H

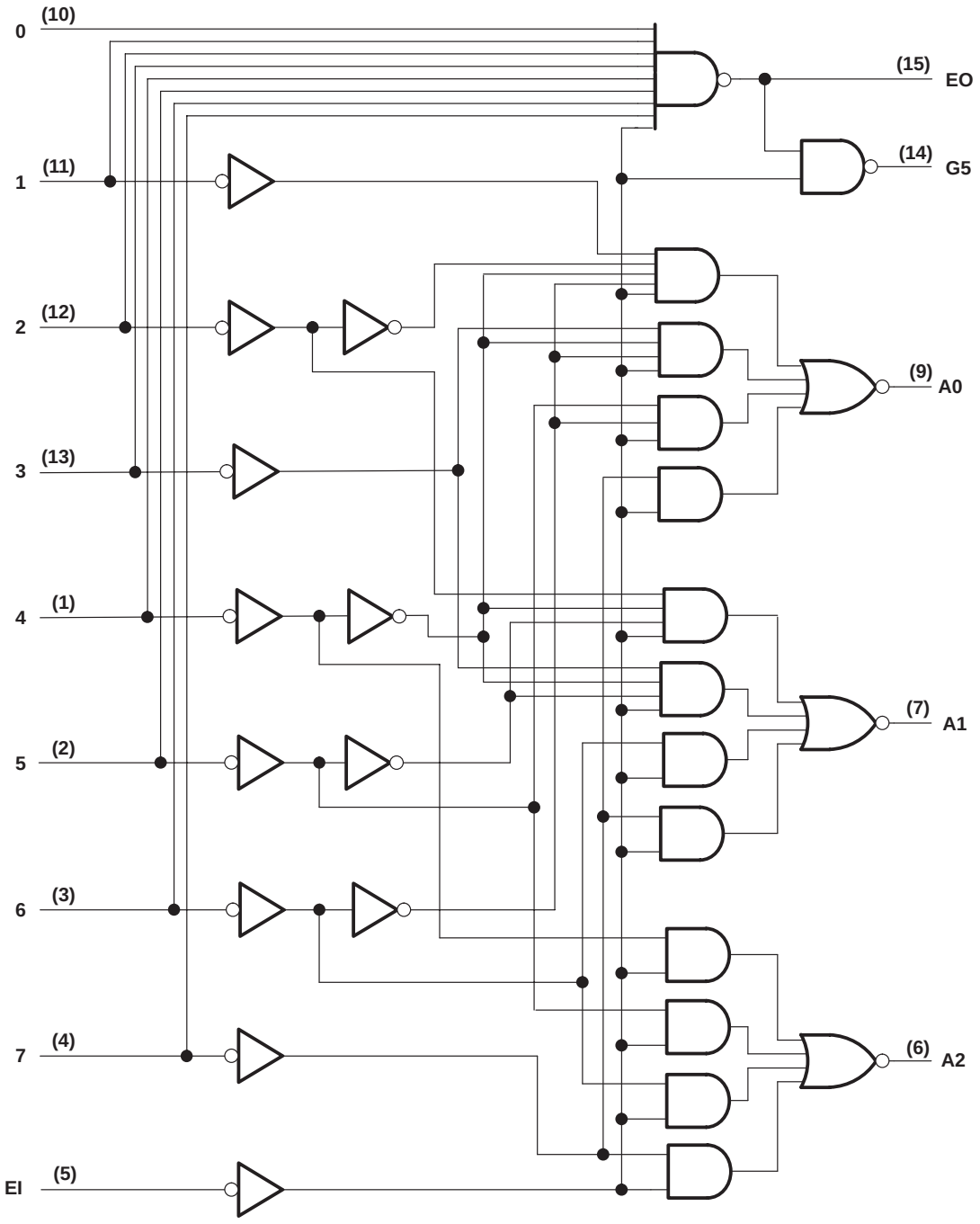
H = high logic level, L = low logic level, X = irrelevant

’147, ’LS147 logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

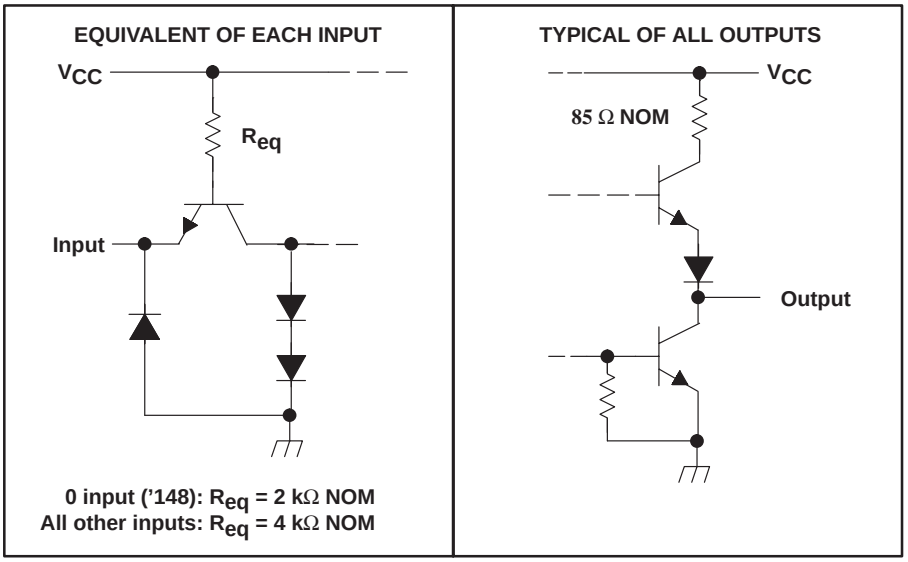
’148, ’LS148 logic diagram (positive logic)



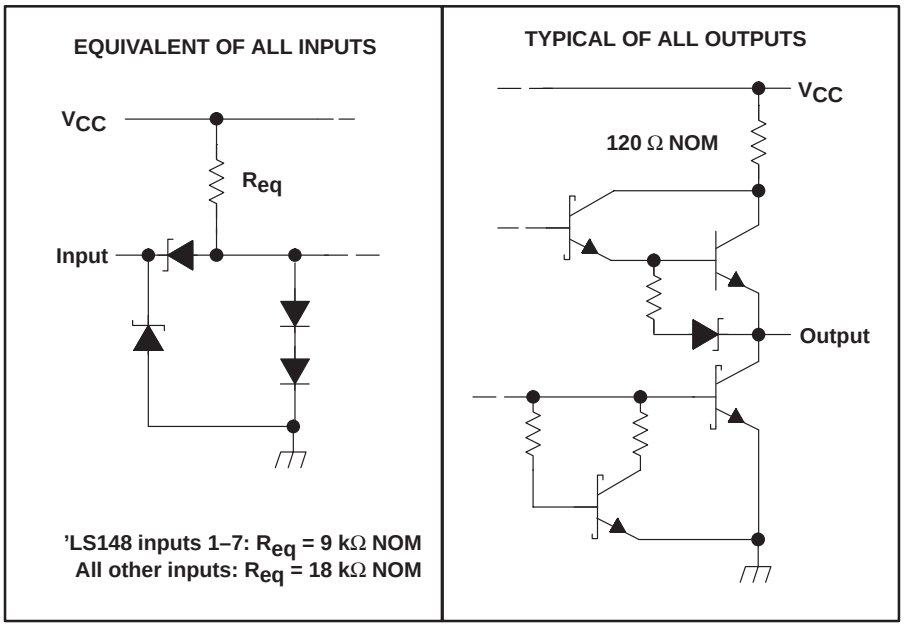
Pin numbers shown are for D, J, N, NS, and W packages.

schematics of inputs and outputs

'147, '148



'LS147, 'LS148



absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage, V_I: ’147, ’148 . . . . . 5.5 V
’LS147, ’LS148 . . . . . 7 V
Inter-emitter voltage: ’148 only (see Note 2) . . . . . 5.5 V
Package thermal impedance θ_{JA} (see Note 3): D package . . . . . 73°C/W
N package . . . . . 67°C/W
NS package . . . . . 64°C/W
Storage temperature range, T_{stg} . . . . . −65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values, except inter-emitter voltage, are with respect to the network ground terminal.
2. This is the voltage between two emitters of a multiple-emitter transistor. For ’148 circuits, this rating applies between any two of the eight data lines, 0 through 7.
3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 4)

		SN54’			SN74’			SN54LS’			SN74LS’			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current			−800			−800			−400			−400	μA
I_{OL}	Low-level output current			16			16			4			8	mA
T_A	Operating free-air temperature	−55		125	0		70	−55		125	0		70	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		'147 MIN	'147 TYP‡	'147 MAX	'148 MIN	'148 TYP‡	'148 MAX	UNIT
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.8			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −12 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = 0.8 V,	V_{IH} = 2 V, I_{OH} = −800 μA	2.4	3.3		2.4	3.3		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IL} = 0.8 V,	V_{IH} = 2 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage		V_{CC} = MIN,	V_I = 5.5 V			1			1	mA
I_{IH}	High-level input current	0 input	V_{CC} = MAX,	V_I = 2.4 V						40	μA
		Any input except 0					40			80	
I_{IL}	Low-level input current	0 input	V_{CC} = MAX,	V_I = 0.4 V						−1.6	mA
		Any input except 0					−1.6			−3.2	
I_{OS}	Short-circuit output current§		V_{CC} = MAX		−35		−85	−35		−85	mA
I_{CC}	Supply current		V_{CC} = MAX (See Note 5)	Condition 1		50	70		40	60	mA
				Condition 2		42	62		35	55	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
NOTE 5: For '147, I_{CC} (Condition 1) is measured with input 7 grounded, other inputs and outputs open; I_{CC} (Condition 2) is measured with all inputs and outputs open. For '148, I_{CC} (Condition 1) is measured with inputs 7 and EI grounded, other inputs and outputs open; I_{CC} (Condition 2) is measured with all inputs and outputs open.

SN54147, SN74147 switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Any	Any	In-phase output	C_L = 15 pF, R_L = 400 Ω		9	14	ns
t_{PHL}						7	11	
t_{PLH}	Any	Any	Out-of-phase output			13	19	ns
t_{PHL}						12	19	

SN54148, SN74148 switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	1–7	A0, A1, or A2	In-phase output	C_L = 15 pF, R_L = 400 Ω		10	15	ns
t_{PHL}						9	14	
t_{PLH}	1–7	A0, A1, or A2	Out-of-phase output			13	19	ns
t_{PHL}						12	19	
t_{PLH}	0–7	EO	Out-of-phase output			6	10	ns
t_{PHL}						14	25	
t_{PLH}	0–7	GS	In-phase output			18	30	ns
t_{PHL}						14	25	
t_{PLH}	EI	A0, A1, or A2	In-phase output			10	15	ns
t_{PHL}						10	15	
t_{PLH}	EI	GS	In-phase output			8	12	ns
t_{PHL}						10	15	
t_{PLH}	EI	EO	In-phase output			10	15	ns
t_{PHL}						17	30	

† t_{PLH} = propagation delay time, low-to-high-level output.
t_{PHL} = propagation delay time, high-to-low-level output.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54LS' MIN	SN54LS' TYP‡	SN54LS' MAX	SN74LS' MIN	SN74LS' TYP‡	SN74LS' MAX	UNIT
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IL} = 0.8 V,	V_{IH} = 2 V, I_{OH} = −400 µA	2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} MAX	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
				I_{OL} = 8 mA					0.35	0.5	
I_I	Input current at maximum input voltage	'LS148 inputs 1–7	V_{CC} = MAX,	V_I = 7 V			0.2			0.2	mA
		All other inputs					0.1			0.1	
I_{IH}	High-level input current	'LS148 inputs 1–7	V_{CC} = MAX,	V_I = 2.7 V			40			40	µA
		All other inputs					20			20	
I_{IL}	Low-level input current	'LS148 inputs 1–7	V_{CC} = MAX,	V_I = 0.4 V			−0.8			−0.8	mA
		All other inputs					−0.4			−0.4	
I_{OS}	Short-circuit output current§		V_{CC} = MAX		−20		−100	−20		−100	mA
I_{CC}	Supply current		V_{CC} = MAX (See Note 6)	Condition 1		12	20		12	20	mA
				Condition 2		10	17		10	17	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
NOTE 6: For 'LS147, I_{CC} (Condition 1) is measured with input 7 grounded, other inputs and outputs open; I_{CC} (Condition 2) is measured with all inputs and outputs open. For 'LS148, I_{CC} (Condition 1) is measured with inputs 7 and EI grounded, other inputs and outputs open; I_{CC} (Condition 2) is measured with all inputs and outputs open.

SN54LS147, SN74LS147 switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 2)

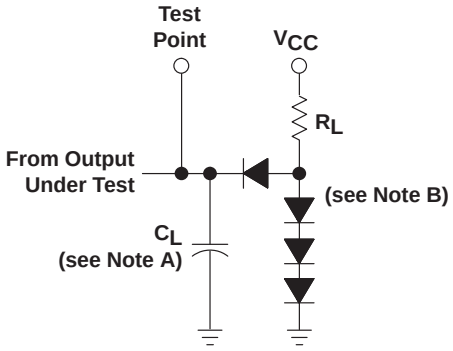
PARAMETER	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Any	Any	In-phase output	C_L = 15 pF, R_L = 2 kΩ		12	18	ns
t_{PHL}						12	18	
t_{PLH}	Any	Any	Out-of-phase output			21	33	ns
t_{PHL}						15	23	

SN54LS148, SN74LS148 switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 2)

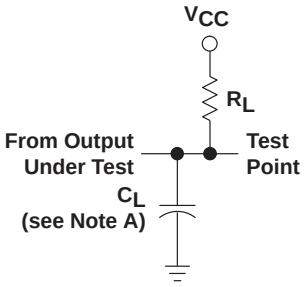
PARAMETER†	FROM (INPUT)	TO (OUTPUT)	WAVEFORM	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	1–7	A0, A1, or A2	In-phase output	C_L = 15 pF, R_L = 2 kΩ		14	18	ns
t_{PHL}						15	25	
t_{PLH}	1–7	A0, A1, or A2	Out-of-phase output			20	36	ns
t_{PHL}						16	29	
t_{PLH}	0–7	EO	Out-of-phase output			7	18	ns
t_{PHL}						25	40	
t_{PLH}	0–7	GS	In-phase output			35	55	ns
t_{PHL}						9	21	
t_{PLH}	EI	A0, A1, or A2	In-phase output			16	25	ns
t_{PHL}						12	25	
t_{PLH}	EI	GS	In-phase output			12	17	ns
t_{PHL}						14	36	
t_{PLH}	EI	EO	In-phase output			12	21	ns
t_{PHL}						23	35	

† t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output

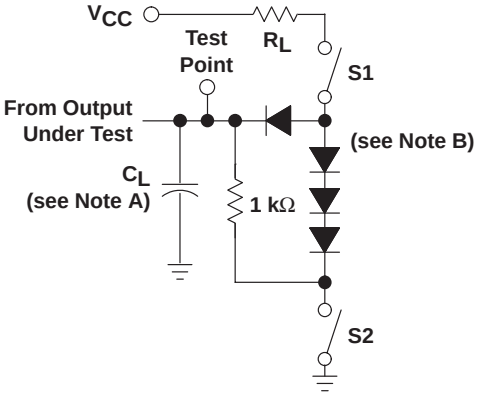
PARAMETER MEASUREMENT INFORMATION
SERIES 54/74 DEVICES



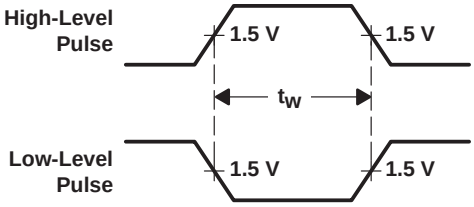
LOAD CIRCUIT
FOR 2-STATE TOTEM-POLE OUTPUTS



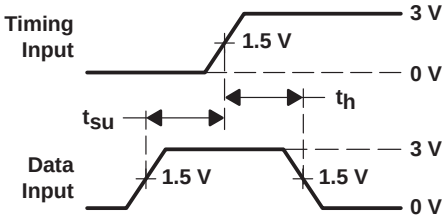
LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS



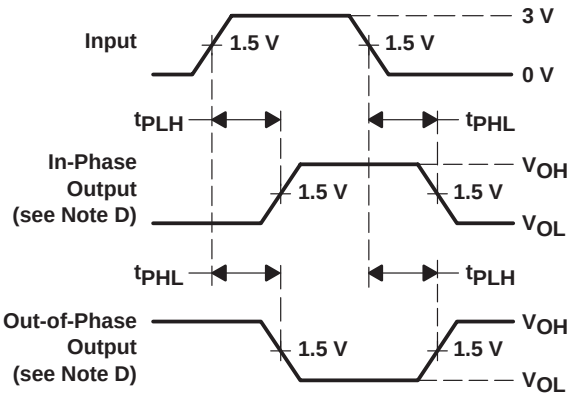
LOAD CIRCUIT
FOR 3-STATE OUTPUTS



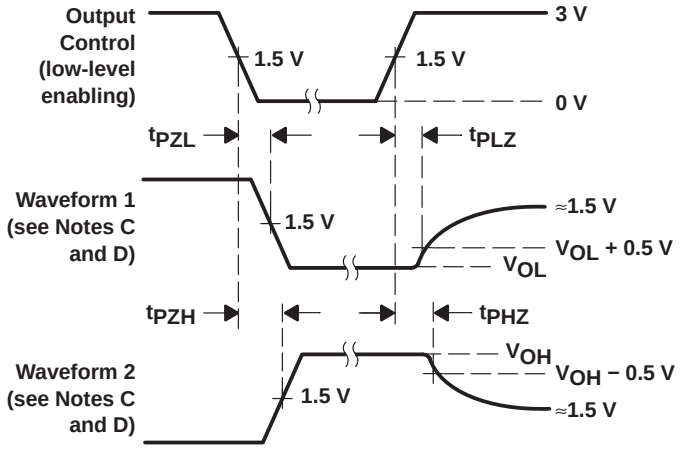
VOLTAGE WAVEFORMS
PULSE DURATIONS



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

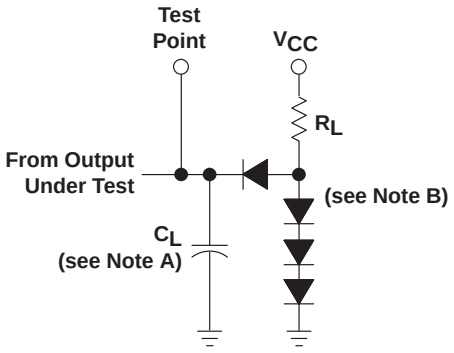


VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

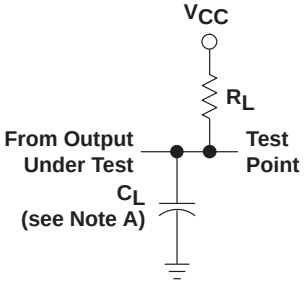
NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
D. S1 and S2 are closed for t_{PLH}, t_{PHL}, t_{PHZ}, and t_{PLZ}; S1 is open, and S2 is closed for t_{PZH}; S1 is closed, and S2 is open for t_{PZL}.
E. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, $Z_O \approx 50\ \Omega$; t_r and $t_f \leq 7$ ns for Series 54/74 devices and t_r and $t_f \leq 2.5$ ns for Series 54S/74S devices.
F. The outputs are measured one at a time, with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

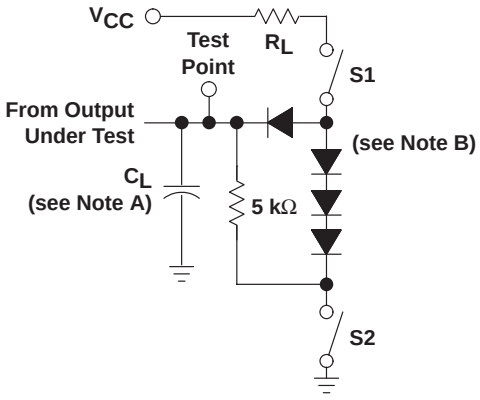
PARAMETER MEASUREMENT INFORMATION
SERIES 54LS/74LS DEVICES



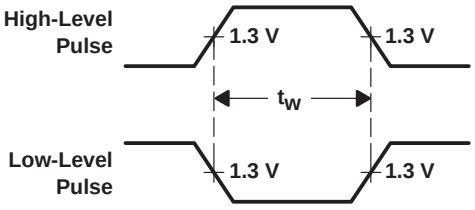
LOAD CIRCUIT
FOR 2-STATE TOTEM-POLE OUTPUTS



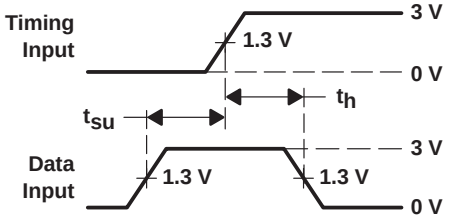
LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS



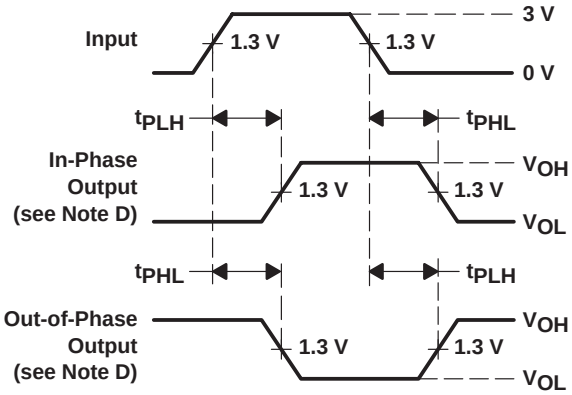
LOAD CIRCUIT
FOR 3-STATE OUTPUTS



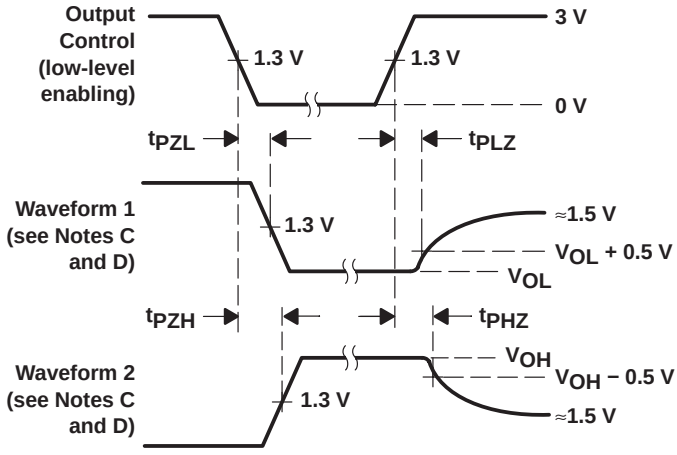
VOLTAGE WAVEFORMS
PULSE DURATIONS



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

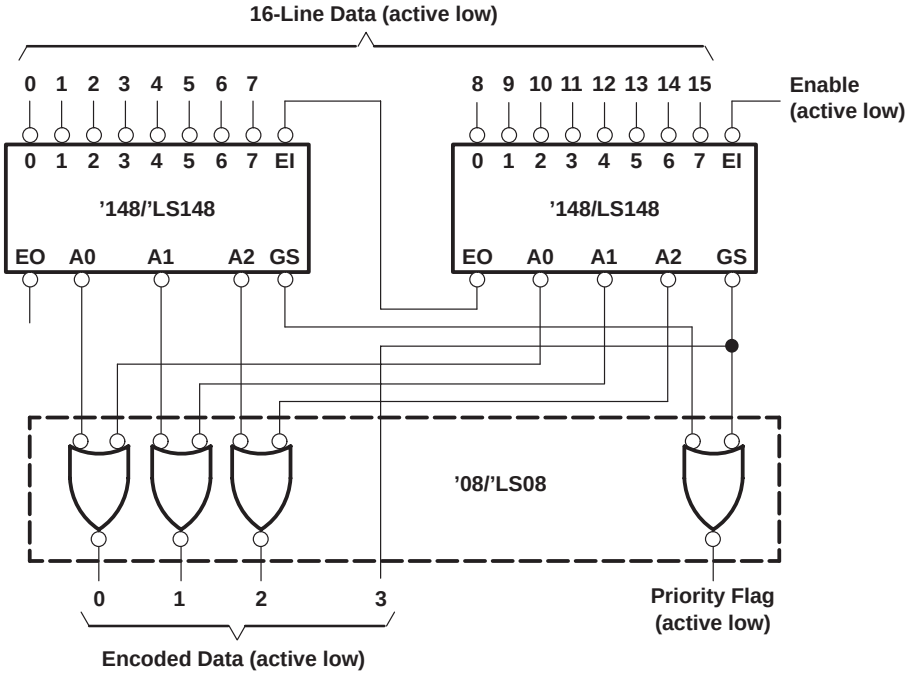


VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
D. S1 and S2 are closed for t_{PLH}, t_{PHL}, t_{PHZ}, and t_{PLZ}; S1 is open, and S2 is closed for t_{PZH}; S1 is closed, and S2 is open for t_{PZL}.
E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
F. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O ≈ 50 Ω, t_r ≤ 1.5 ns, t_f ≤ 2.6 ns.
G. The outputs are measured one at a time, with one input transition per measurement.

Figure 2. Load Circuits and Voltage Waveforms

APPLICATION INFORMATION



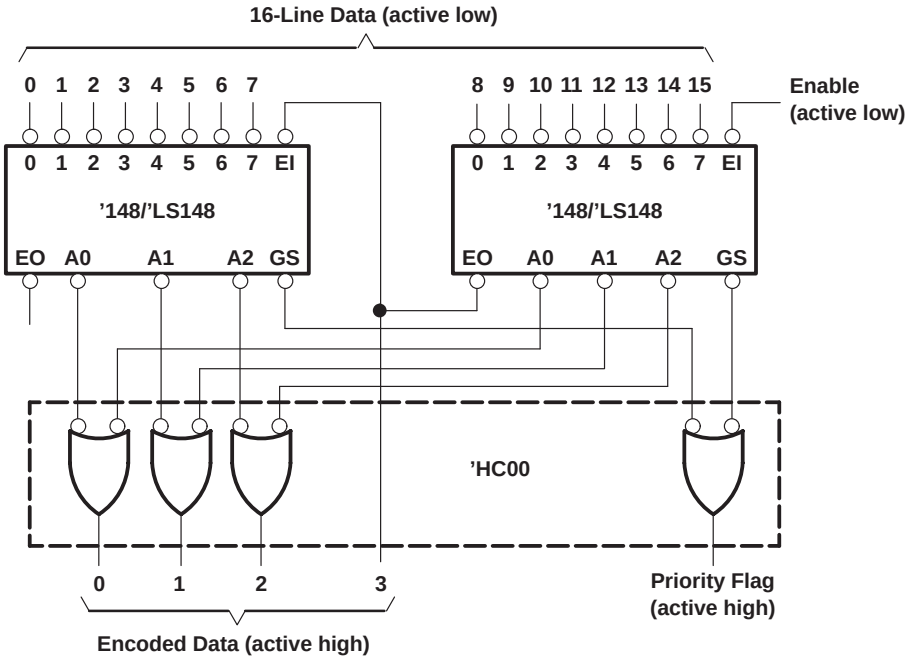


Figure 3. Priority Encoder for 16 Bits

Because the '147/'LS147 and '148/'LS148 devices are combinational logic circuits, wrong addresses can appear during input transients. Moreover, for the '148/'LS148 devices, a change from high to low at EI can cause a transient low on GS when all inputs are high. This must be considered when strobing the outputs.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
78027012A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
7802701EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
7802701FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/36001B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/36001BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/36001BFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SN54148J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54LS148J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN74147N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74148J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74148N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74148N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS147DR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS147N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS148D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS148DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS148DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS148DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS148J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS148N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS148N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS148NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS148NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS148NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54148J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54148W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
SNJ54LS148FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS148J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS148W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check

http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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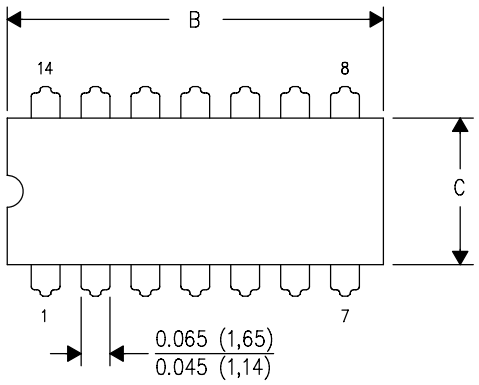
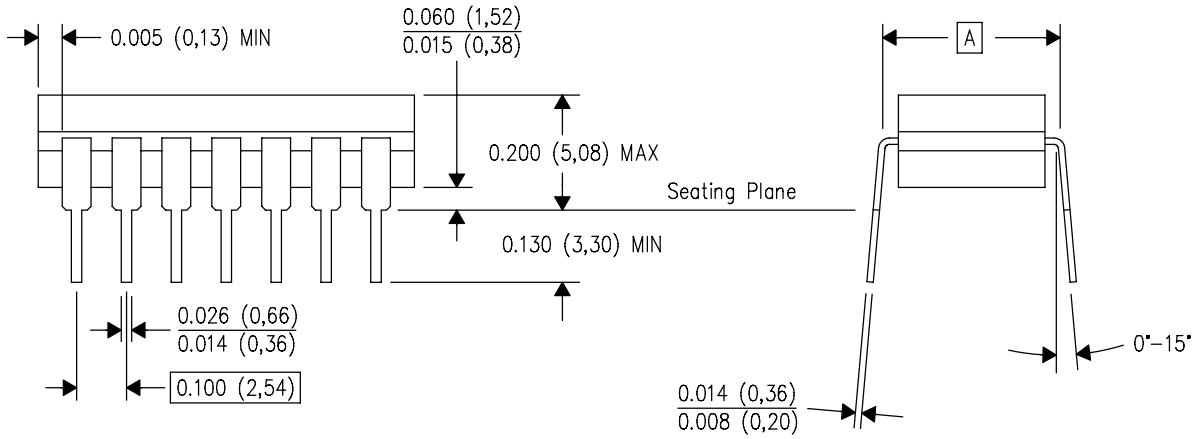
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



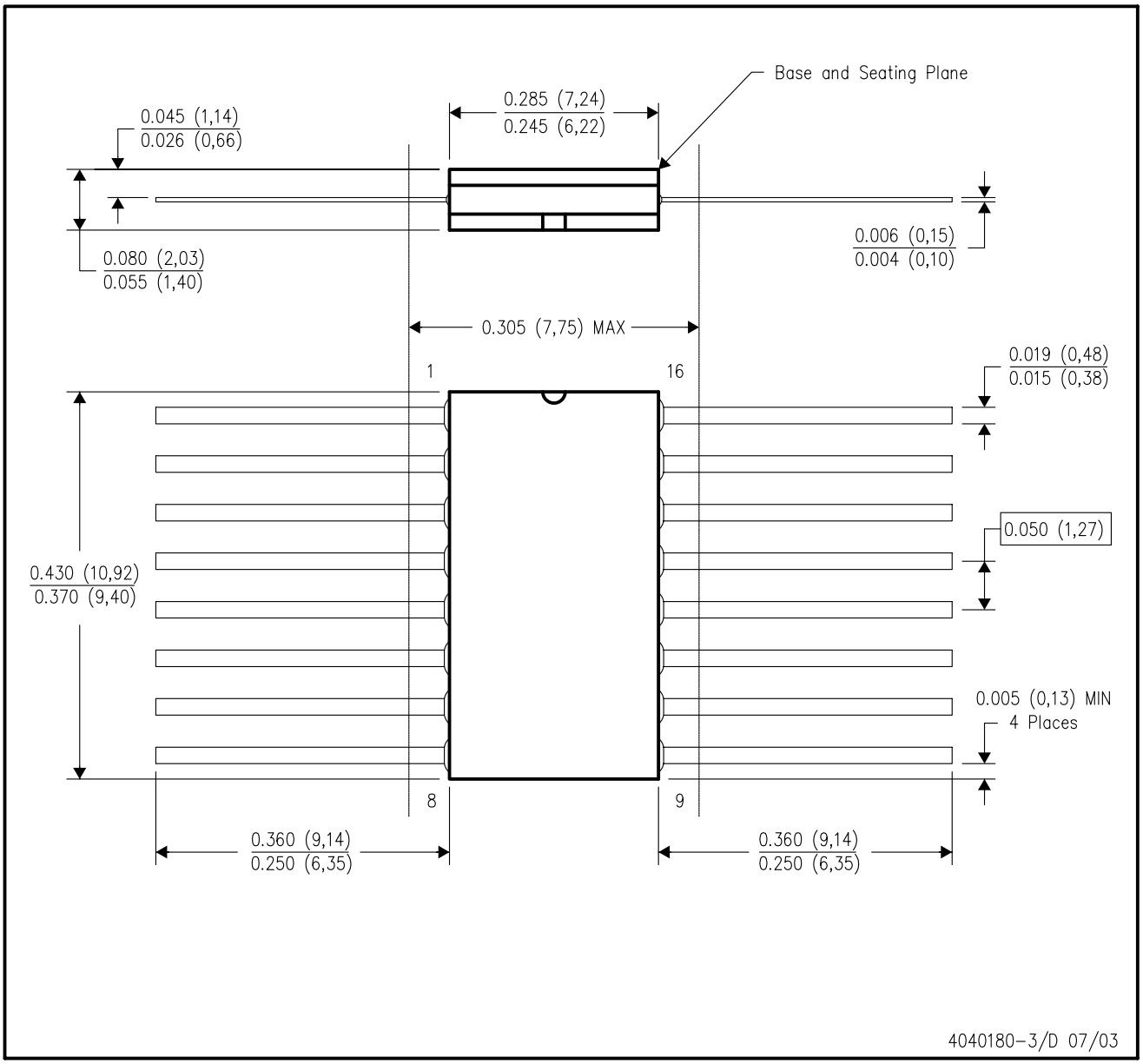
DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

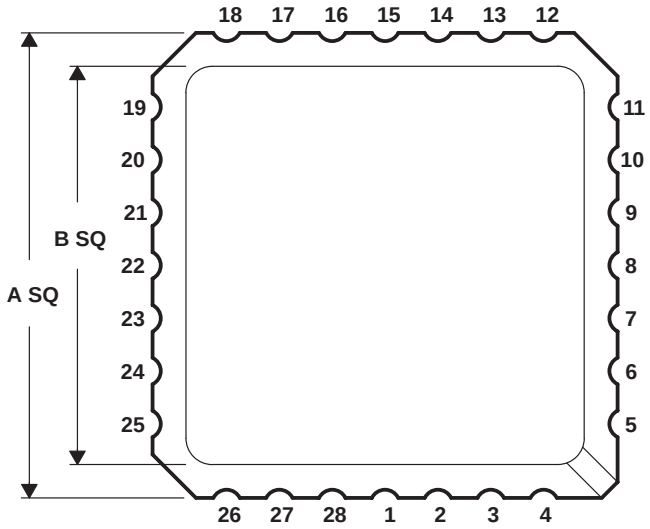
W (R–GDFP–F16) CERAMIC DUAL FLATPACK



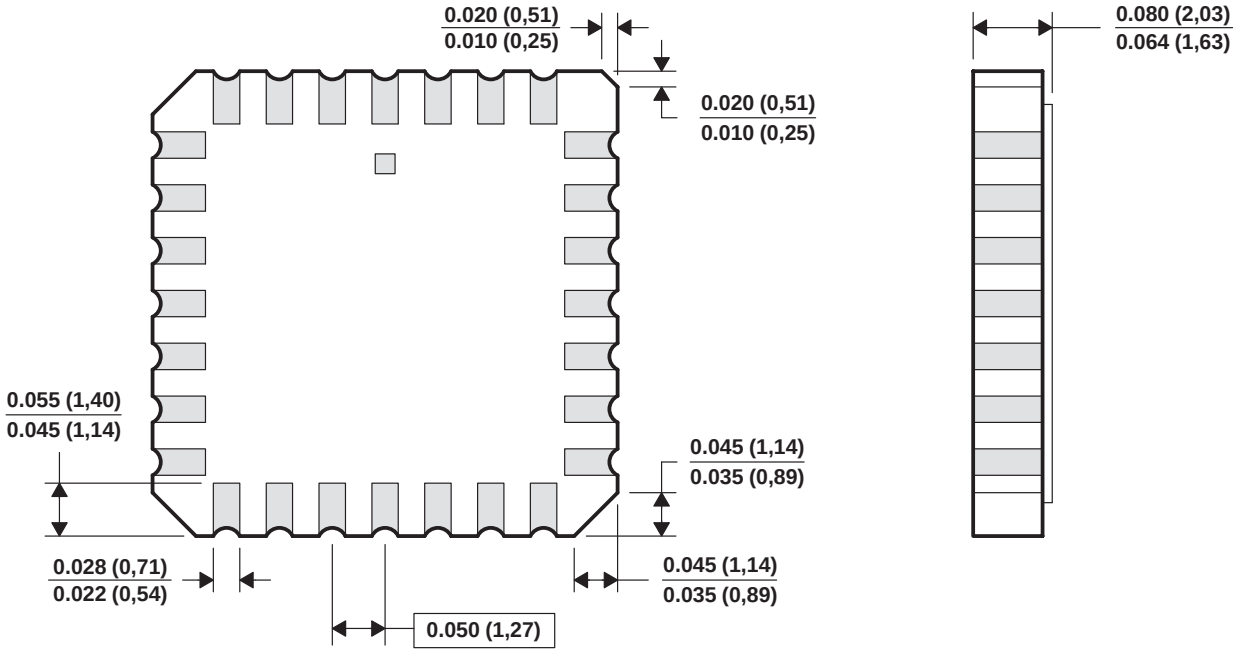
NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only.
E. Falls within MIL STD 1835 GDFP1–F16 and JEDEC MO–092AC

FK (S-CQCC-N)** **LEADLESS CERAMIC CHIP CARRIER**

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.739 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



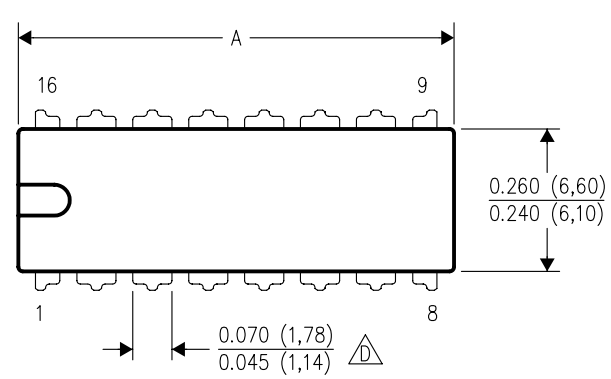
4040140/D 10/96

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. The terminals are gold plated.
E. Falls within JEDEC MS-004

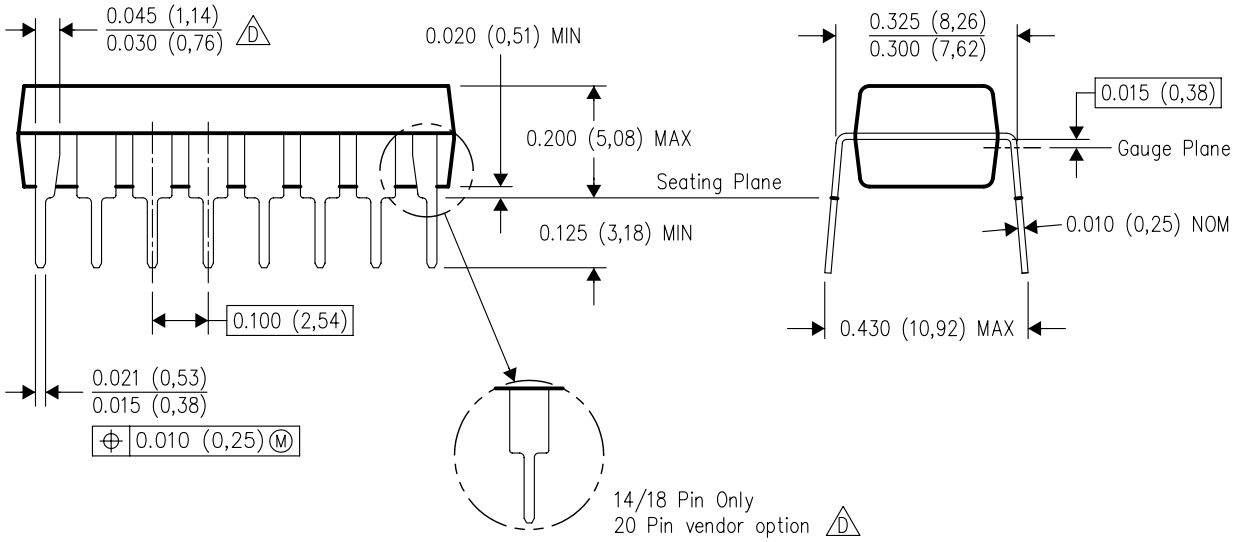
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



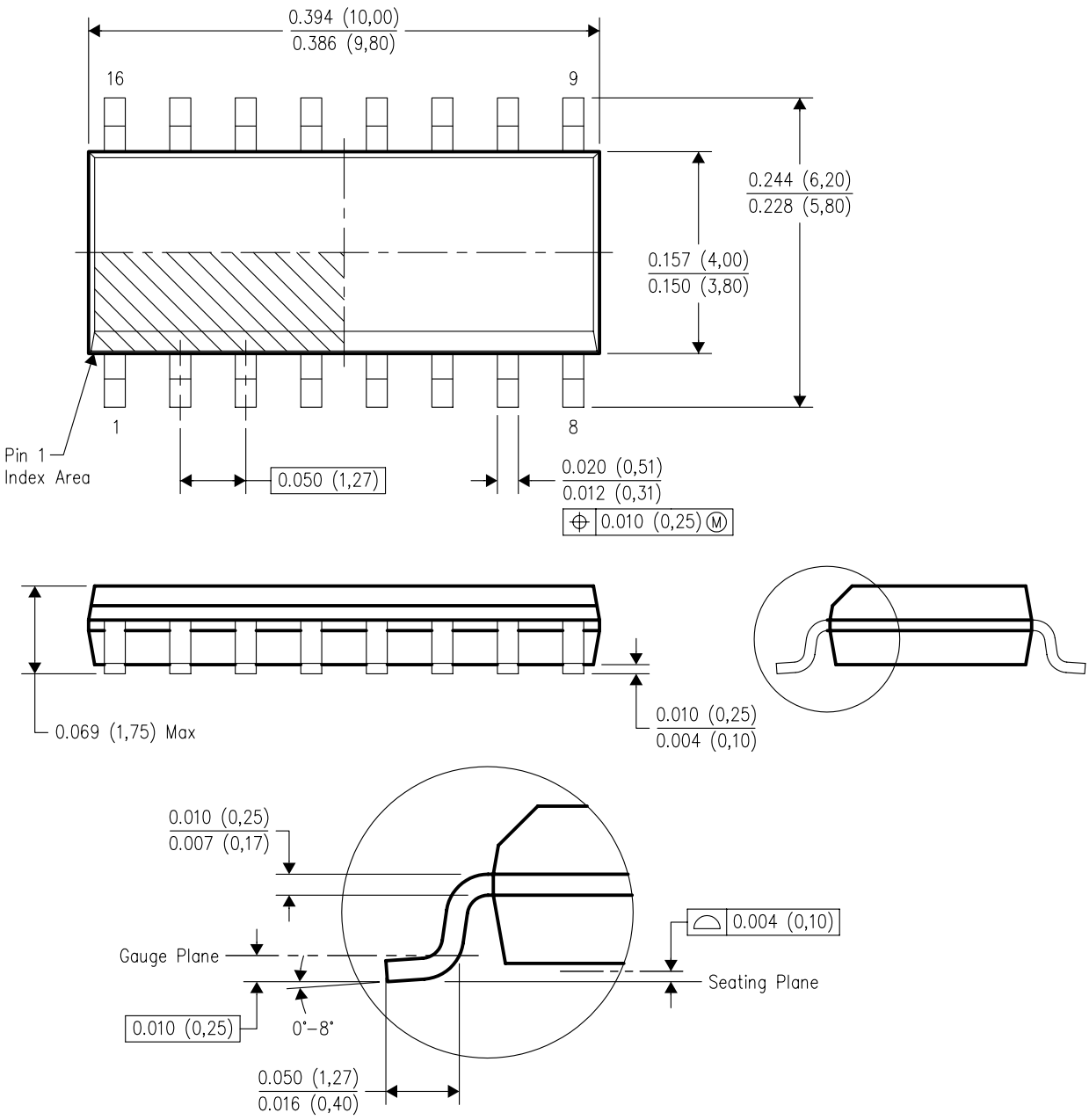
DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R–PDSO–G16) PLASTIC SMALL–OUTLINE PACKAGE

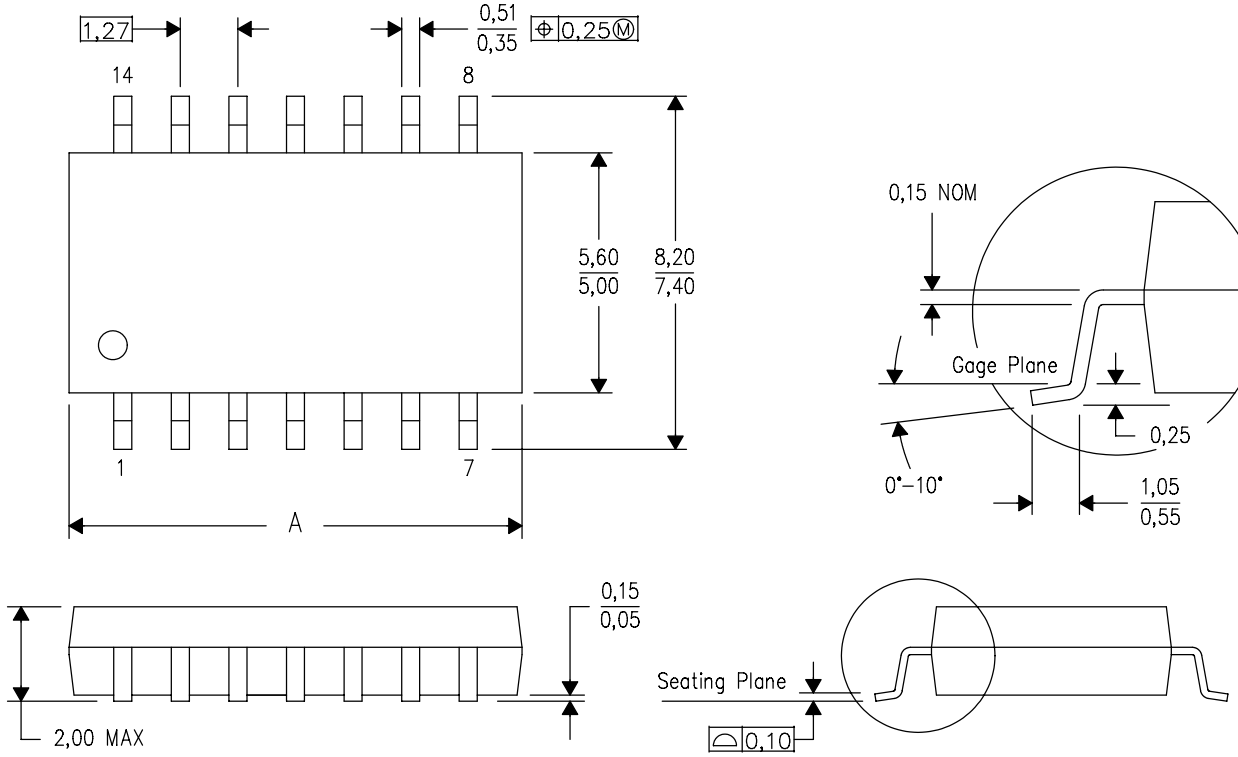


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–012 variation AC.

MECHANICAL DATA

NS (R-PDSO-G)** **PLASTIC SMALL-OUTLINE PACKAGE**

14-PINS SHOWN



DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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Mailing Address: Texas Instruments
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National Semiconductor

June 1989

54150/DM54150/DM74150, 54151A/DM54151A/DM74151A Data Selectors/Multiplexers

General Description

These data selectors/multiplexers contain full on-chip decoding to select the desired data source. The 150 selects one-of-sixteen data sources; the 151A selects one-of-eight data sources. The 150 and 151A have a strobe input which must be at a low logic level to enable these devices. A high level at the strobe forces the W output high and the Y output (as applicable) low.

The 151A features complementary W and Y outputs, whereas the 150 has an inverted (W) output only.

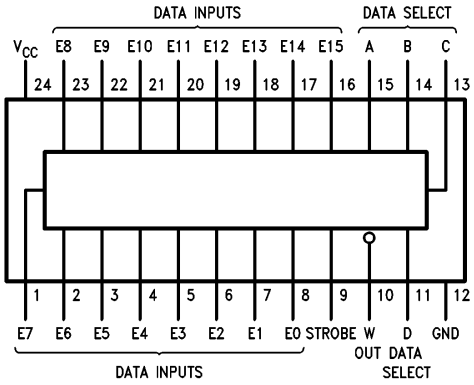
The 151A incorporates address buffers which have symmetrical propagation delay times through the complementary paths. This reduces the possibility of transients occurring at the output(s) due to changes made at the select inputs, even when the 151A outputs are enabled (i.e., strobe low).

Features

- 150 selects one-of-sixteen data lines
- 151A selects one-of-eight data lines
- Performs parallel-to-serial conversion
- Permits multiplexing from N lines to one line
- Also for use as Boolean function generator
- Typical average propagation delay time, data input to W output
  - 150 11 ns
  - 151A 9 ns
- Typical power dissipation
  - 150 200 mW
  - 151A 135 mW
- Alternate Military/Aerospace device (54150, 54151A) is available. Contact a National Semiconductor Sales Office/Distributor for specifications.

Connection Diagrams

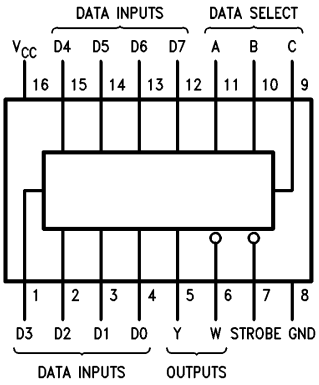
Dual-In-Line Package



TL/F/6546–1

Order Number 54150DQMB, 54150FMQB, DM54150J or DM74150N
See NS Package Number J24A, N24A or W24C

Dual-In-Line Package



TL/F/6546–2

Order Number 54151ADMQB, 54151AFMQB, DM54151AJ, DM54151AW or DM74151AN
See NS Package Number J16A, N16E or W16A

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Absolute Maximum Ratings (Note)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	7V
Input Voltage	5.5V
Operating Free Air Temperature Range	
DM54 and 54	−55°C to +125°C
DM74	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note: *The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.*

Recommended Operating Conditions

Symbol	Parameter	DM54150			DM74150			Units
		Min	Nom	Max	Min	Nom	Max	
V_{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High Level Input Voltage	2			2			V
V_{IL}	Low Level Input Voltage			0.8			0.8	V
I_{OH}	High Level Output Current			−0.8			−0.8	mA
I_{OL}	Low Level Output Current			16			16	mA
T_A	Free Air Operating Temperature	−55		125	0		70	°C

'150 Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ (Note 1)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −12 mA				−1.5	V
V_{OH}	High Level Output Voltage	V_{CC} = Min, I_{OH} = Max V_{IL} = Max, V_{IH} = Min		2.4			V
V_{OL}	Low Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IH} = Min, V_{IL} = Max				0.4	V
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 5.5V				1	mA
I_{IH}	High Level Input Current	V_{CC} = Max, V_I = 2.4V				40	μA
I_{IL}	Low Level Input Current	V_{CC} = Max, V_I = 0.4V				−1.6	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 2)	DM54	−20		−55	mA
			DM74	−18		−55	
I_{CC}	Supply Current	V_{CC} = Max, (Note 3)			40	68	mA

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 2: Not more than one output should be shorted at a time.

Note 3: I_{CC} is measured with the strobe and data select inputs at 4.5V, all other inputs and outputs open.

’150 Switching Characteristics

at $V_{CC} = 5V$ and $T_A = 25°C$ (See Section 1 for Test Waveforms and Output Load)

Symbol	Parameter	From (Input) To (Output)	$R_L = 400\Omega$, $C_L = 15$ pF		Units
			Min	Max	
t_{PLH}	Propagation Delay Time Low to High Level Output	Select to W		35	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Select to W		33	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Strobe to W		24	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Strobe to W		30	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	E0-E15 to W		20	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	E0-E15 to W		14	ns

Recommended Operating Conditions

Symbol	Parameter	DM54151A			DM74151A			Units
		Min	Nom	Max	Min	Nom	Max	
V_{CC}	Supply Voltage	4.5	5	5.5	4.75	5	5.25	V
V_{IH}	High Level Input Voltage	2			2			V
V_{IL}	Low Level Input Voltage			0.8			0.8	V
I_{OH}	High Level Output Current			−0.8			−0.8	mA
I_{OL}	Low Level Output Current			16			16	mA
T_A	Free Air Operating Temperature	−55		125	0		70	°C

’151A Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ (Note 1)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −12 mA				−1.5	V
V_{OH}	High Level Output Voltage	V_{CC} = Min, I_{OH} = Max V_{IL} = Max, V_{IH} = Min		2.4			V
V_{OL}	Low Level Output Voltage	V_{CC} = Min, I_{OL} = Max V_{IH} = Min, V_{IL} = Max				0.4	V
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 5.5V				1	mA
I_{IH}	High Level Input Current	V_{CC} = Max, V_I = 2.4V				40	μA
I_{IL}	Low Level Input Current	V_{CC} = Max, V_I = 0.4V				−1.6	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 2)	DM54	−20		−55	mA
			DM74	−18		−55	
I_{CC}	Supply Current	V_{CC} = Max, (Note 3)			27	48	mA

Note 1: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 2: Not more than one output should be shorted at a time.

Note 3: I_{CC} is measured with the strobe and data select inputs at 4.5V, all other inputs and outputs open.

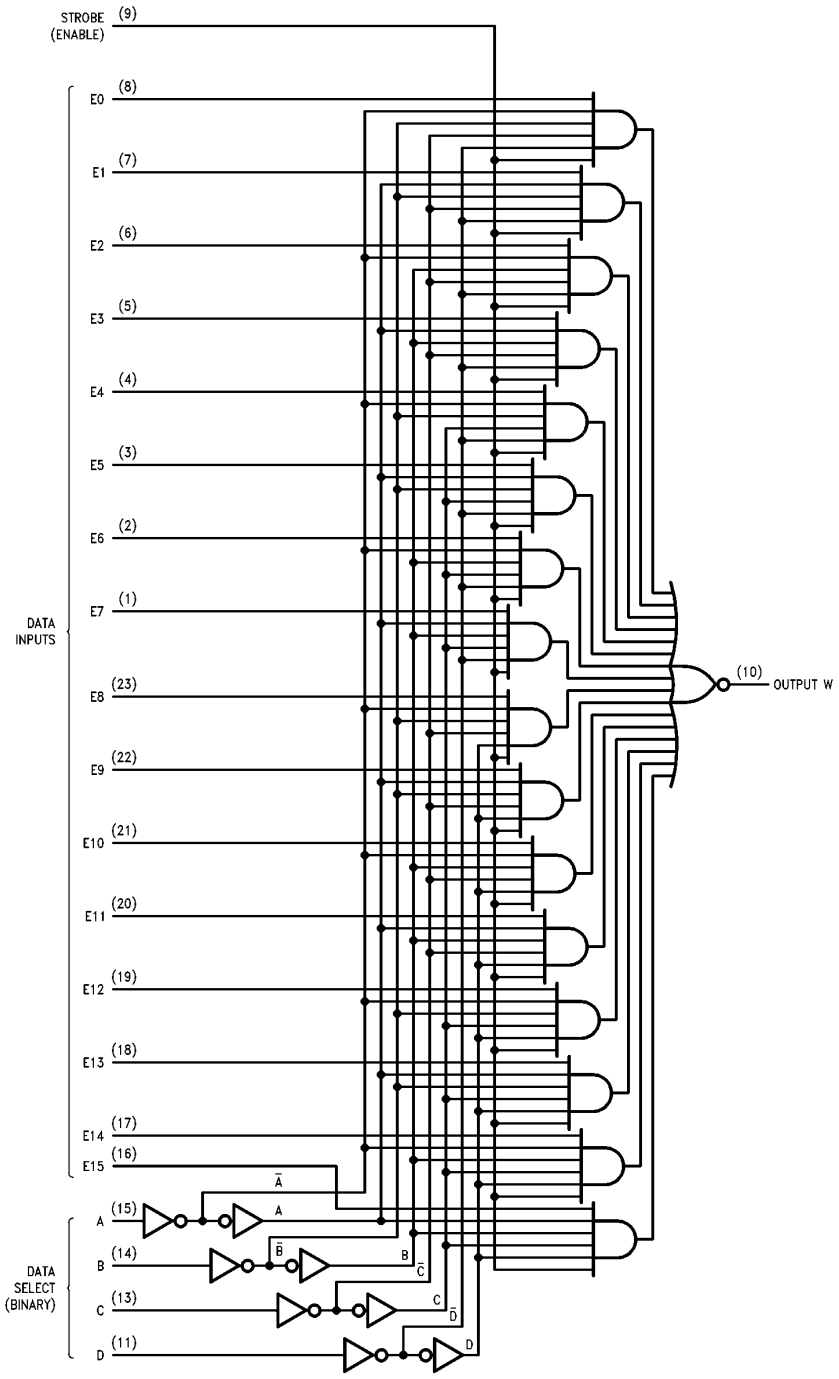
’151A Switching Characteristics

at V_{CC} = 5V and T_A = 25°C (See Section 1 for Test Waveforms and Output Load)

Symbol	Parameter	From (Input) To (Output)	R_L = 400Ω, C_L = 15 pF		Units
			Min	Max	
t_{PLH}	Propagation Delay Time Low to High Level Output	Select (4 Levels) to Y		38	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Select (4 Levels) to Y		30	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Select (3 Levels) to W		26	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Select (3 Levels) to W		30	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Strobe to Y		33	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Strobe to Y		30	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	Strobe to W		21	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	Strobe to W		25	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	D0-D7 to Y		24	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	D0-D7 to Y		24	ns
t_{PLH}	Propagation Delay Time Low to High Level Output	D0-D7 to W		14	ns
t_{PHL}	Propagation Delay Time High to Low Level Output	D0-D7 to W		14	ns

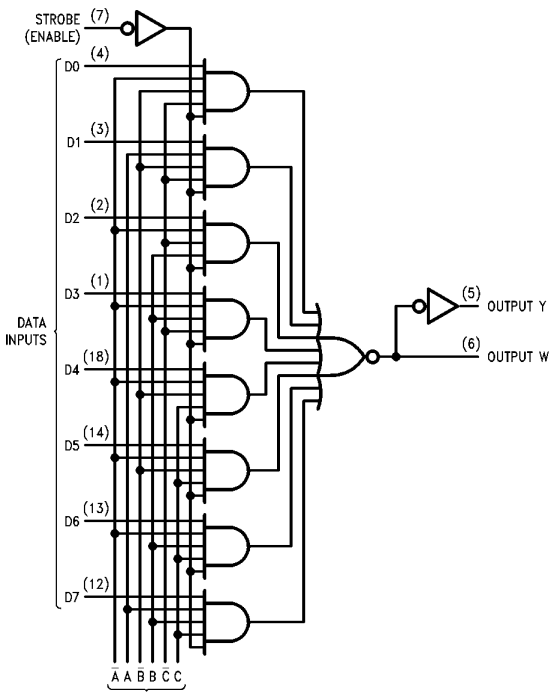
Logic Diagrams

150



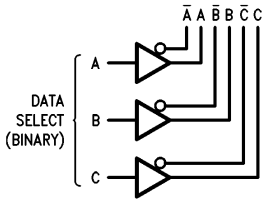
Logic Diagrams

151A



TL/F/6546–4

Address Buffers for 54151A/74151A



TL/F/6546–5

See Address Buffers Below

Function Tables

54150/74150

Inputs					Outputs
Select				Strobe	
D	C	B	A	S	W
X	X	X	X	H	H
L	L	L	L	L	$\overline{E0}$
L	L	L	H	L	$\overline{E1}$
L	L	H	L	L	$\overline{E2}$
L	L	H	H	L	$\overline{E3}$
L	H	L	L	L	$\overline{E4}$
L	H	L	H	L	$\overline{E5}$
L	H	H	L	L	$\overline{E6}$
L	H	H	H	L	$\overline{E7}$
H	L	L	L	L	$\overline{E8}$
H	L	L	H	L	$\overline{E9}$
H	L	H	L	L	$\overline{E10}$
H	L	H	H	L	$\overline{E11}$
H	H	L	L	L	$\overline{E12}$
H	H	L	H	L	$\overline{E13}$
H	H	H	L	L	$\overline{E14}$
H	H	H	H	L	$\overline{E15}$

H = High Level, L = Low Level, X = Don't Care

$\overline{E0}$, $\overline{E1}$ . . . $\overline{E15}$ = the complement of the level of the respective E input

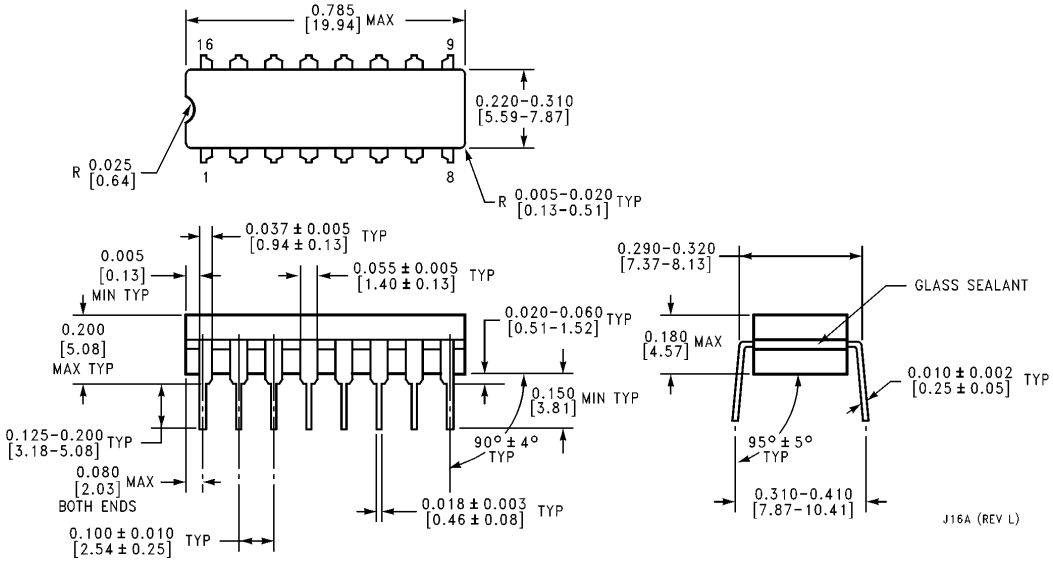
54151A/75151A

Inputs				Outputs	
Select			Strobe		
C	B	A	S	Y	W
X	X	X	H	L	H
L	L	L	L	D0	$\overline{D0}$
L	L	H	L	D1	$\overline{D1}$
L	H	L	L	D2	$\overline{D2}$
L	H	H	L	D3	$\overline{D3}$
H	L	L	L	D4	$\overline{D4}$
H	L	H	L	D5	$\overline{D5}$
H	H	L	L	D6	$\overline{D6}$
H	H	H	L	D7	$\overline{D7}$

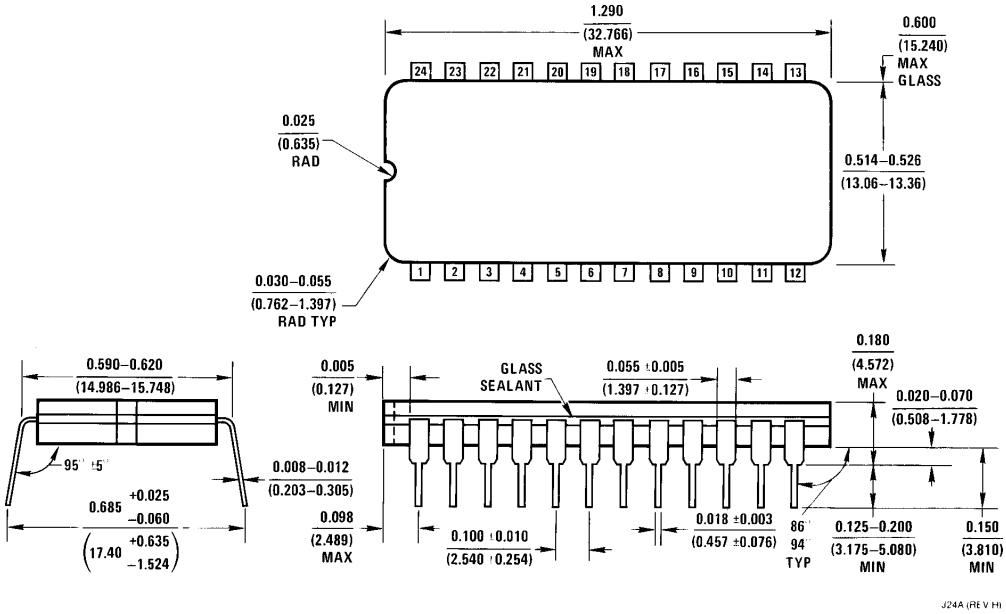
H = High Level, L = Low Level, X = Don't Care

D0, D1 . . . D7 = the level of the respective D input

Physical Dimensions inches (millimeters)

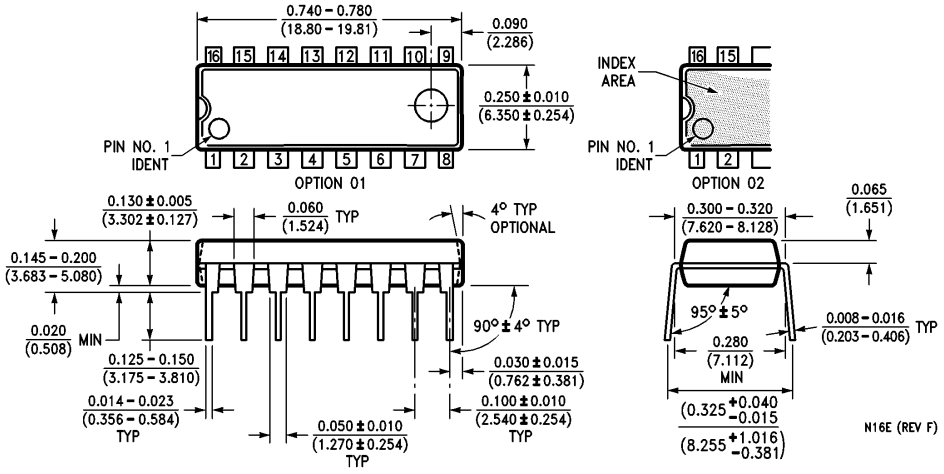


16-Lead Ceramic Dual-In-Line Package (J)
Order Number 54151ADMQB or DM54151AJ
NS Package Number J16A

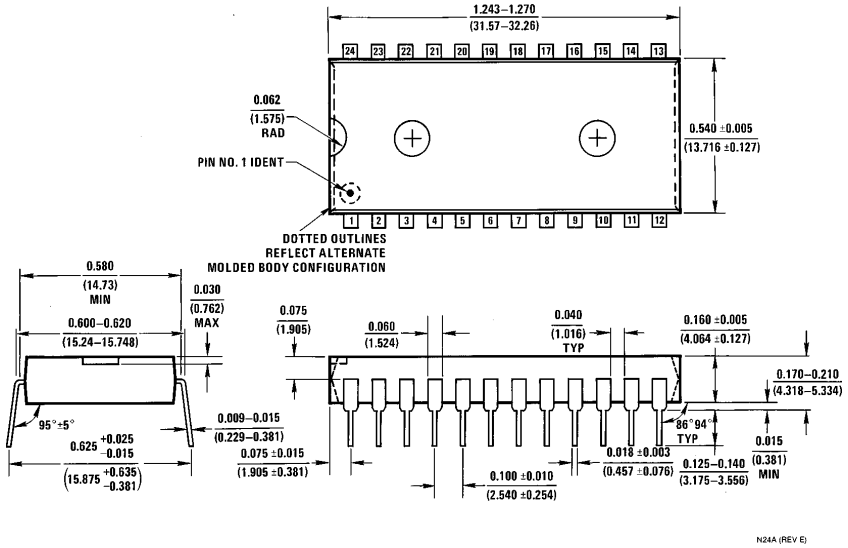


24-Lead Ceramic Dual-In-Line Package (J)
Order Number 54150DMQB or DM54150J
NS Package Number J24A

Physical Dimensions inches (millimeters) (Continued)

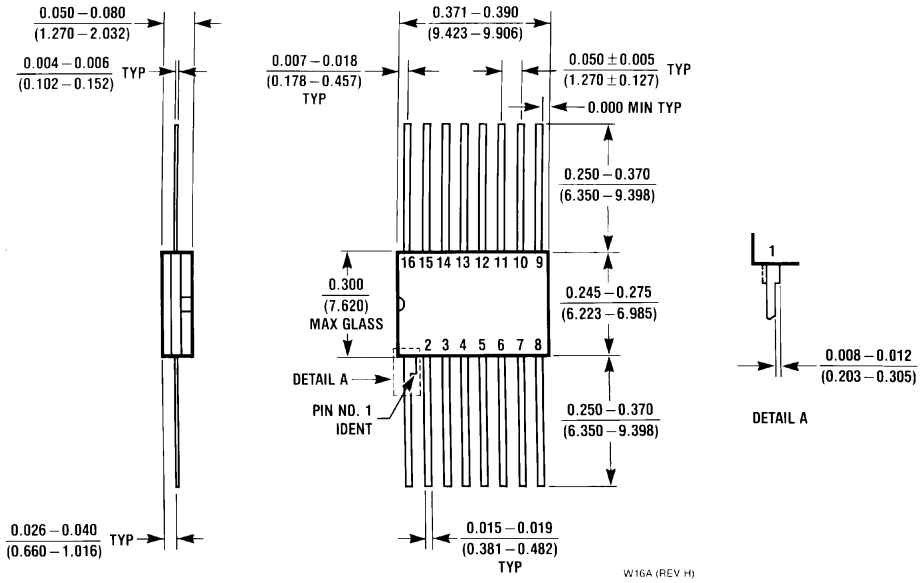


16-Lead Molded Dual-In-Line Package (N)
Order Number DM74151AN
NS Package Number N16E



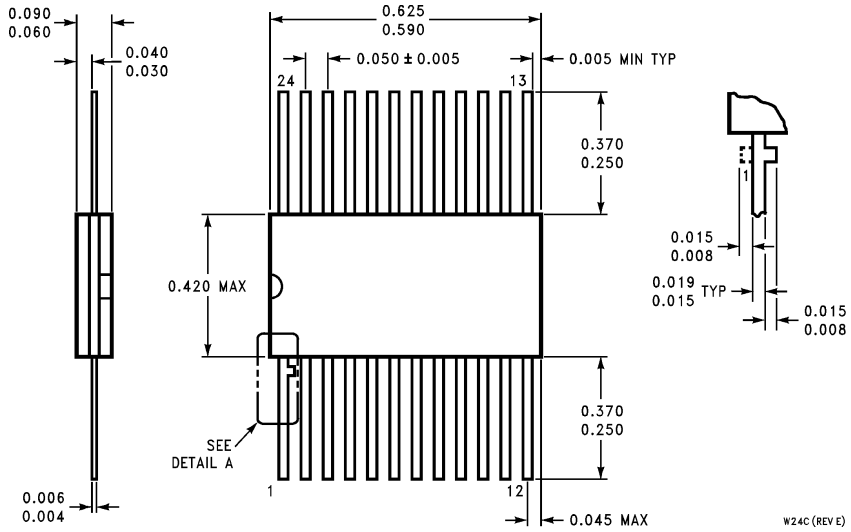
24-Lead Molded Dual-In-Line Package (N)
Order Number DM74150N
NS Package Number N24A

Physical Dimensions inches (millimeters) (Continued)



16-Lead Ceramic Flat Package (W)
Order Number 54151AFMQB or DM54151AW
NS Package Number W16A

Physical Dimensions inches (millimeters) (Continued)



24-Lead Ceramic Flat Package (W)
Order Number 54150FMQB
NS Package Number W24C

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

National Semiconductor Corporation
1111 West Bardin Road
Arlington, TX 76017
Tel: 1(800) 272-9959
Fax: 1(800) 737-7018

National Semiconductor Europe
Fax: (+49) 0-180-530 85 86
Email: cnjwge@tevm2.nsc.com
Deutsch Tel: (+49) 0-180-530 85 85
English Tel: (+49) 0-180-532 78 32
Français Tel: (+49) 0-180-532 93 58
Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: (852) 2737-1600
Fax: (852) 2736-9960

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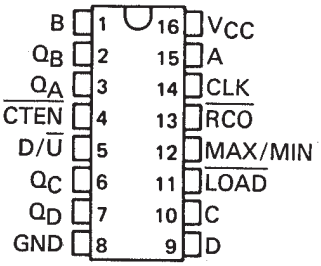
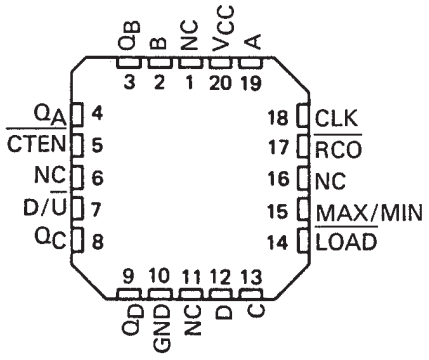
- **Counts 8-4-2-1 BCD or Binary**
- **Single Down/Up Count Control Line**
- **Count Enable Control Input**
- **Ripple Clock Output for Cascading**
- **Asynchronously Presettable with Load Control**
- **Parallel Outputs**
- **Cascadable for n-Bit Applications**

TYPE	AVERAGE PROPAGATION DELAY	TYPICAL MAXIMUM CLOCK FREQUENCY	TYPICAL POWER DISSIPATION
'190,'191	20ns	25MHz	325mW
'LS190,'LS191	20ns	25MHz	100mW

SN54190, SN54191, SN54LS190, SN54LS191 . . . J PACKAGE
SN74190, SN74191 . . . N PACKAGE
SN74LS190, SN74LS191 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS190, SN54LS191 . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

description

The '190, 'LS190, '191, and 'LS191 are synchronous, reversible up/down counters having a complexity of 58 equivalent gates. The '191 and 'LS191 are 4-bit binary counters and the '190 and 'LS190 are BCD counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple clock) counters.

The outputs of the four master-slave flip-flops are triggered on a low-to-high transition of the clock input if the enable input is low. A high at the enable input inhibits counting. Level changes at the enable input should be made only when the clock input is high. The direction of the count is determined by the level of the down/up input. When low, the counter count up and when high, it counts down. A false clock may occur if the down/up input changes while the clock is low. A false ripple carry may occur if both the clock and enable are low and the down/up input is high during a load pulse.

These counters are fully programmable; that is, the outputs may be preset to either level by placing a low on the load input and entering the desired data at the data inputs. The output will change to agree with the data inputs independently of the level of the clock input. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

The clock, down/up, and load inputs are buffered to lower the drive requirement which significantly reduces the number of clock drivers, etc., required for long parallel words.

Two outputs have been made available to perform the cascading function: ripple clock and maximum/minimum count. The latter output produces a high-level output pulse with a duration approximately equal to one complete cycle of the clock when the counter overflows or underflows. The ripple clock output produces a low-level output pulse equal in width to the low-level portion of the clock input when an overflow or underflow condition exists. The counters can be easily cascaded by feeding the ripple clock output to the enable input of the succeeding counter if parallel clocking is used, or to the clock input if parallel enabling is used. The maximum/minimum count output can be used to accomplish look-ahead for high-speed operation.

Series 54' and 54LS' are characterized for operation over the full military temperature range of −55°C to 125°C; Series 74' and 74LS' are characterized for operation from 0°C to 70°C.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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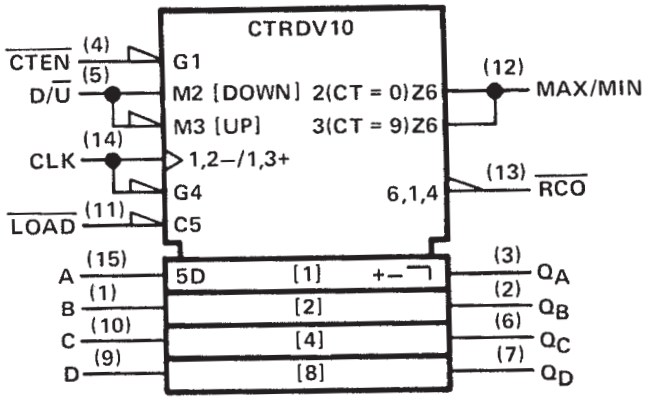
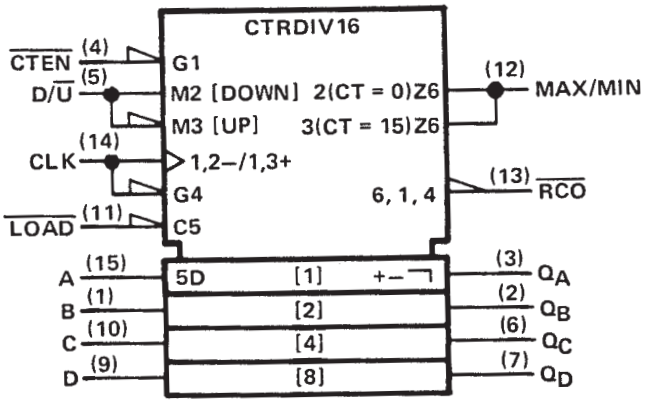
logic symbols†

'190, 'LS190



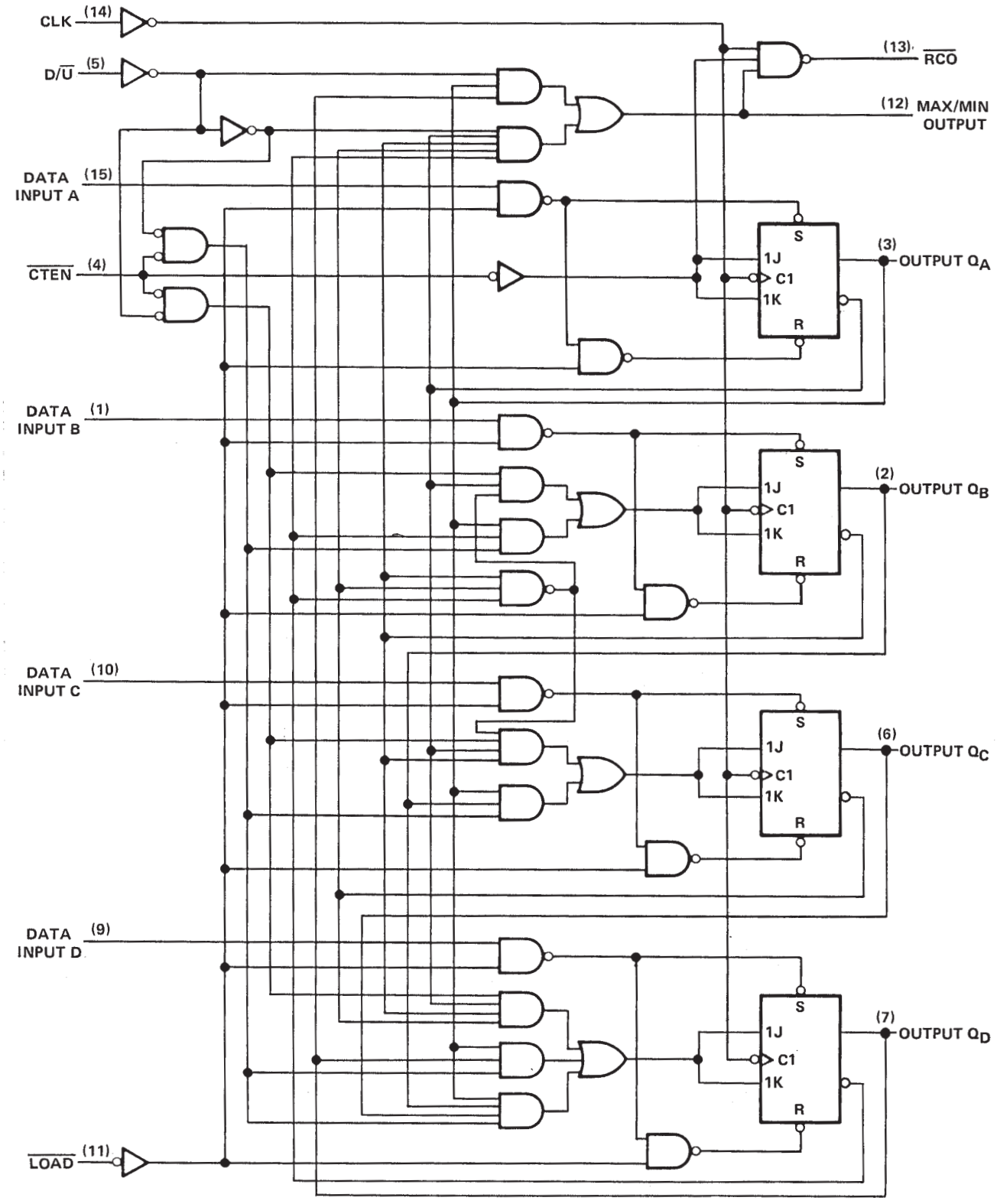
'191, 'LS191



† These symbols are accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, and N packages.

logic diagram (positive logic)

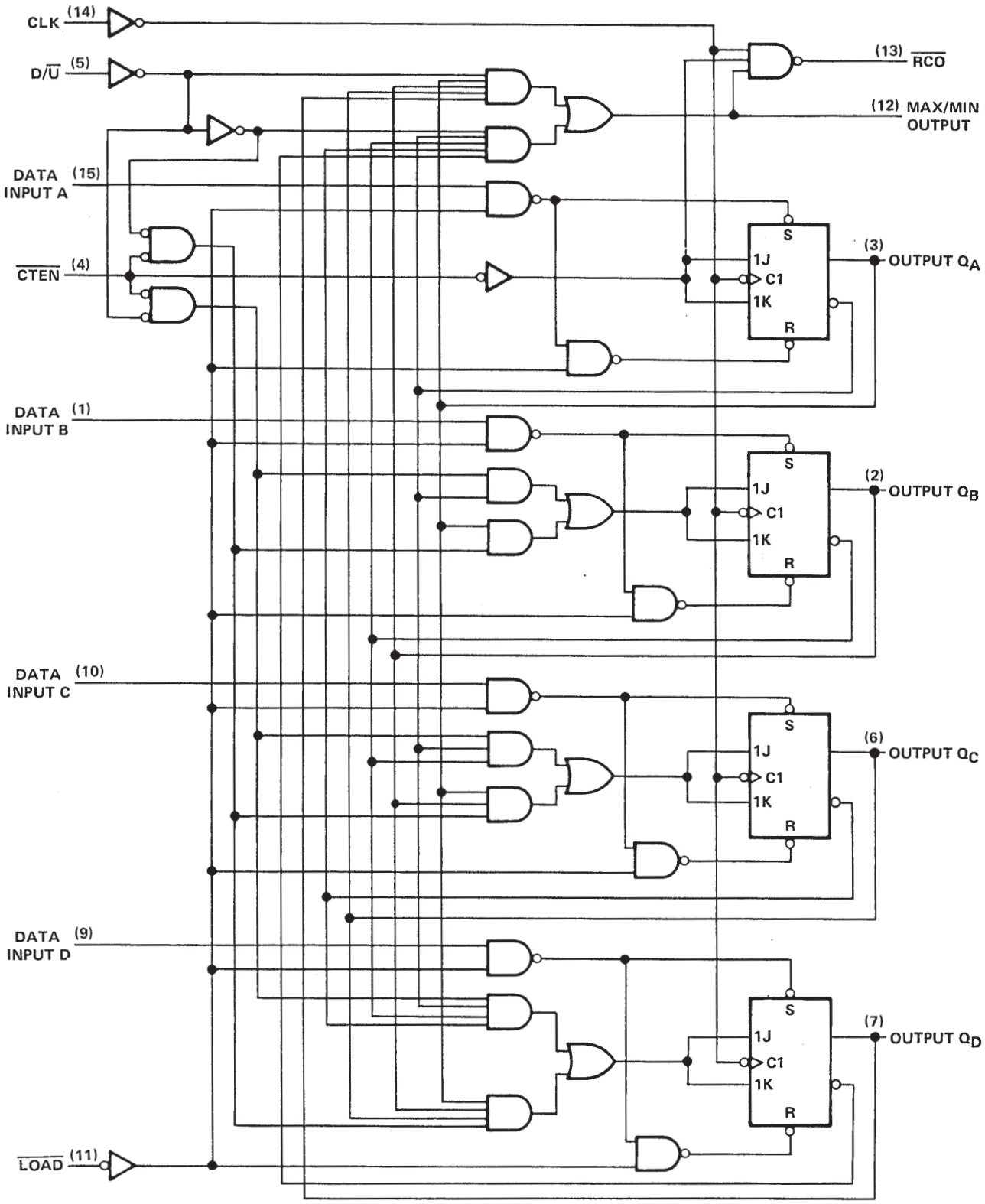
'190, 'LS190 DECADE COUNTERS



Pin numbers shown are for D, J, and N packages.

logic diagram (positive logic)

'191, 'LS191 BINARY COUNTERS



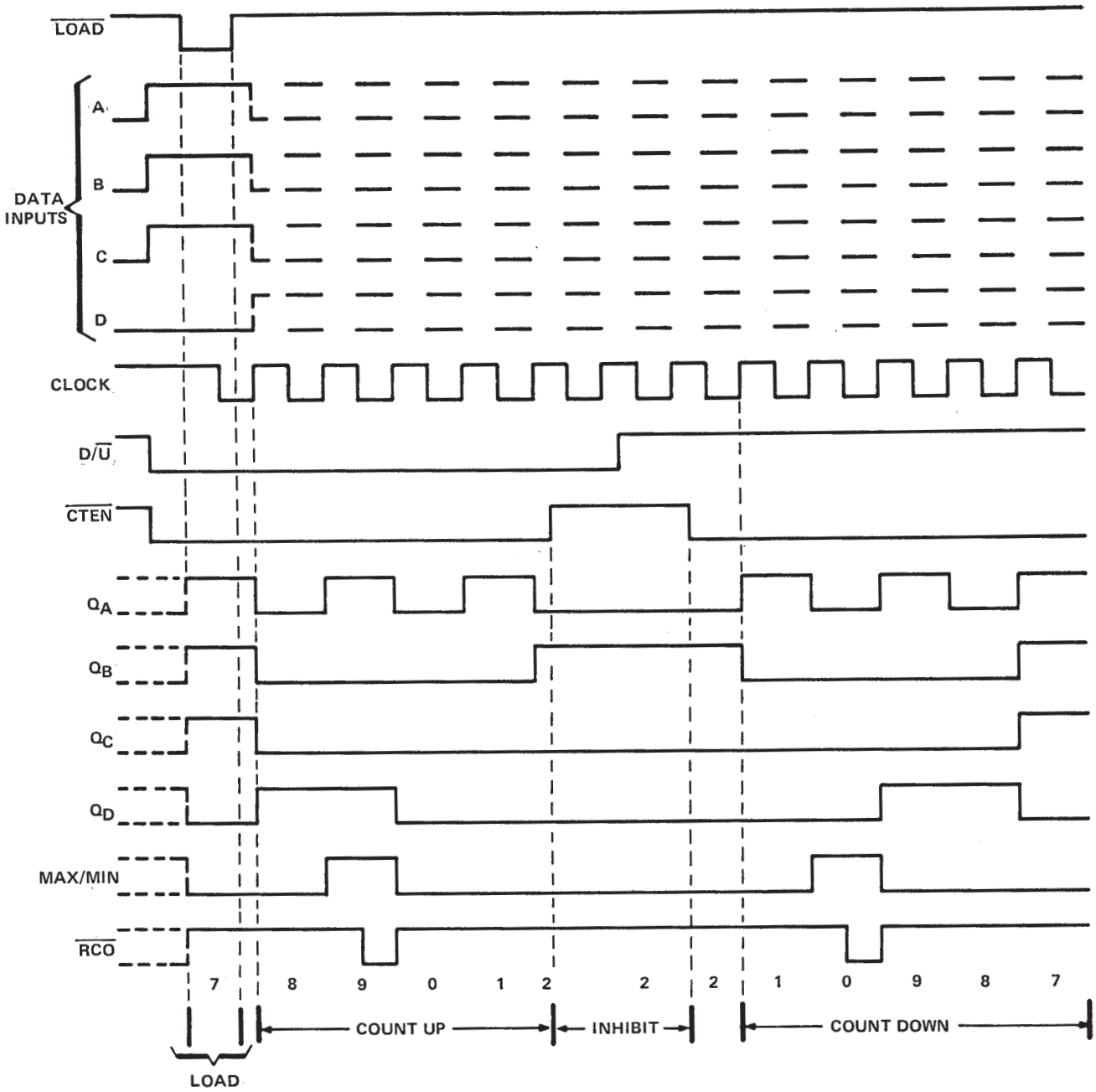
Pin numbers shown are for D, J, and N packages.

'190, 'LS190 DECADE COUNTERS

typical load, count, and inhibit sequences

Illustrated below is the following sequence:

1. Load (preset) to BCD seven.
2. Count up to eight, nine (maximum), zero, one, and two.
3. Inhibit.
4. Count down to one, zero (minimum), nine, eight, and seven.

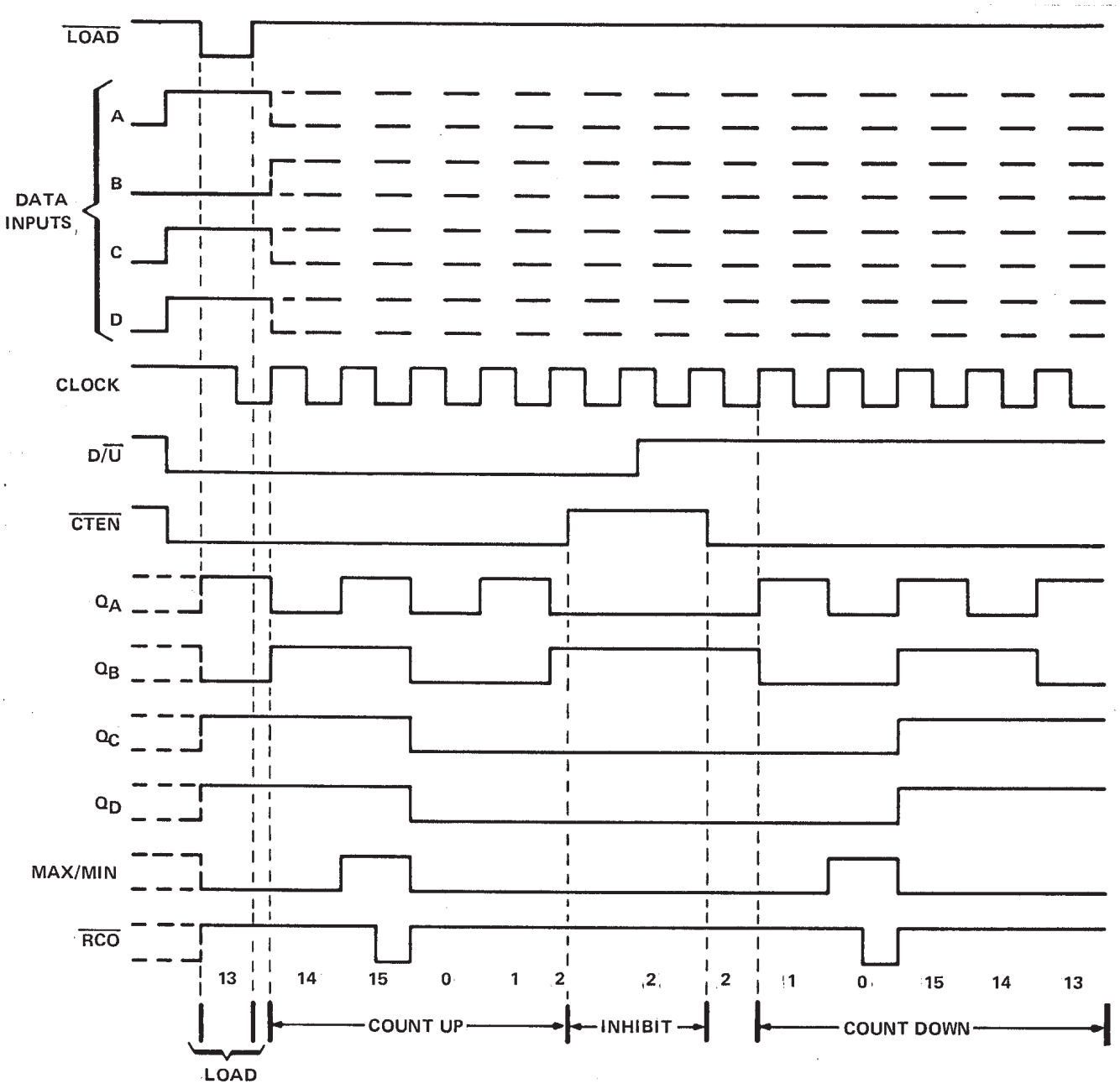


'191, 'LS191 BINARY COUNTERS

pical load, count, and inhibit sequences

Illustrated below is the following sequence:

1. Load (preset) to binary thirteen.
2. Count up to fourteen, fifteen (maximum), zero, one, and two.
3. Inhibit.
4. Count down to one, zero (minimum), fifteen, fourteen, and thirteen.



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: SN54', SN74' Circuits . . . . . 5.5 V
SN54LS', SN74LS' Circuits . . . . . 7 V
Operating free-air temperature range: SN54', SN54LS' Circuits . . . . . −55°C to 125°C
SN74', SN74LS' Circuits . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

			SN54190, SN54191			SN74190, SN74191			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current				−0.8			−0.8	mA
I_{OL}	Low-level output current				16			16	mA
f_{clock}	Input clock frequency		0		20	0		20	MHz
$t_{w(clock)}$	Width of clock input pulse		25			25			ns
$t_{w(load)}$	Width of load input pulse		35			35			ns
t_{su}	Setup time	Data, high or low (See Figure 1 and 2)	20			20			ns
		Load inactive state	20			20			
t_{hold}	Data hold time		0			0			ns
T_A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54190, SN54191			SN74190, SN74191			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage	V_{CC} = MIN	2			2			V
V_{IL}	Low-level input voltage	V_{CC} = MIN			0.8			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN, I_I = −12 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −0.8 mA	2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA		0.2	0.4		0.2	0.4	V
I_I	High-level input current at maximum input voltage	V_{CC} = MAX, V_I = 5.5 V			1			1	mA
I_{IH}	High-level input current at any input except enable	V_{CC} = MAX, V_I = 2.4 V			40			40	μA
I_{IH}	High-level input current at enable input				120			120	μA
I_{IL}	Low-level input current at any input except enable	V_{CC} = MAX, V_I = 0.4 V			−1.6			−1.6	mA
I_{IL}	Low-level input current at enable input				−4.8			−4.8	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX	−20		−65	−18		−65	mA
I_{CC}	Supply current	V_{CC} = MAX, See Note 2		65	99		65	105	mA

† For conditions shown as MAX or MIN, use appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
NOTE 2: I_{CC} is measured with all inputs grounded and all outputs open.

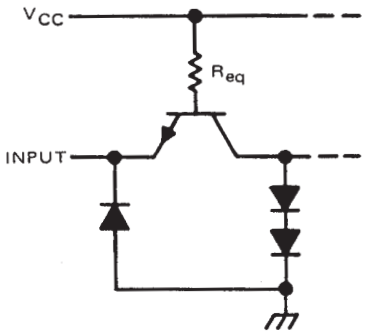
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'190, '191			UNIT
				MIN	TYP	MAX	
f_{max}			C_L = 15 pF, R_L = 400 Ω, See Figures 1 and 3 thru 7	20	25		MHz
t_{PLH}	$\overline{Load}$	Q_A, Q_B, Q_C, Q_D			22	33	ns
t_{PHL}					33	50	
t_{PLH}	Data A, B, C, D	Q_A, Q_B, Q_C, Q_D			14	22	ns
t_{PHL}					35	50	
t_{PLH}	CLK	$\overline{RCO}$			13	20	ns
t_{PHL}					16	24	
t_{PLH}	CLK	Q_A, Q_B, Q_C, Q_D			16	24	ns
t_{PHL}					24	36	
t_{PLH}	CLK	Max/Min			28	42	ns
t_{PHL}					37	52	
t_{PLH}	D/$\overline{U}$	$\overline{RCO}$			30	45	ns
t_{PHL}					30	45	
t_{PLH}	D/$\overline{U}$	Max/Min			21	33	ns
t_{PHL}					22	33	

† f_{max} ≡ maximum clock frequency
t_{PLH} ≡ propagation delay time, low-to-high-level output
t_{PHL} ≡ propagation delay time, high-to-low-level output

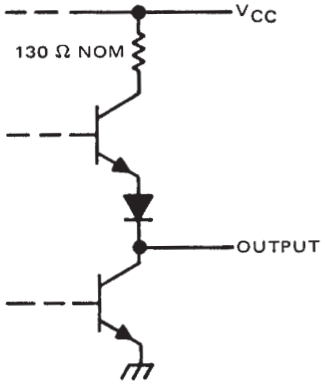
schematics of inputs and outputs

EQUIVALENT OF EACH INPUT



Enable input: R_{eq} = 1.3 kΩ NOM
All other inputs: R_{eq} = 4 kΩ NOM

TYPICAL OF ALL OUTPUTS



recommended operating conditions

		SN54LS190 SN54LS191			SN74LS190 SN74LS191			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current			−0.4			−0.4	mA
I_{OL}	Low-level output current			4			8	mA
f_{clock}	Clock frequency	0		20	0		20	MHz
$t_{w(clock)}$	Width of clock input pulse	25			25			ns
$t_{w(load)}$	Width of load input pulse	35			35			ns
t_{su}	Data setup time (See Figures 1 and 2)	20			20			ns
t_{su}	Load inactive state setup time	30			30			ns
t_h	Data hold time	5			5			ns
t_h	Enable hold time	0			0			ns
t_{enable}	Count enable time (see Note 3)	40			40			ns
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54LS190 SN54LS191			SN74LS190 SN74LS191			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = −18 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max, I_{OH} = −400 μA		2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
				I_{OL} = 8 mA					0.35	0.5	
I_I	High-level input current at maximum input voltage	Enable	V_{CC} = MAX, V_I = 7 V				0.3			0.3	mA
		Others					0.1			0.1	
I_{IH}	High-level input current	Enable	V_{CC} = MAX, V_I = 2.7 V				60			60	μA
		Others					20			20	
I_{IL}	Low-level input current	Enable	V_{CC} = MAX, V_I = 0.4 V				−1.2			−1.2	mA
		Others					−0.4			−0.4	
I_{OS}	Short-circuit output current§		V_{CC} = MAX,		−20		−100	−20		−100	mA
I_{CC}	Supply current		V_{CC} = MAX, See Note 2			20	35		20	35	mA

†For conditions shown as MAX or MIN, use appropriate value specified under recommended operating conditions for the applicable device type.

‡All typical values are at V_{CC} = 5 V, T_A = 25°C.

§Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTES: 2. I_{CC} is measured with all inputs grounded and all outputs open.

3. Minimum count enable time is the interval immediately preceeding the rising edge of the clock pulse during which interval the count enable input must be low to ensure counting.

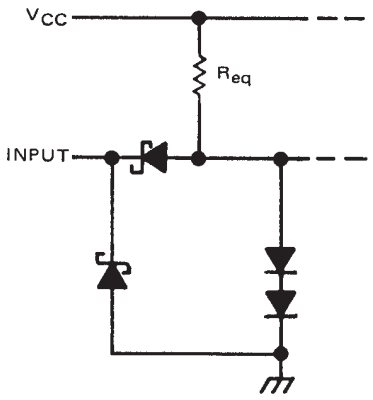
switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER†	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS190, 'LS191			UNIT
				MIN	TYP	MAX	
f_{max}			C_L = 15 pF, R_L = 2 kΩ, See Figures 1 and 3 thru 7	20	25		MHz
t_{PLH}	$\overline{Load}$	Q_A, Q_B, Q_C, Q_D			22	33	ns
t_{PHL}					33	50	
t_{PLH}	Data A, B, C, D	Q_A, Q_B, Q_C, Q_D			20	32	ns
t_{PHL}					27	40	
t_{PLH}	CLK	$\overline{RCO}$			13	20	ns
t_{PHL}					16	24	
t_{PLH}	CLK	Q_A, Q_B, Q_C, Q_D			16	24	ns
t_{PHL}					24	36	
t_{PLH}	CLK	Max/Min			28	42	ns
t_{PHL}					37	52	
t_{PLH}	D/$\overline{U}$	$\overline{RCO}$			30	45	ns
t_{PHL}					30	45	
t_{PLH}	D/$\overline{U}$	Max/Min			21	33	ns
t_{PHL}					22	33	
t_{PLH}	$\overline{CTEN}$	$\overline{RCO}$			21	33	ns
t_{PHL}					22	33	

† f_{max} ≡ maximum clock frequency
t_{PLH} ≡ propagation delay time, low-to-high-level output
t_{PHL} ≡ propagation delay time, high-to-low-level output

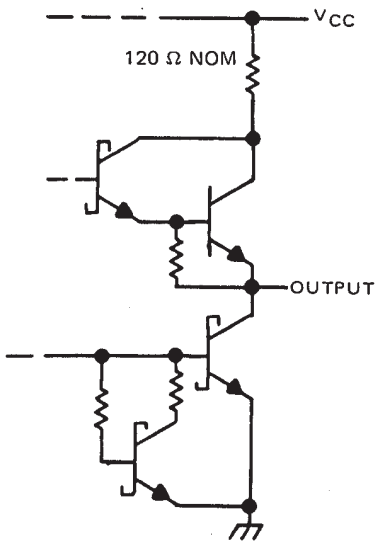
schematics of inputs and outputs

EQUIVALENT OF EACH INPUT



Enable input: R_{eq} = 8.33 kΩ NOM
Load input: R_{eq} = 25 kΩ NOM
All other inputs: R_{eq} = 17 kΩ NOM

TYPICAL OF ALL OUTPUTS



PARAMETER MEASUREMENT INFORMATION

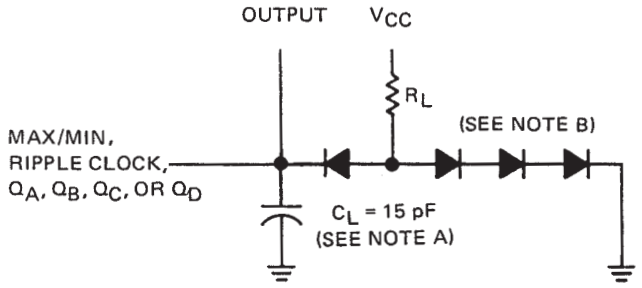
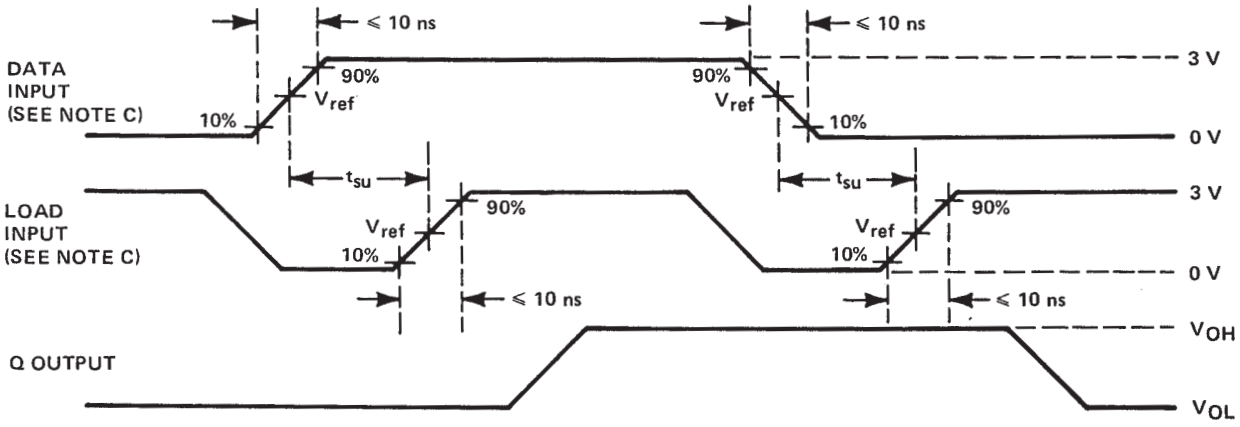
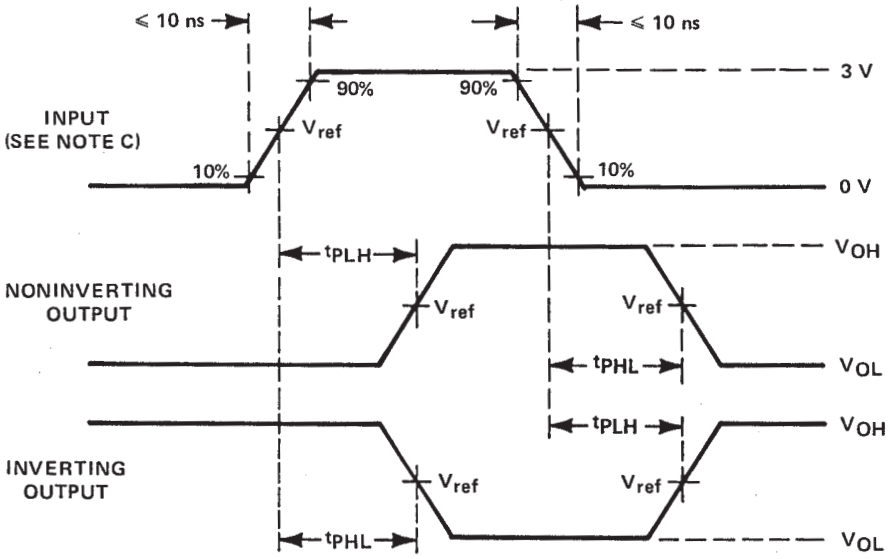


FIGURE 1–LOAD CIRCUIT
FOR SWITCHING TIME MEASUREMENT



FIGUTE 2-DATA SETUP TIME VOLTAGE WAVEFORMS

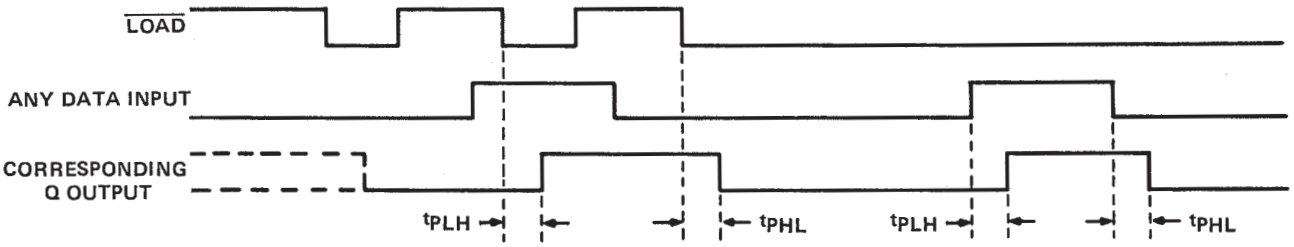


See waveform sequences in figures 4 through 7 for propagation times from a specific input to a specific output. For simplication, pulse rise times, reference levels, etc., have not been shown in figures 4 through 7.

FIGURE 3-GENERAL VOLTAGE WAVEFORMS FOR PROPAGATION TIMES

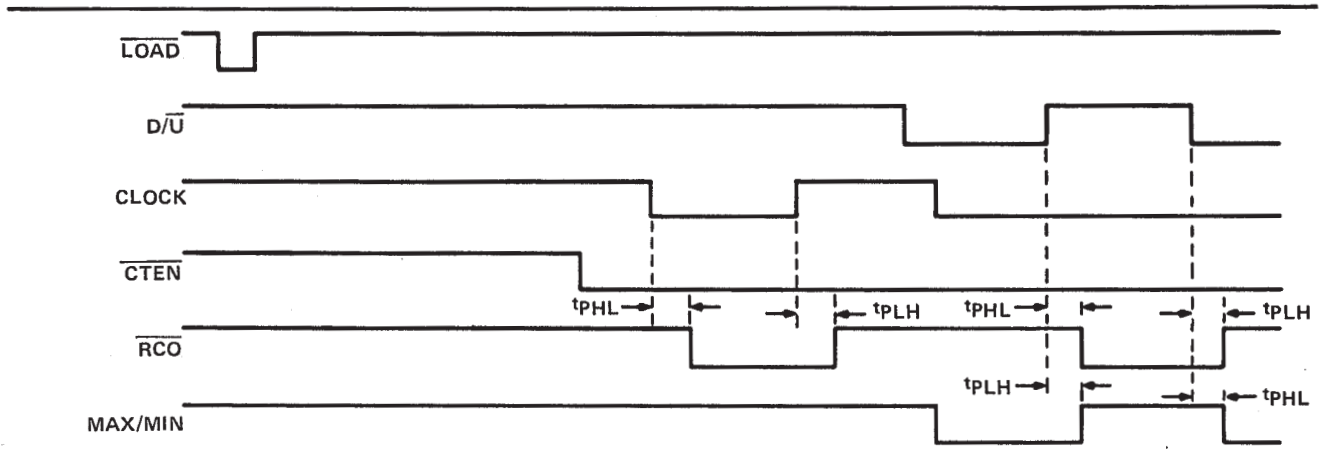
NOTES: A. C_L includes probe and jig capacitance.
B. All diodes are 1N3064 or equivalent.
C. The input pulses are supplied by generators having the following characteristics: Z_{out} = 50 Ω, duty cycle ⩽ 50%, PRR ⩽ 1 MHz.
D. V_{ref} = 1.5 V for '190 and '191; 1.3 V for 'LS190 and 'LS191.

PARAMETER MEASUREMENT INFORMATION (continued)



NOTE E: Conditions on other inputs are irrelevant.

FIGURE 4—LOAD TO OUTPUT AND DATA TO OUTPUT

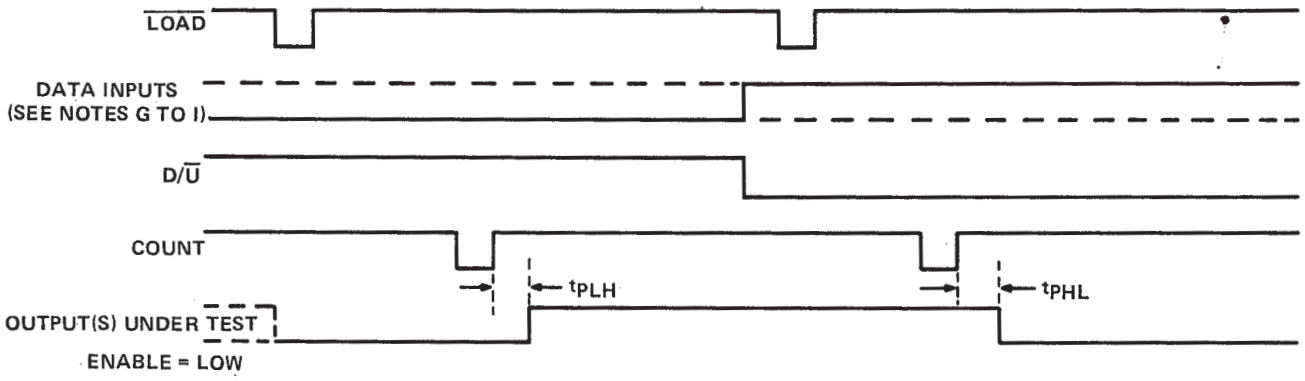


NOTE F: All data inputs are low.

FIGURE 5—ENABLE TO RIPPLE CLOCK, CLOCK TO RIPPLE CLOCK, DOWN/UP TO RIPPLE CLOCK, AND DOWN/UP TO MAX/MIN

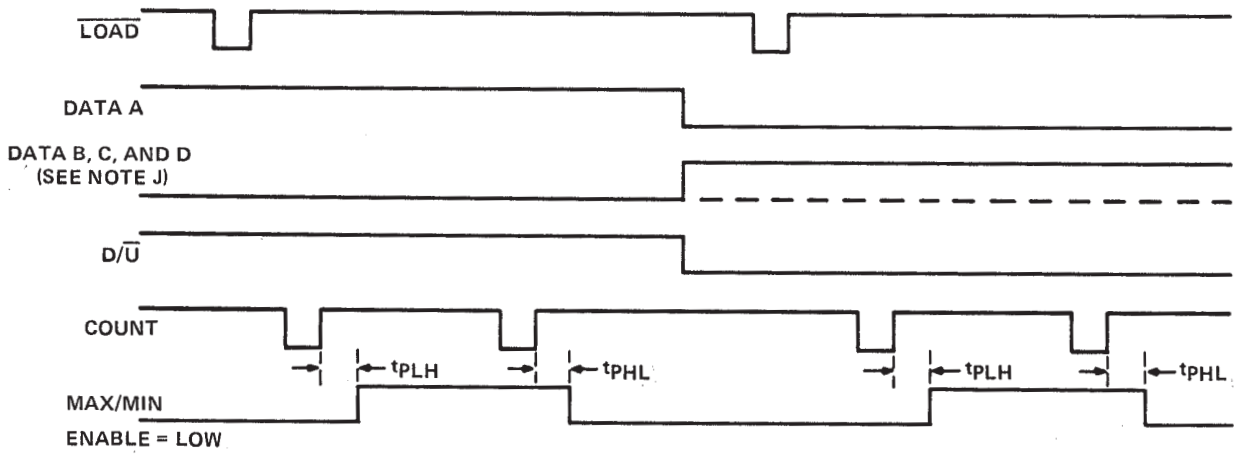
PARAMETER MEASUREMENT INFORMATION (continued)

switching characteristics (continued)



NOTES: G. To test Q_A, Q_B, and Q_C outputs of '190 and 'LS190: Data inputs A, B, and C are shown by the solid line. Data input D is shown by the dashed line.
H. To test Q_D output of '190 and 'LS190: Data inputs A and D are shown by the solid line. Data inputs B and C are held at the low logic level.
I. To test Q_A, Q_B, Q_C, and Q_D outputs of '191 and 'LS191: All four data inputs are shown by the solid line.

FIGURE 6-CLOCK TO OUTPUT



NOTE J: Data inputs B and C are shown by the dashed line for the '190 and 'LS190 and the solid line for the '191 and 'LS191: Data input D is shown by the solid line for both devices.

FIGURE 7-CLOCK TO MAX/MIN

IMPORTANT NOTICE

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FAIRCHILD SEMICONDUCTOR™

March 1989
Revised March 2000

DM74LS266
Quad 2-Input Exclusive-NOR Gate with Open-Collector Outputs

General Description

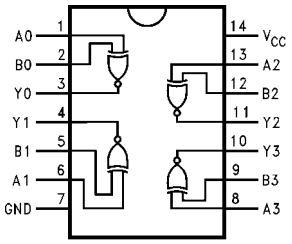
This device contains four independent gates each of which performs the logic exclusive-NOR function. Outputs are open collector.

Ordering Code:

Order Number	Package Number	Package Description
DM74LS266M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
DM74LS266N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Truth Table

Inputs		Outputs
A	B	Y
L	L	H
L	H	L
H	L	L
H	H	H

H = HIGH Voltage Level
L = LOW Voltage Level

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Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	−65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V_{CC}	Supply Voltage	4.75	5	5.25	V
V_{IH}	HIGH Level Input Voltage	2			V
V_{IL}	LOW Level Input Voltage			0.8	V
V_{OH}	HIGH Level Output Voltage			5.5	V
I_{OL}	LOW Level Output Current			8	mA
T_A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V_I	Input Clamp Voltage	V_{CC} = Min, I_I = −18 mA			−1.5	V
I_{CEX}	HIGH Level Output Current	V_{CC} = Min, V_O = 5.5V, V_{IL} = Max			100	µA
V_{OL}	LOW Level Output Voltage	V_{CC} = Min, I_{OL} = Max, V_{IH} = Min			0.5	V
		I_{OL} = 4 mA, V_{CC} = Min			0.4	
I_I	Input Current @ Max Input Voltage	V_{CC} = Max, V_I = 7V			0.2	mA
I_{IH}	HIGH Level Input Current	V_{CC} = Max, V_I = 2.7V			40	µA
I_{IL}	LOW Level Input Current	V_{CC} = Max, V_I = 0.4V			−0.8	mA
I_{OS}	Short Circuit Output Current	V_{CC} = Max (Note 3)	−20		−100	mA
I_{CC}	Supply Current	V_{CC} = Max			13	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

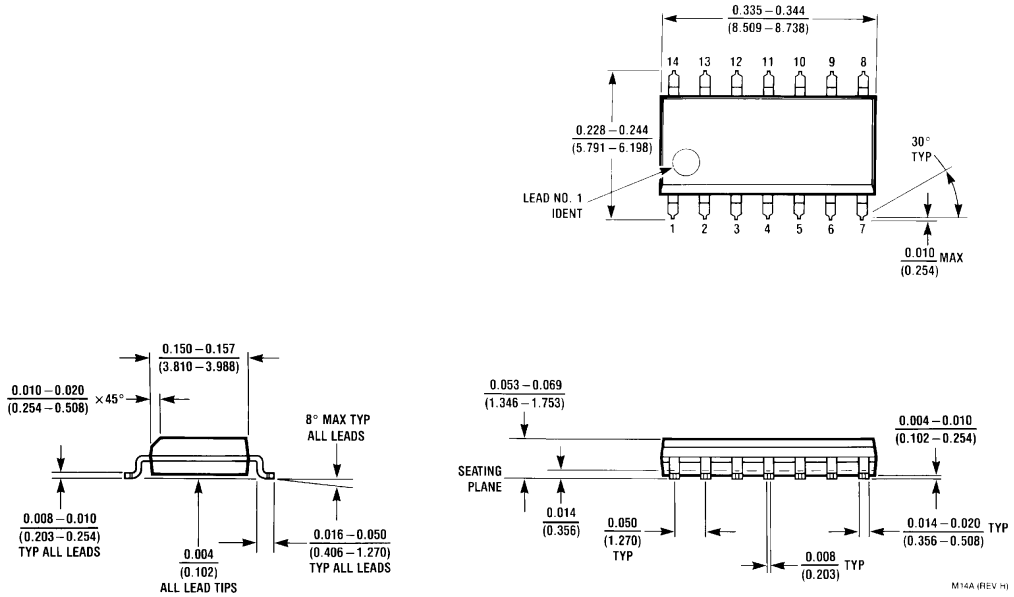
Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Switching Characteristics

V_{CC} = 5V, T_A = 25°C

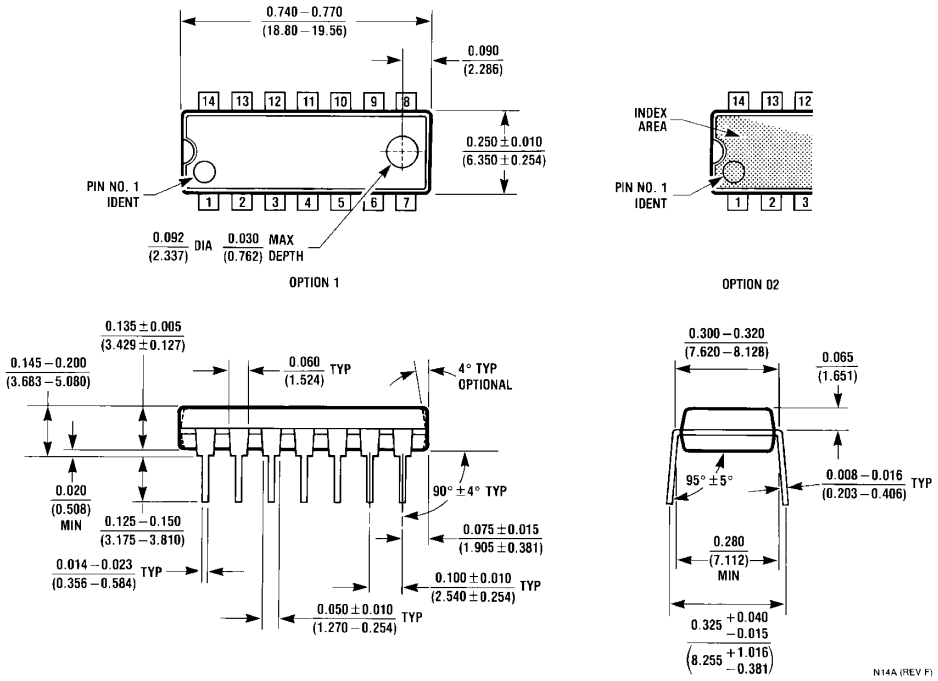
Symbol	Parameter	R_L = 2 kΩ, C_L = 15 pF		Units
		Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output		23	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output		23	ns

Physical Dimensions inches (millimeters) unless otherwise noted



14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150 Narrow
Package Number M14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide
Package Number N14A

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